



LZ87010

User's Guide

(Advance)

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LZ87010 Advance User's Guide

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Preface

The SHARP LZ87010 is a high-performance 8-bit microcontroller. This User's Guide is the principal technical reference for this device. This document assumes the reader is familiar with 8051 programming.

For abridged versions of this User's Guide, consult the LZ87010 Data Sheet and the single page Product Brief. For details, contact a SHARP representative or see the SHARP Microelectronics of the Americas website at <http://www.sharpsma.com>.

Application Notes and further information on connecting, programming and implementing the LZ87010, along with suggestions for companion parts, can be found on SHARP's website. Browse to <http://www.sharpsma.com>.

What's in This User's Guide

Chapter 1 – Introduction

This Chapter presents the theory of operation of the LZ87010 microcontroller, including features, benefits, pinout, signal description, and an overview of the entire device.

Chapter 2 – System Clocking

This Chapter describes the use of crystal oscillators or external clock generators with the LZ87010, the internal clocking structure, and the use of clock-stopping power-saving modes.

Chapter 3 – 8051-Compatible Core

This Chapter presents an overview of the 8051-compatible core. 8051-compatible I/O, however, is presented in later chapters.

Chapter 4 – Internal RAM

This Chapter describes the two blocks of on-chip data memory, the 256-byte scratchpad RAM and the 4,096-byte MOVX RAM.

Chapter 5 – Internal Flash

This Chapter describes the 64KB internal Flash memory, which can be programmed externally or internally, through software control.

Chapter 6 – I/O Ports

This Chapter describes the seven 8-bit general-purpose I/O ports and the two 8-bit high-current output ports.

Chapter 7 – 8051-Compatible Timers

This Chapter describes Timer 0 and Timer 1, which are compatible with the standard 8051.

Chapter 8 – Enhanced Timers

This Chapter describes Timers 2, 3, 4, and 5, which are enhanced 16-bit timers providing a total of four counters, four capture units, four PWM units, and eight compare units.

Chapter 9 – Watchdog Timer

This Chapter describes the LZ87010 Watchdog Timer (WDT).

Chapter 10 – UARTS

This Chapter describes the LZ87010 UARTs, UART 0 and UART 1. Both are 8051-compatible, except that UART1 has a dedicated baud-rate generator.

Chapter 11 – External Memory

This Chapter describes the LZ87010 External Memory interface, which allows up to 64KB of external program memory to be used, replacing part or all of on-chip Flash memory.

Chapter 12 – Interrupts

This Chapter describes the LZ87010 interrupt structure, interrupt priority, and interrupt vectors.

Chapter 13 – Analog Inputs (ADC)

This Chapter describes the LZ87010 12-bit, 8-input analog-to-digital converter (ADC).

Chapter 14 – Analog Outputs (DAC)

This Chapter presents the LZ87010 two 8-bit digital-to-analog converters (DACs) and their dedicated waveform generators.

Chapter 15 – I²C Interface

This Chapter presents the LZ87010 I²C serial interface, which can operate at both 100 kbit/s and 400 kbit/s data rates, and supports both master and slave modes of operation.

Chapter 16 – Debug Interface

This Chapter presents the SHARP Debug Interface (SDI).

Chapter 17 – Reset

This Chapter describes system reset and power-up.

Chapter 18 – Electrical Characteristics

This Chapter includes DC and AC specifications, timing Information, and timing diagrams for the LZ87010 microcontroller.

Chapter 19 – Mechanical Specifications

This Chapter contains physical dimension specifications for the LZ87010 microcontroller.

Terms and Conventions

Multiplexed Pins

The LZ87010 is manufactured in an LQFP package with 100 pins. Some pins have only one function, but others support two functions. These multiplexed pins have both functions available simultaneously.

Pin Names

Package pins are named to indicate the signal(s) or functionality available at the pin. If the signal or function is active LOW, the name is prefixed with a lower-case 'n', such as nPSWR. Multiplexed pins are named to indicate all available functions, such as Pin 80: P0[5]/INT[5], which can function as either General-Purpose I/O Port 0, bit 5, or Interrupt Request bit 5.

These naming conventions help designers recognize and avoid collisions between multiplexed functions but can complicate explanatory text, so this Guide uses the name appropriate to the context. A discussion of an interrupt, for example, would refer to signal INT[5], but information about Port 0 bit 5 would use P0[5]. Readers must be aware that these are separate signals, with distinctly different functionality, which happen to be available on the same pin.

Peripheral Devices

The LZ87010 is an 8-bit microcontroller using an 8051-compatible architecture. Additional functionality not available in the standard 8051 consists mostly of additional peripheral devices not present in the 8051. These devices have their I/O and control registers mapped to the 'Special Function Register' (SFR) memory space of the 8051 architecture, which is in the data memory address range of 0x80-0xFF.

Register Addresses

The LZ87010 is a memory-mapped device with programmable, internal registers that control its operation. Each internal register is located at a unique address in the memory map.

In this Guide, the addresses for all registers are expressed as an absolute hex address.

Register Tables

All Registers are presented in tabular format. A primary table presents each register's name, address, permissions, bit names and the register's contents at reset. Subsequent tables, if present, detail the specific names and function(s) of all bits and bit fields in the register and explain any important variations that may exist.

Reading and Writing

An important detail to note is that all registers are not perfectly writable and readable. Some will exhibit different characteristics on a write, while a read may not return the expected result.

Reserved Bits and Fields

At the same time, not all bit fields in all registers can be written, nor can all register bits and fields yield useful information when read. These restricted register bits and fields will be specifically called out with three slashes (///) and the word 'Reserved', along with their special conditions in the bit field tables. See Table 1 and Table 2 for examples of this practice.

Table 1. Register Name

BIT	7	6	5	4	3	2	1	0
FIELD	///	///	///	TRAP_EN	///	DPSEL		
RESET	0	0	0	0	0	0		
RW	RO	RO	RO	RW	RO	RW		
ADDR	0xA2							

Table 2. Register Bit Fields

BIT	NAME	DESCRIPTION
7:5	///	Reserved Reads return '0'; write as '0'.
4	TRAP_EN	Example Bit Name A description of this bit's functionality will be found in this space.
3	///	Reserved Reads return '0'; write as '0'.
2:0	DPSEL	Example Field Name A description of these bits' functionality will be found in this space.

Numeric Values

Binary values are prefixed with 0b; for example, 0b00001000.

Hexadecimal values are expressed with UPPERCASE letters and prefixed with 0x; for example, 0x0FBC.

All numeric values not specifically identified with the above prefixes as either binary or hexadecimal are decimal values.

Registers and bit fields with 0b0 in all bits are referred to as 'cleared' or as 0. Registers and bit fields with 0b1 values in all bits are referred to as 'set' or as the binary, hexadecimal, or decimal value of the entire field or register.

Block Diagrams

The functional descriptions in this Guide include block diagrams with symbols representing logical or mathematical operations or selections, usually the result of writing a value to a register. Figure 1 shows one such multiplexer with three inputs and one output (the result).

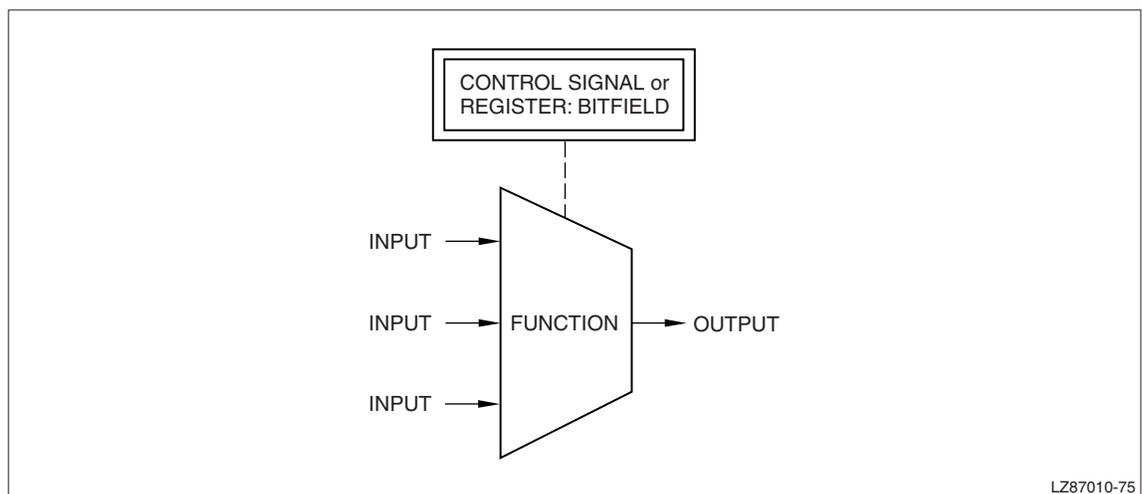


Figure 1. Multiplexer

Block diagrams can include symbols representing Registers and the bit fields within them. Figure 2 shows that the BITFIELDNAME bit field in the REGISTERNAME register enables or disables the signal named OUTPUT.

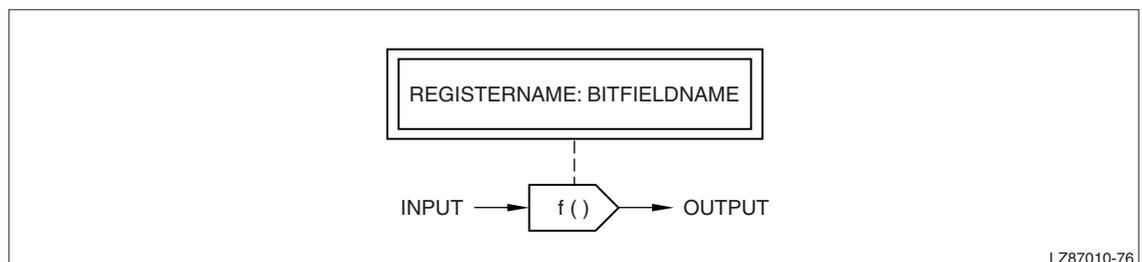


Figure 2. Register with Bit Field Named

Figure 4 is similar to Figure 2 except that Figure 4 references multiple (different) BITFIELDS in the REGISTERNAME register.

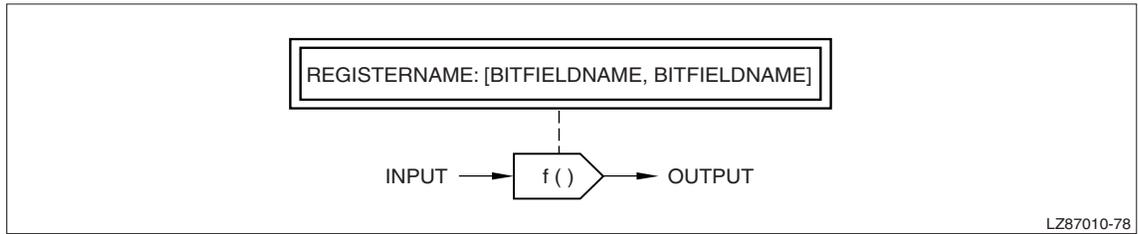


Figure 3. Register with Multiple Bit Fields Named

Not all bit fields are named. If a bit field has no name, the Register is shown with numbers indicating the appropriate bit positions, with the least significant bit on the right, as in Figure 4. This bit ordering matches that of the Register tables, shown in Table 1.

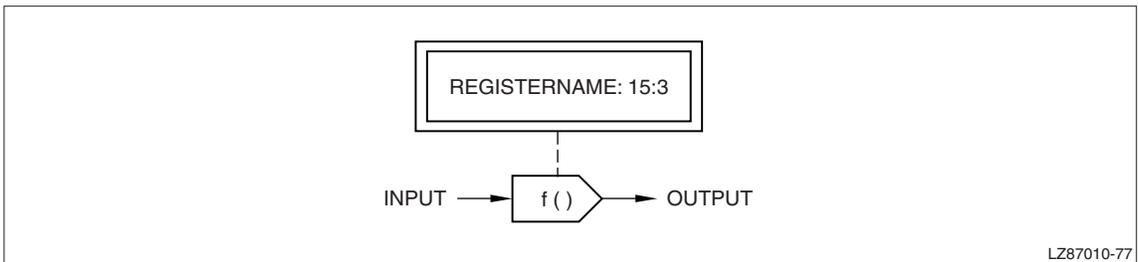


Figure 4. Register with Bit Field Numbered

Chapter 1

Introduction

1.1 Features

- 8-bit, 40 MHz, 8051-compatible CPU core:
 - Two-clock Machine Cycle
 - Equivalent to a 240 MHz 8051
- Two-wire Debug Interface with Breakpoint and Trace
- 64KB On-chip Flash Program Memory
 - Enough Memory for Demanding Applications
 - In-circuit Serially Programmable
 - New 8051 Instruction for Writable Code Memory
- External (Off-chip) Program Memory Interface
 - 16-bit Address/8-bit Data Busses
 - Supports Reads and Writes
- 4KB On-chip MOVX Data RAM
- 256 Bytes Scratchpad RAM
- Six 16-bit Multifunction Timer/Counters
 - Two 8051-compatible Timers
 - Two with Capture/Compare/PWM Capability
 - Two with Compare/PWM Capability
- Serial Interfaces
 - Two 8051-compatible UARTs, One with a Dedicated Internal Baud Rate Generator
 - I²C™ Interface
- A/D Converter
 - Eight Analog Inputs, 12-bit Resolution
 - 500,000 Samples/second
- D/A Converters
 - Two Independent Analog Output Channels
 - 8-bit Resolution
- Waveform Generators
 - Twin D/A Converters are Driven by Dual Waveform Generators with 128-byte Wavetable RAMs
 - Flexible Clocking and Indexing
- Sixteen High Current Output Pins
- Up to 56 General-Purpose I/O Pins

- Interrupt Controller
 - 8 External Interrupt Pins
 - 13 Internal Interrupt Sources
 - 4 Software-Selectable Interrupt Priorities
- Watchdog Timer
- Flexible Internal Clocking Architecture
- Low Power Modes: Active, Idle, Stop
- 3.3 V ($\pm 10\%$) Power Supply
- 100-Pin LQFP Package

1.2 Description

The LZ87010 is a high-performance, feature-rich 8-bit microcontroller based on the 8051 microprocessor architecture. It combines:

- A high-performance, enhanced 8051 core that gives performance equivalent to a 240 MHz 8051
- Large amounts of on-chip memory, including 64KB of Flash program memory and 4.25KB of data memory (256 bytes of scratchpad RAM and 4,096 bytes of MOVX data RAM) to support complex applications
- A wide range of I/O devices, including:
 - Two UARTs
 - Six counter/timers
 - An eight-input 12-bit ADC
 - Two wavetable-driven analog outputs
 - An I²C serial port
 - A dedicated serial debug interface
 - Up to 16 high-current output signals
 - Up to 56 general-purpose I/O signals.

Extended features are accessed through special function registers (SFRs) that were unsigned in the original 8051. Two new instructions have been added to allow software breakpoints and writes to code memory.

1.3 Pin Diagram

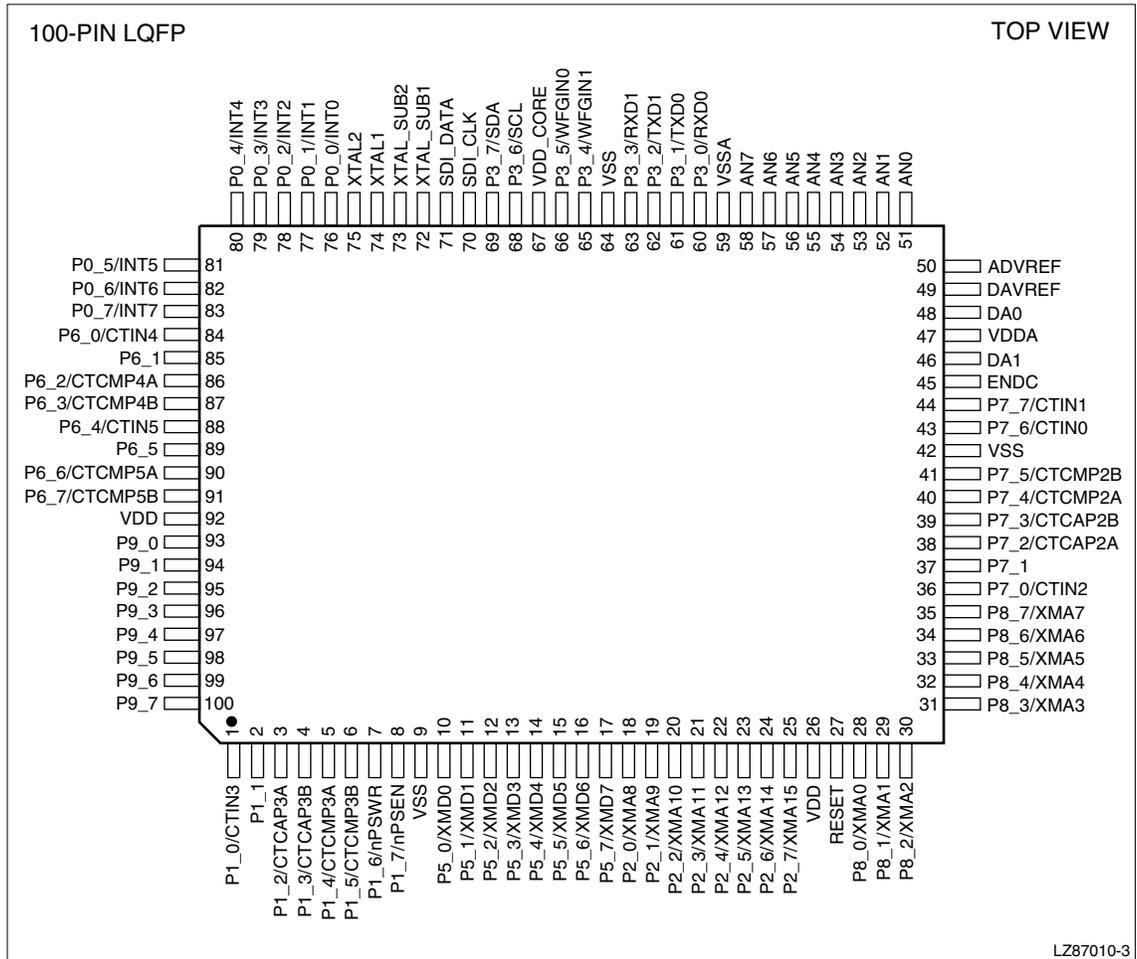


Figure 1-1. LZ87010 Pin Diagram

1.4 Block Diagram

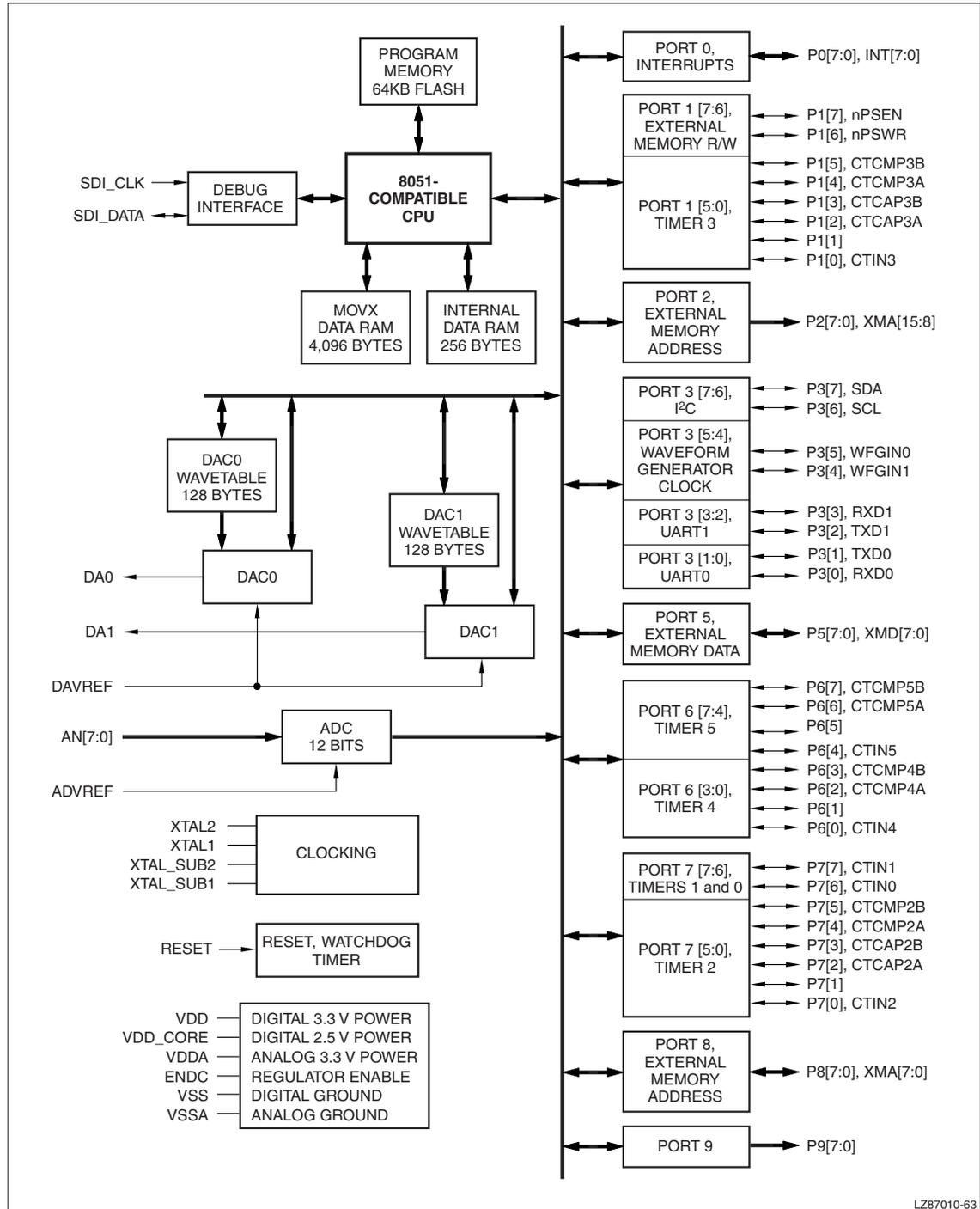


Figure 1-2. LZ87010 Block Diagram

LZ87010-63

1.5 Signal Descriptions

Table 1-1. Signal Descriptions, Listed Alphabetically

SIGNAL NAME	SIGNAL TYPE*	PIN NO.	PIN TYPE	FUNCTIONAL UNIT	SHARED WITH	DESCRIPTION
ADVREF	I	50	I	ADC		Analog input. Voltage Reference for Analog-to-Digital Converter; sets upper limit of conversion range.
AN[7:0]	I	58:51	I	ADC		Analog Input Ports
CTCAP2A	I	38	I/O	Timers	P7[2]	Timer 2 Capture 0 Input
CTCAP2B	I	39	I/O	Timers	P7[3]	Timer 2 Capture 1 Input
CTCAP3A	I	3	I/O	Timers	P1[2]	Timer 3 Capture 0 Input
CTCAP3B	I	4	I/O	Timers	P1[3]	Timer 3 Capture 1 Input
CTCMP2A	O	40	I/O	Timers	P7[4]	Timer 2 Compare 0 Output
CTCMP2B	O	41	I/O	Timers	P7[5]	Timer 2 Compare 1 Output
CTCMP3A	O	5	I/O	Timers	P1[4]	Timer 3 Compare 0 Output
CTCMP3B	O	6	I/O	Timers	P1[5]	Timer 3 Compare 1 Output
CTCMP4A	O	86	I/O	Timers	P6[2]	Timer 4 Compare 0 Output
CTCMP4B	O	87	I/O	Timers	P6[3]	Timer 4 Compare 1 Output
CTCMP5A	O	90	I/O	Timers	P6[6]	Timer 5 Compare 0 Output
CTCMP5B	O	91	I/O	Timers	P6[7]	Timer 5 Compare 1 Output
CTIN0	I	43	I/O	Timers	P7[6]	Timer 0 Clock Input
CTIN1	I	44	I/O	Timers	P7[7]	Timer 1 Clock Input
CTIN2	I	36	I/O	Timers	P7[0]	Timer 2 Clock Input
CTIN3	I	1	I/O	Timers	P1[0]	Timer 3 Clock Input
CTIN4	I	84	I/O	Timers	P6[0]	Timer 4 Clock Input
CTIN5	I	88	I/O	Timers	P6[4]	Timer 5 Clock Input
DA0	O	48	O	DACs		Waveform Generator 0 Analog Output
DA1	O	46	O	DACs		Waveform Generator 1 Analog Output
DAVREF	I	49	I	DACs		Voltage Reference for Digital-to-Analog Converters; sets upper limit of conversion range
ENDC	I	45	I	Power		Internal Voltage Regulator Enable. If HIGH, 2.5 V core voltage is supplied by internal regulator from 3.3 V supply. If LOW, 2.5 V core voltage is supplied externally on VDD_CORE.
INT[7:0]	I	83:76	I/O	Interrupts	P0[7:0]	Interrupt Request Signals
nPSEN	O	8	I/O	External Memory	P1[7]	External Memory Output Enable
nPSWR	O	7	I/O	External Memory	P1[6]	External Memory Read/Write
P0[7:0]	I/O	83:76	I/O	Ports	INT[7:0]	General Purpose Input/Output Pin
P1[0]	I/O	1	I/O	Ports	CTIN3	General Purpose Input/Output Pin
P1[1]	I/O	2	I/O	Ports		General Purpose Input/Output Pin
P1[2]	I/O	3	I/O	Ports	CTCAP3A	General Purpose Input/Output Pin
P1[3]	I/O	4	I/O	Ports	CTCAP3B	General Purpose Input/Output Pin
P1[4]	I/O	5	I/O	Ports	CTCMP3A	General Purpose Input/Output Pin
P1[5]	I/O	6	I/O	Ports	CTCMP3B	General Purpose Input/Output Pin
P1[6]	I/O	7	I/O	Ports	nPSWR	General Purpose Input/Output Pin

Table 1-1. Signal Descriptions, Listed Alphabetically (Cont'd)

SIGNAL NAME	SIGNAL TYPE*	PIN NO.	PIN TYPE	FUNCTIONAL UNIT	SHARED WITH	DESCRIPTION
P1[7]	I/O	8	I/O	Ports	nPSEN	General Purpose Input/Output Pin
P2[7:0]	O	25:18	O	Ports	XMA[15:8]	General Purpose Output-Only Port (High Current)
P3[0]	I/O	60	I/O	Ports	RXD0	General Purpose Input/Output Pin
P3[1]	I/O	61	I/O	Ports	TXD0	General Purpose Input/Output Pin
P3[2]	I/O	62	I/O	Ports	TXD1	General Purpose Input/Output Pin
P3[3]	I/O	63	I/O	Ports	RXD1	General Purpose Input/Output Pin
P3[4]	I/O	65	I/O	Ports	WFGIN1	General Purpose Input/Output Pin
P3[5]	I/O	66	I/O	Ports	WFGIN0	General Purpose Input/Output Pin
P3[6]	I/O	68	I/O	Ports	SCL	General Purpose Input/Output Pin (Open Collector)
P3[7]	I/O	69	I/O	Ports	SDA	General Purpose Input/Output Pin (Open Collector)
P4[7:0]						Port 4 is not implemented in the LZ87010.
P5[7:0]	I/O	17:10	I/O	Ports	XMD[7:0]	General Purpose Input/Output Pin
P6[0]	I/O	84	I/O	Ports	CTIN4	General Purpose Input/Output Pin
P6[1]	I/O	85	I/O	Ports		General Purpose Input/Output Pin
P6[2]	I/O	86	I/O	Ports	CTCMP4A	General Purpose Input/Output Pin
P6[3]	I/O	87	I/O	Ports	CTCMP4B	General Purpose Input/Output Pin
P6[4]	I/O	88	I/O	Ports	CTIN5	General Purpose Input/Output Pin
P6[5]	I/O	89	I/O	Ports		General Purpose Input/Output Pin
P6[6]	I/O	90	I/O	Ports	CTCMP5A	General Purpose Input/Output Pin
P6[7]	I/O	91	I/O	Ports	CTCMP5B	General Purpose Input/Output Pin
P7[0]	I/O	36	I/O	Ports	CTIN2	General Purpose Input/Output Pin
P7[1]	I/O	37	I/O	Ports		General Purpose Input/Output Pin
P7[2]	I/O	38	I/O	Ports	CTCAP2A	General Purpose Input/Output Pin
P7[3]	I/O	39	I/O	Ports	CTCAP2B	General Purpose Input/Output Pin
P7[4]	I/O	40	I/O	Ports	CTCMP2A	General Purpose Input/Output Pin
P7[5]	I/O	41	I/O	Ports	CTCMP2B	General Purpose Input/Output Pin
P7[6]	I/O	43	I/O	Ports	CTIN0	General Purpose Input/Output Pin
P7[7]	I/O	44	I/O	Ports	CTIN1	General Purpose Input/Output Pin
P8[7:0]	I/O	35:28	I/O	Ports	XMA[7:0]	General Purpose Input/Output Pin
P9[7:0]	O	100:93	O	Ports		General Purpose Output-Only Port (High Current)
RESET	I	27	I	Reset		System Reset
RXD0	I	60	I/O	UART	P3[0]	UART 0 Receive Data
RXD1	I	63	I/O	UART	P3[3]	UART 1 Receive Data
SCL	I/O	68	I/O	I ² C	P3[6]	I ² C Bus Clock (Open Collector)
SDA	I/O	69	I/O	I ² C	P3[7]	I ² C Bus Data (Open Collector)
SDI_CLK	I	70	I	Debug		SHARP Debug Interface Clock
SDI_DATA	I/O	71	I/O	Debug		SHARP Debug Interface Data
TXD0	O	61	I/O	UART	P3[1]	UART 0 Transmit Data
TXD1	O	62	I/O	UART	P3[2]	UART 1 Transmit Data
VDD	PWR	26, 92	PWR	Power		Main Digital Power Supply, 3.3 V ± 10%

Table 1-1. Signal Descriptions, Listed Alphabetically (Cont'd)

SIGNAL NAME	SIGNAL TYPE*	PIN NO.	PIN TYPE	FUNCTIONAL UNIT	SHARED WITH	DESCRIPTION
VDD_CORE	PWR	67	PWR	Power		Core Power Supply. Normally connected only to a 4.7 μ F tantalum bypass capacitor.
VDDA	PWR	47	PWR	Power		Analog Power, 3.3 V \pm 10%. Must be derived from VDD
VSS	GND	9, 42, 64	GND	Power		Digital Ground
VSSA	GND	59	GND	Power		Analog Ground
WFGIN0	I	66	I/O	Waveform Generator	P3[5]	Waveform Generator Clock Input 0
WFGIN1	I	65	I/O	Waveform Generator	P3[4]	Waveform Generator Clock Input 1
XMA[15:8]	O	25:18	O	External Memory	P2	External Memory Address Bus, Upper 8 Bits
XMA[7:0]	O	35:28	I/O	External Memory	P8	External Memory Address Bus, Lower 8 Bits
XMD[7:0]	I/O	17:10	I/O	External Memory	P5	External Memory Data Bus
XTAL_SUB1	I	72	I/O	Clock		Crystal Oscillator Connection for 32 kHz subclock. If an external clock generator is used, this pin is the clock input.
XTAL_SUB2	O	73	I/O	Clock		Crystal Oscillator Connection for 32 kHz subclock. Connect to VSS if external clock generator is used.
XTAL1	I	74	I/O	Clock		Crystal Oscillator Connection for High-Frequency System Clock. If an external clock generator is used, this pin is the clock input.
XTAL2	O	75	I/O	Clock		Crystal Oscillator Connection for High-Frequency System Clock. Connect to VSS if external clock generator is used.

NOTE: *The signal type is shown for each use of a multi-use pin. For example, TXD0 and P3[1] share a pin. TXD0 is shown as O, while P3[1] is shown as I/O.

1.6 Functional Description

The broad range of features in the LZ87010 allows it to support complex applications, such as the one shown in Figure 1-3.

1.6.1 8051-Compatible Processor Core

The LZ87010 processor core is compatible with the industry-standard 8051. The additional features of the LZ87010 have been mapped to unused addresses in the SFR (special function register) memory space. Two new instructions add software breakpoints and allow writes to program memory.

The LZ87010 provides a sixfold increase in execution efficiency compared to the 8051 (two clock cycles per machine cycle instead of 12). Thus, a 40 MHz LZ87010 is equivalent in performance to a 240 MHz 8051.

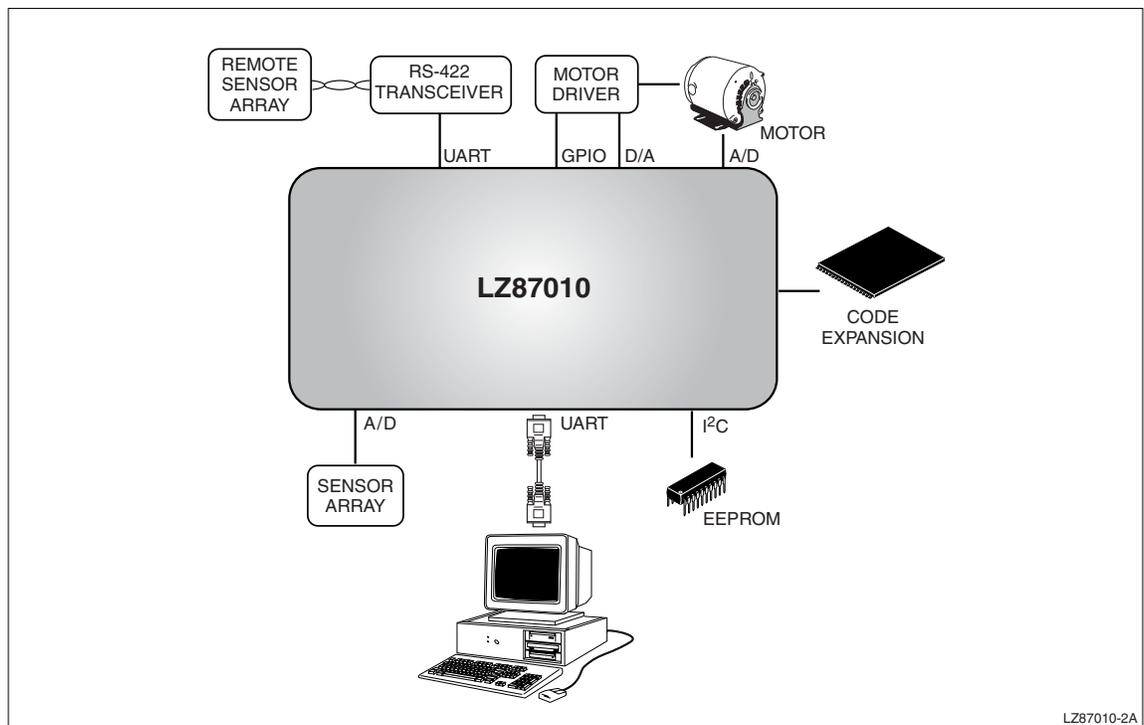


Figure 1-3. LZ87010 Application Diagram Example

1.6.2 Program Memory

Program memory is a 64K × 8 Flash array. On Reset, execution begins at Flash memory address 0. Program memory can also be used for read/write data storage.

This memory is shipped from the factory with all bytes set to 0xFF. Initial programming takes place under the control of either an external bulk programmer or the debug interface. Subsequent reprogramming can be controlled by an external bulk programmer, a boot-strap loader or the debug interface. Both sector erase and mass erase functions are supported (sectors are 512 bytes).

A security feature allows the program memory interface to be read-protected if desired, preventing its contents from being downloaded via the debug interface.

1.6.3 Internal Data RAM

The internal data RAM consists of 256 bytes of static RAM. The processor's direct and indirect addressing modes can access the lower 128 bytes of RAM, while the upper 128 bytes of RAM can be accessed by the indirect addressing mode only.

1.6.4 MOVX Data RAM

An additional 4KB of static RAM is provided on the chip and is accessible through the MOVX instruction.

1.6.5 SHARP Debug Interface

The debug interface uses a two-wire serial data channel to connect with external debugging hardware. Internally, it provides single-step support, start/stop control, breakpoint memory, trace memory, and read/write access to registers and memory. The internal Flash memory can be programmed over this interface. The pins of the debug interface are also used for manufacturing testing. See Figure 1-4.

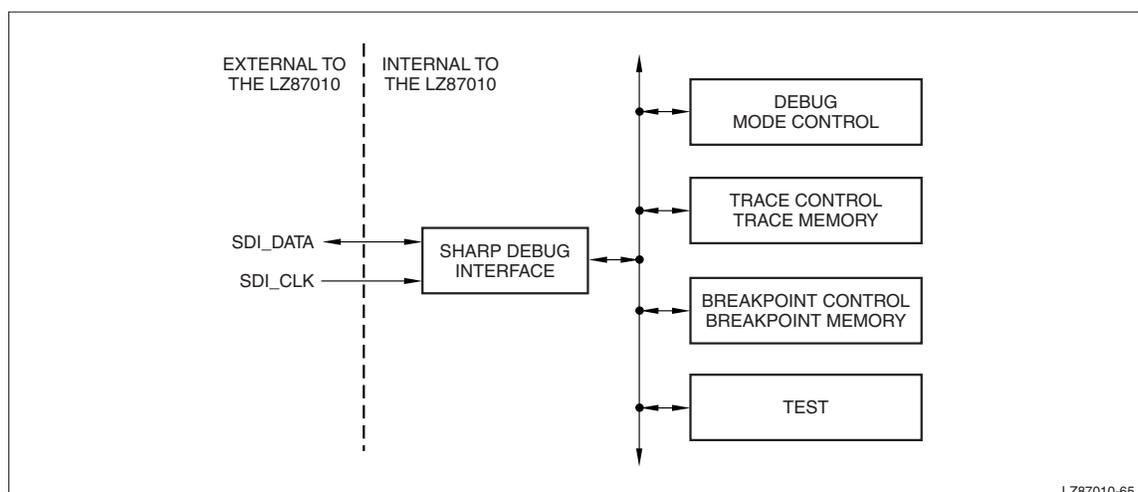


Figure 1-4. Sharp Debug Interface

1.6.6 Interrupt Controller

The interrupt controller arbitrates between 13 interrupt sources, each with its own execution vector. Each of these sources is assigned by software to one of four interrupt priority levels.

Eight external interrupt signals (INT[7:0]) are supported, sharing pins with Port 0. INT[0] and INT[1] each have their own interrupt vector, while INT[7:2] share a single vector. For these, the interrupt service routine identifies the asserted pin by reading Port 0 and scanning for set bits. External interrupts can be selected to be edge-sensitive or level-sensitive.

Table 1-2. Interrupt Sources and Vectors

DESCRIPTION	VECTOR ADDRESS	INTERRUPT LEVEL*
External Interrupt 0 (INT0 pin)	0x0003	0
Timer 0	0x000B	1
External Interrupt 1 (INT1 pin)	0x0013	2
Timer 1	0x001B	3
UART 0	0x0023	4
Timer 4/Timer 5	0x0033	6
Timer 2/Timer 3	0x003B	7
I ² C	0x0043	8
UART 1	0x004B	9
ADC	0x0053	10
DAC 0 Waveform Generator	0x005B	11
DAC 1 Waveform Generator	0x0063	12
External Interrupt 2 (INT7:2 pins)	0x006B	13

NOTE: *The interrupt level shows the order in which simultaneous interrupts will be serviced if they are all set to the same priority level. The lowest level is serviced first. Levels 5 and 14 are not implemented in the LZ87010.

1.6.7 External Program Memory Interface

The external program memory interface supports up to 64KB of off-chip memory that can be used for both code and data. (Banking can extend this address space by using general-purpose I/O pins to provide additional high-order address bits). The interface provides 16 address pins, 8 data pins, and two control pins: nPSEN and nPSWR (read and write enables, respectively). It provides glueless support for static RAM, ROM, EPROM, and EEPROM devices. The XMCFG register enables external memory access, determines how much of the internal Flash will be replaced by external memory, and sets the number of wait states.

The standard MOVC instruction allows software to read external program memory. An extended instruction (MOVC @(DPTR++),A) allows software to write it as well.

1.6.8 I/O Ports

Nine 8-bit ports can be assigned to up to 72 of the LZ87010's 100 pins. Seven of these ports provide general-purpose I/O functions on all pins. Two provide high-current outputs.

Most I/O ports are dual-purpose and have both a dedicated function (such as TXD0, the Transmit Data output of UART 0) and a generalized I/O function (such as P3[1]).

The read/write ports contain weak internal pull-up resistors with a nominal value of 90 k Ω . When a '1' bit is written, the port is driven strongly HIGH for one cycle, then tri-stated. This drives the signal HIGH more quickly than is possible with a weak pull-up alone. The pull-up then maintains the HIGH state. When a '0' bit is written to a port, it is driven LOW continuously. The port should be written with '1' bits before being used in read mode to place the port in a high-impedance state.

The output-only ports (PORT 2 and PORT 9) are driven continuously in both the HIGH and LOW output states. Reads from these registers return the last value written.

1.6.9 UARTs

The LZ87010 contains two general-purpose serial interfaces: UART 0 and UART 1. Both are 8051-compatible. UART 1 adds a dedicated internal baud-rate generator.

1.6.10 I²C Interface

A two-wire serial interface provides master and slave communications using the industry-standard I²C protocol, in both standard mode (100 kbit/s) and fast mode (400 kbit/s).

1.6.11 Analog Inputs (ADC)

Analog-to-digital conversion is provided for eight analog inputs, with 12-bit resolution over the range of 0 to 3.3 V. The analog input section consists of an 8-input analog MUX, an analog voltage reference input pin, and a single ADC with sample-and-hold.

Analog-to-digital conversions are initiated under software control, and a status bit reports when the conversion is complete. A separate ADC clock divider allows the ADC unit to operate at a different frequency from the core.

1.6.12 Analog Outputs (DACs) and Waveform Generators

Two identical 8-bit digital-to-analog converters, DAC 0 and DAC 1, provide analog outputs. Each DAC has a 128 byte waveform RAM that can provide output waveforms of any desired shape. Programmable indexing, clocking, and interrupt generation make this function extremely flexible. The waveform generators can be bypassed when direct access to the DAC is desirable. The two DACs share a voltage reference input that sets the maximum output voltage.

1.6.13 Counter/Timer/PWM

Six timers are provided: two standard 8051 timers (Timer 0 and Timer 1) and four enhanced timers (Timer 2 through Timer 5). The enhanced timers use 16-bit counter/capture/compare registers and can be configured for the following functions:

- Interval timing, using either the system clock or the subclock (divided by a power of two between 1 and 32,768) as the interval
- Event timing, using an external pin as an event counter
- Signal capture (timers 2 and 3 only), using the timer to record when an input signal transition takes place
- Comparison, where the count is compared to a preselected value, and the result optionally written to an output pin
- Pulse-width modulation, where the counter and compare registers are used to modulate an output pin.

All of these functions can optionally generate an interrupt.

A one-second timer tick can be generated by selecting the 32.768 kHz subclock and applying the maximum clock divisor of 32,768.

1.6.14 Clocks

Two input clocks are used: a high-frequency system clock in the range of 20 - 40 MHz (XTAL1/XTAL2) and a low-frequency subclock running at 32.768 kHz (XTAL_SUB1/XTAL_SUB2). The LZ87010 supports clock generation through crystals connected directly to the device. See Figure 1-5. Alternatively, external clock generators can be used.

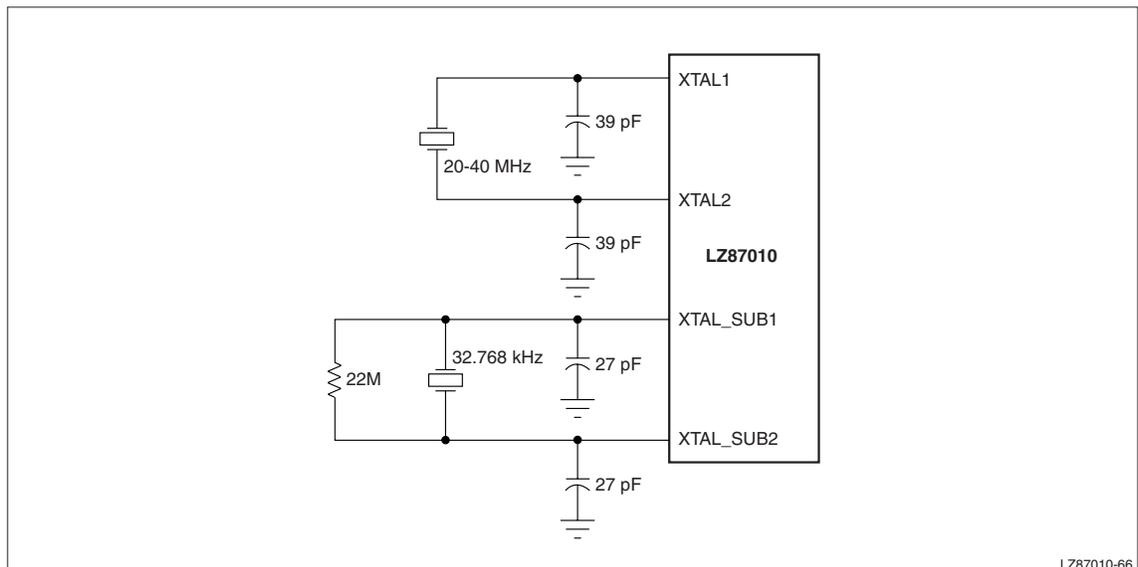


Figure 1-5. External Clock Circuitry

LZ87010-66

The active CPU clock source and clock divisor are chosen under software control. See Figure 1-6. Three main clocks are derived from this divided clock:

- CCLK, the core clock, which runs at the divided clock frequency. CCLK halts in both Idle and Stop modes.
- SCLK, the State Machine clock, which runs at the same frequency as CCLK. Unlike CCLK, SCLK continues to run in Idle mode, halting only in Stop mode.
- PCLK, the peripheral clock, which runs at half the speed of SCLK. PCLK runs in Active and Idle modes, and halts in Stop Mode.

Many of the peripherals, including the timers and UARTs, can perform additional clock division. Some can choose either of the two input clocks independently of the SCLK source. The ADC clock runs off the undivided system oscillator (XTAL1/XTAL2), applying its own clock division.

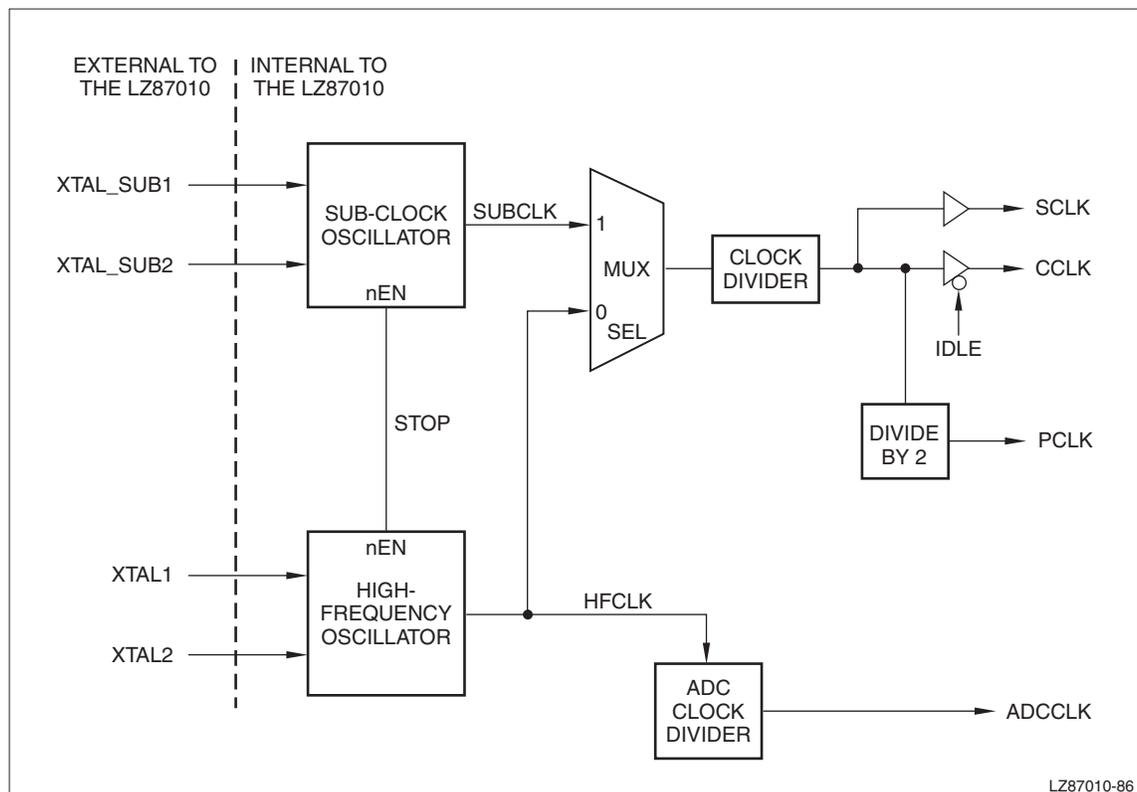


Figure 1-6. Simplified System Clocking

1.6.15 Reset

The RESET pin, when asserted HIGH, drives the entire device to a known state. Shortly after RESET is released, execution proceeds from address 0 in the embedded Flash program memory.

A watchdog timer, if enabled, will reset the chip after a period of inactivity.

1.6.16 Power and Ground

The LZ87010 is typically operated from a single 3.3 V supply. The device uses 2.5 V for the core, provided by an on-chip voltage regulator.

Separate analog power and ground pins are provided to allow extra filtering on the board for the analog power. The analog and digital supplies must be derived from the same source to prevent latch-up.

1.6.17 Low-Power Modes

The LZ87010 has three operating modes: Active, Idle, and Stop. In Idle mode, the oscillators continue to run and the peripherals remain active, but the processor core halts until an interrupt is received. In Stop mode, the oscillators are halted, the core and the peripherals halt, and operation can be resumed only by asserting RESET.

Power consumption is significantly reduced in low-power modes.

Further power savings can be obtained by disabling the internal voltage regulator (by tying ENDC LOW) and using an external 2.5 V power supply on the VDD_CORE pin.

1.7 Register Summary

The registers of the LZ87010 are listed in Table 1-7. As in the 8051, registers with addresses ending in 0x0 or 0x8 are bit-addressable.

Figure 1-7. Register Description by Functional Unit

NAME	ADDRESS*	DESCRIPTION
ADC REGISTERS		
ADCC	0xC3	ADC Control
ADC DL	0xC1	ADC Data [3:0]
ADC DH	0xC2	ADC Data [11:4]
CPU CORE REGISTERS		
ACC	0xE0*	Accumulator
ALTFEN1	0x95	Alternate Function Enables
B	0xF0*	B Register
CLKCFG	0x94	System Clock Configuration
DPH	0x83	Data Pointer [15:8]
DPH1	0x85	Data Pointer 1 [15:8]
DPL	0x82	Data Pointer [7:0]
DPL1	0x84	Data Pointer 1 [7:0]
DPS	0x86	Data Pointer Select and Extended Operation
IE	0xA8*	Interrupt Enable
IE1	0xE8*	Interrupt Enable 1
IP	0xB8*	Interrupt Priority Control
IP1	0xF8*	Interrupt Priority Control
IPH	0xB9	Interrupt Priority Control
IPH1	0xF9	Interrupt Priority Control
PSW	0xD0*	Program Status Word
SP	0x81	Stack Pointer
EXTERNAL MEMORY REGISTERS		
XMCFG	0xC5	External Memory Configuration
FLASH REGISTERS		
FLASHCFG	0x96	Flash Memory Configuration
FLASHTB	0x97	Flash Write Timebase
I²C REGISTERS		
ICCON	0xB4	I ² C Configuration
ICDATA	0xB7	I ² C Data
ICDEBUG	0xBE	I ² C Debug
ICHCNT	0xBC	I ² C Clock HIGH Time
ICLCNT	0xBD	I ² C Clock LOW Time
ICSAR	0xB5	I ² C Slave Addr [7:0]
ICSTAT	0xBF	I ² C Status
ICUSAR	0xB6	I ² C Slave Addr [9:8]
I/O PORT REGISTERS		
P0	0x80*	General-Purpose I/O Port 0
PORT 1	0x90*	General-Purpose I/O Port 1
PORT 2	0xA0*	Output Port 2

Figure 1-7. Register Description by Functional Unit (Cont'd)

NAME	ADDRESS*	DESCRIPTION
PORT 3	0xB0*	General-Purpose I/O Port 3
PORT 5	0x91	General-Purpose I/O Port 5
PORT 6	0xC0*	General-Purpose I/O Port 6
PORT 7	0xD8*	General-Purpose I/O Port 7
PORT 8	0x93	General-Purpose I/O Port 8
PORT 9	0xA9	Output Port 9
POWER REGISTERS		
DACC	0xC4	DAC Power Enable
PCON	0x87	Power Control
TIMER REGISTERS		
T2CAP	0xD9	Timer 2 Capture Control
T2CAP0H	0xDB	Timer 2 Capture 0 MSB
T2CAP0L	0xDA	Timer 2 Capture 0 LSB
T2CAP1H	0xDD	Timer 2 Capture 1 MSB
T2CAP1L	0xDC	Timer 2 Capture 1 LSB
T2CMP	0xD3	Timer 2 Compare Control
T2CMP0H	0xD5	Timer 2 Compare 0 MSB
T2CMP0L	0xD4	Timer 2 Compare 0 LSB
T2CMP1H	0xD7	Timer 2 Compare 1 MSB
T2CMP1L	0xD6	Timer 2 Compare 1 LSB
T2CNTH	0xDF	Timer 2 Count MSB
T2CNTL	0xDE	Timer 2 Count LSB
T2CON	0xD1	Timer 2 Control
T2STA	0xD2	Timer 2 Status
T3CAP	0xE9	Timer 3 Capture Control
T3CAP0H	0xEB	Timer 3 Capture 0 MSB
T3CAP0L	0xEA	Timer 3 Capture 0 LSB
T3CAP1H	0xED	Timer 3 Capture 1 MSB
T3CAP1L	0xEC	Timer 3 Capture 1 LSB
T3CMP	0xE3	Timer 3 Compare Control
T3CMP0H	0xE5	Timer 3 Compare 0 MSB
T3CMP0L	0xE4	Timer 3 Compare 0 LSB
T3CMP1H	0xE7	Timer 3 Compare 1 MSB
T3CMP1L	0xE6	Timer 3 Compare 1 LSB
T3CNTH	0xEF	Timer 3 Count MSB
T3CNTL	0xEE	Timer 3 Count LSB
T3CON	0xE1	Timer 3 Control
T3STA	0xE2	Timer 3 Status
T4CMP	0xF3	Timer 4 Compare Control
T4CMP0H	0xF5	Timer 4 Compare 0 MSB
T4CMP0L	0xF4	Timer 4 Compare 0 LSB
T4CMP1H	0xF7	Timer 4 Compare 1 MSB
T4CMP1L	0xF6	Timer 4 Compare 1 LSB
T4CNTH	0xFF	Timer 4 Count MSB
T4CNTL	0xFE	Timer 4 Count LSB

Figure 1-7. Register Description by Functional Unit (Cont'd)

NAME	ADDRESS*	DESCRIPTION
T4CON	0xF1	Timer 4 Control Register
T4STA	0xF2	Timer 4 Status
T5CMP	0xA3	Timer 5 Compare Control
T5CMP0H	0xA5	Timer 5 Compare 0 MSB
T5CMP0L	0xA4	Timer 5 Compare 0 LSB
T5CMP1H	0xA7	Timer 5 Compare 1 MSB
T5CMP1L	0xA6	Timer 5 Compare 1 LSB
T5CNTH	0xAF	Timer 5 Count MSB
T5CNTL	0xAE	Timer 5 Count LSB
T5CON	0xA1	Timer 5 Control
T5STA	0xA2	Timer 5 Status
TCMPOE	0xB3	Timer Compare Output Enable
TCON	0x88*	Timer/Counter 0 and 1 Control
TH0	0x8C	Timer/Counter 0 Data High
TH1	0x8D	Timer/Counter 1 Data High
TL0	0x8A	Timer/Counter 0 Data Low
TL1	0x8B	Timer/Counter 1 Data Low
TMOD	0x89	Timer/Counter 0 and 1 Mode
UART REGISTERS		
BRGCNTH	0xC7	Baud Rate Generator Timing [15:8]
BRGCNTL	0xC6	Baud Rate Generator Timing [7:0]
SBUF	0x99	UART 0 Data
SBUF1	0xC9	UART 1 Data
SCON	0x98*	UART 0 Control
SCON1	0xC8*	UART 1 Control
WATCHDOG RESET REGISTERS		
WDCNT	0xAD	Watchdog Timer Count
WDTCTL	0xAC	Watchdog Timer Control
WAVEFORM GENERATOR REGISTERS		
WGCFG0	0xCC	Waveform Generator 0 Configuration
WGCTL0	0xCA	Waveform Generator 0 Control
WGINX0	0xCE	Waveform Generator 0 Index
WGCFG1	0xCD	Waveform Generator 1 Configuration
WGCTL1	0xCB	Waveform Generator 1 Control
WGINX1	0xCF	Waveform Generator 1 Index
WGMD0	0xFB	Waveform Generator 0 Data
WGMD1	0xFD	Waveform Generator 1 Data
WGMA0	0xFA	Waveform Generator 0 Memory Address
WGMA1	0xFC	Waveform Generator 1 Memory Address

NOTE: *Registers marked with an asterisk (*) are bit-addressable.

1.8 Instruction Set Summary

The LZ87010 instruction set consists of the 8051 instruction set plus two new instructions: TRAP and MOVC @(DPTR++),A.

The TRAP instruction causes the LZ87010 to enter debug mode under software control. Once in debug mode, single-stepping and other debugging features can be used. Debug mode can also be entered under hardware control through the debug interface.

The MOVC @(DPTR++),A instruction allows code memory to be written. It copies the contents of the Accumulator to the code memory address pointed to by the DPTR register, then increments DPTR. This instruction writes to the currently selected code memory space (internal or external program memory).

Table 1-3 summarizes the LZ87010's instruction set. Table 1-4 lists the mnemonics for operands. Table 1-5 lists the instructions that affect flag bits.

CAUTION

Writing improperly to the Flash memory can damage the device. The appropriate Flash timings must be observed.

Table 1-3. Instruction Set Summary

INSTRUCTION	DESCRIPTION	BYTES	CYCLES
CALL addr 11	Absolute jump to subroutine	2	2
ADD A,#d	Add immediate to A	2	1
ADD A,@Ri	Add indirect memory to A	1	1
ADD A,dir	Add direct byte to A	2	1
ADD A,Rn	Add register to A	1	1
ADDC A,#d	Add immediate to A with carry	2	1
ADDC A,@Ri	Add indirect memory to A with carry	1	1
ADDC A,dir	Add direct byte to A with carry	2	1
ADDC A,Rn	Add register to A with carry	1	1
AJMP addr 11	Absolute jump unconditional	2	2
ANL A,#d	AND immediate to A	2	1
ANL A,@Ri	AND indirect memory to A	1	1
ANL A,dir	AND direct byte to A	2	1
ANL A,Rn	AND register to A	1	1
ANL C,/bit	AND direct bit inverse to carry	2	2
ANL C,bit	AND direct bit to carry	2	2
ANL dir,#d	AND immediate to direct byte	3	2
ANL dir,A	AND A to direct byte	2	1
CJNE @Ri,#d,rel	Compare indirect immediate, jump if not equal	3	2
CJNE A,#d,rel	Compare A immediate, jump if not equal	3	2
CJNE A,dir,rel	Compare A direct, jump if not equal	3	2

Table 1-3. Instruction Set Summary (Cont'd)

INSTRUCTION	DESCRIPTION	BYTES	CYCLES
CJNE Rn,#d,rel	Compare register immediate, jump if not equal	3	2
CLR A	Clear A	1	1
CLR bit	Clear direct bit	2	1
CLR C	Clear carry	1	1
CPL A	Complement A	1	1
CPL bit	Complement direct bit	2	1
CPL C	Complement carry	1	1
DA A	Decimal Adjust A	1	1
DEC @Ri	Decrement indirect memory	1	1
DEC A	Decrement A	1	1
DEC dir	Decrement direct byte	2	1
DEC Rn	Decrement register	1	1
DIV AB	Divide A by B	1	4
DJNZ dir,rel	Decrement direct byte, jump if not zero	3	2
DJNZ Rn,rel	Decrement register, jump if not zero	2	2
INC @Ri	Increment indirect memory	1	1
INC A	Increment A	1	1
INC dir	Increment direct byte	2	1
INC DPTR	Increment data pointer	1	2
INC Rn	Increment register	1	1
JB bit,rel	Jump on direct bit set	3	2
JBC bit,rel	Jump on direct bit set, clear bit	3	2
JC rel	Jump on carry bit set	2	2
JMP @A+DPTR	Jump indirect relative to data pointer	1	2
JNB bit,rel	Jump on direct bit clear	3	2
JNC rel	Jump on carry bit clear	2	2
JNZ rel	Jump on accumulator not equal to zero	2	2
JZ rel	Jump on accumulator equal to zero	2	2
LCALL addr 16	Long jump to subroutine	3	2
LJMP addr 16	Long jump (unconditional)	3	2
MOV @Ri,#d	Move immediate to indirect memory	2	1
MOV @Ri,A	Move A to indirect memory	1	1
MOV @Ri,dir	Move direct byte to indirect memory	2	2
MOV A,#d	Move immediate to A	2	1
MOV A,@Ri	Move indirect memory to A	1	1
MOV A,dir	Move direct byte to A	2	1
MOV A,Rn	Move register to A	1	1
MOV bit,C	Move carry to direct bit	2	2
MOV C,bit	Move direct bit to carry	2	1

Table 1-3. Instruction Set Summary (Cont'd)

INSTRUCTION	DESCRIPTION	BYTES	CYCLES
MOV dir,#d	Move immediate to direct byte	3	2
MOV dir,@Ri	Move indirect memory to direct byte	2	2
MOV dir,A	Move A to direct byte	2	1
MOV dir,dir	Move direct byte to direct byte	3	2
MOV dir,Rn	Move register to direct byte	2	2
MOV DPTR,#dd	Move immediate to data pointer	3	2
MOV Rn,#d	Move immediate to register	2	1
MOV Rn,A	Move A to register	1	1
MOV Rn,dir	Move direct byte to register	2	2
MOVC @(DPTR++),A	Write program memory	1	2
MOVC A,@A+DPTR	Move code byte relative DPTR to A	1	2
MOVC A,@A+PC	Move code byte relative PC to A	1	2
MOVX @DPTR,A	Move A to 'external' data RAM (16-bit address)*	1	2
MOVX @Ri,A	Move A to 'external' data RAM (8-bit address)*	1	2
MOVX A,@DPTR	Move 'external' data (16-bit address) to A*	1	2
MOVX A,@Ri	Move 'external' data (8-bit address) to A*	1	2
MUL AB	Multiply A by B	1	4
NOP	No Operation	1	1
ORL A,#d	OR immediate to A	2	1
ORL A,@Ri	OR indirect memory to A	1	1
ORL A,dir	OR direct byte to A	2	1
ORL A,Rn	OR register to A	1	1
ORL C,/bit	OR direct bit inverse to carry	2	2
ORL C,bit	OR direct bit to carry	2	2
ORL dir,#d	OR immediate to direct byte	3	2
ORL dir,A	OR A to direct byte	2	1
POP dir	Pop direct byte from stack	2	2
PUSH dir	Push direct byte onto stack	2	2
RET	Return from subroutine	1	2
RETI	Return from interrupt	1	2
RL A	Rotate A left	1	1
RLC A	Rotate A left through carry	1	1
RR A	Rotate A right	1	1
RRC A	Rotate A right through carry	1	1
SETB bit	Set direct bit	2	1
SETB C	Set carry bit	1	1
SJMP rel	Short jump (relative address)	2	2
SUBB A,#d	Subtract immediate from A with borrow	2	1
SUBB A,@Ri	Subtract indirect memory from A with borrow	1	1

Table 1-3. Instruction Set Summary (Cont'd)

INSTRUCTION	DESCRIPTION	BYTES	CYCLES
SUBB A,dir	Subtract direct byte from A with borrow	2	1
SUBB A,Rn	Subtract register from A with borrow	1	1
SWAP A	Swap nibbles of A	1	1
TRAP	Software break command	1	1
XCH A,@Ri	Exchange A and indirect memory	1	1
XCH A,dir	Exchange A and direct byte	2	1
XCH A,Rn	Exchange A and register	1	1
XCHD A,@Ri	Exchange A and indirect memory nibble	1	1
XRL A,@Ri	Exclusive-OR indirect memory to A	1	1
XRL A,#d	Exclusive-OR immediate to A	2	1
XRL A,dir	Exclusive-OR direct byte to A	2	1
XRL A,Rn	Exclusive-OR register to A	1	1
XRL dir,#d	Exclusive-OR immediate to direct byte	3	2
XRL dir,A	Exclusive-OR A to direct byte	2	1

NOTE: *'External' data memory is actually on-chip in the LZ87010.

Table 1-4. Operand Types

SYMBOL	DESCRIPTION
#d	Immediate data, 8 bits wide, included as part of the instruction
#dd	Immediate data, 16 bits wide, included as part of the instruction
@Ri	Indirect addressing mode. Register R0 (if i=0) or R1 (if i=1) contains the 8-bit address of the operation. The full range of 0x00 to 0xFF refers to internal RAM.
addr 11	11-bit address. The upper 5 bits of the program counter are used to extend this address to 16 bits. This form of addressing is limited to the 2KB block of memory containing the instruction.
addr 16	16-bit absolute address, included as part of the instruction
bit	Direct-addressed bit in internal RAM or SFR
dir	Direct addressing mode. Addresses 0x00-0x7F refer to internal RAM. Addresses 0x80-0xFF refer to SFRs.
rel	Two's complement address offset, relative to the program counter
Rn	Register R0-R7 in the currently selected register bank

Table 1-5. Instructions' Effect on Flag Bits

INSTRUCTION	C	OV	AC
ADD	x	x	x
ADDC	x	x	x
SUBB	x	x	x
MUL	0	x	
DIV	0	x	
DA	x		
RRC	x		
RLC	x		
SETB C	1		
CLR C	0		
CPL C	x		
ANL C, bit	x		
ANL C, /bit	x		
ORL C, bit	x		
ORL C, /bit	x		
MOV C, bit	x		
CJNE	x		

Table 1-6. Command Matrix

	x0	x1	x2	x3	x4	x5	x6	x7	x8-xF
0x	NOP 1,1	AJMP addr 11 2,2	LJMP addr 16 3,2	RR A 1,1	INC A 1,1	INC dir 2,1	INC @R0 1,1	INC @R1 1,1	INC Rn 1,1
1x	JBC bit,rel 3,2	ACALL addr 11 2,2	LCALL addr 16 3,2	RRC A 1,1	DEC A 1,1	DEC dir 2,1	DEC @R0 1,1	DEC @R1 1,1	DEC Rn 1,1
2x	JB bit,rel 3,2	AJMP addr 11 2,2	RET 1,2	RL A 1,1	ADD A,#d 2,1	ADD A,dir 2,1	ADD A,@R0 1,1	ADD A,@R1 1,1	ADD A,Rn 1,1
3x	JNB bit,rel 3,2	ACALL addr 11 2,2	RETI 1,2	RLC A 1,1	ADDC A,#d 2,1	ADDC A,dir 2,1	ADDC A,@R0 1,1	ADDC A,@R1 1,1	ADDC A,Rn 1,1
4x	JC rel 2,2	AJMP addr 11 2,2	ORL dir,A 2,1	ORL dir,#d 3,2	ORL A,#d 2,1	ORL A,dir 2,1	ORL A,@R0 1,1	ORL A,@R1 1,1	ORL A,Rn 1,1
5x	JNC rel 2,2	ACALL addr 11 2,2	ANL dir,A 2,1	ANL dir,#d 3,2	ANL A,#d 2,1	ANL A,dir 2,1	ANL A,@R0 1,1	ANL A,@R1 1,1	ANL A,Rn 1,1
6x	JZ rel 2,2	AJMP addr 11 2,2	XRL dir,A 2,1	XRL dir,#d 3,2	XRL A,#d 2,1	XRL A,dir 2,1	XRL A,@R0 1,1	XRL A,@R1 1,1	XRL A,Rn 1,1
7x	JNZ rel 2,2	ACALL addr 11 2,2	ORL C,bit 2,2	JMP @A+DPTR 1,2	MOV A,#d 2,1	MOV dir,#d 3,2	MOV @R0,#d 2,1	MOV @R1,#d 2,1	MOV Rn,#d 2,1
8x	SJMP rel 2,2	AJMP addr 11 2,2	ANL C,bit 2,2	MOVC A,@A+PC 1,2	DIV AB 1,4	MOV dir,dir 3,2	MOV dir,@R0 2,2	MOV dir,@R1 2,2	MOV dir,Rn 2,2
9x	MOV DPTR,#dd 3,2	ACALL addr 11 2,2	MOV bit,C 2,2	MOVC A,@A+DPTR 1,2	SUBB A,#d 2,1	SUBB A,dir 2,1	SUBB A,@R0 1,1	SUBB A,@R1 1,1	SUBB A,Rn 1,1
Ax	ORL C,/bit 2,2	AJMP addr 11 2,2	MOV C,bit 2,1	INC DPTR 1,2	MUL AB 1,4	MOVC @(DPTR++),A 1,2	MOV @R0,dir 2,2	MOV @R1,dir 2,2	MOV Rn,dir 2,2
Bx	ANL C,/bit 2,2	ACALL addr 11 2,2	CPL bit 2,1	CPL C 1,1	CJNE A,#d,rel 3,2	CJNE A,dir,rel 3,2	CJNE @R0,#d,rel 3,2	CJNE @R1,#d,rel 3,2	CJNE Rn,#d,rel 3,2
Cx	PUSH dir 2,2	AJMP addr 11 2,2	CLR bit 2,1	CLR C 1,1	SWAP A 1,1	XCH A,dir 2,1	XCH A,@R0 1,1	XCH A,@R1 1,1	XCH A,Rn 1,1
Dx	POP dir 2,2	ACALL addr 11 2,2	SETB bit 2,1	SETB C 1,1	DA A 1,1	DJNZ dir,rel 3,2	XCHD A,@R0 1,1	XCHD A,@R1 1,1	DJNZ Rn,rel 2,2
Ex	MOVX A,@DPTR 1,2	AJMP addr 11 2,2	MOVX A,@R0 1,2	MOVX A,@R1 1,2	CLR A 1,1	MOV A,dir 2,1	MOV A,@R0 1,1	MOV A,@R1 1,1	MOV A,Rn 1,1
Fx	MOVX @DPTR,A 1,2	ACALL addr 11 2,2	MOVX @R0,A 1,2	MOVX @R1,A 1,2	CPL A 1,1	MOV dir,A 2,1	MOV @R0,A 1,1	MOV @R1,A 1,1	MOV Rn,A 1,1

NOTES:

1. #d is an 8-bit immediate; #dd is a 16-bit immediate.
2. Bottom row gives bytes, cycles.
3. In rightmost column, 'n' in 'Rn' ranges from 0x0-0x7 for opcodes ending in 0x8-0xF.
4. Opcode 0xA5 is also used for the TRAP instruction (1 byte, 1 cycle). The DPS register controls which instruction is active.

Chapter 2

System Clocking

2.1 Theory of Operation

System clocking in the LZ87010 is provided by two sets of clock inputs: high-frequency inputs XTAL1 and XTAL2, and low-frequency subclock inputs XTAL_SUB1 and XTAL_SUB2. These inputs can be used either with crystal oscillators or external clock generators, as shown in Figure 2-1.

The high-frequency oscillator operation is guaranteed from 20 MHz to 40 MHz. The low-frequency oscillator is optimized for 32.768 kHz.

The oscillator circuit operates in Active and Standby modes, but in Stop mode the oscillator is disabled. This means that Stop mode must be exited through a valid reset sequence, and the oscillators must be given time to achieve stability before the reset is concluded.

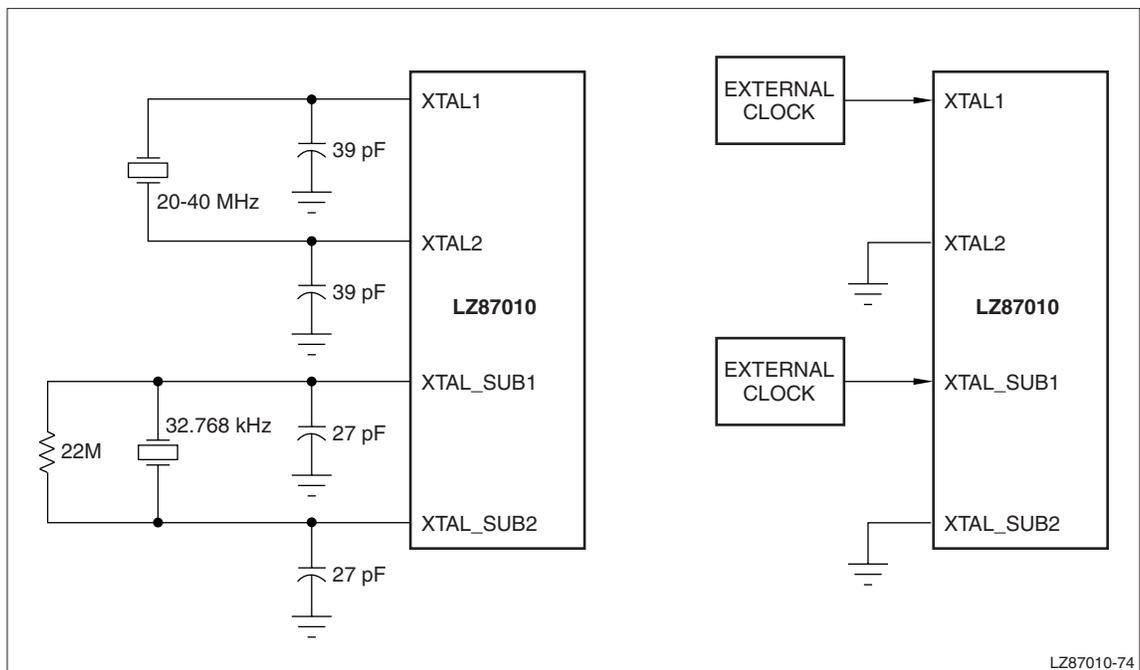


Figure 2-1. System Oscillator Alternatives

2.1.1 Internal Clocks

Internal clocking is shown in Figure 2-2. The individual clock signals are described here.

2.1.1.1 HFCLK

This is the output of the high-frequency oscillator on the XTAL1 and XTAL2 pins. It is used by the ADC and the system clock generator. HFCLK halts in Stop mode.

2.1.1.2 SUBCLK

This is the output of the 32 kHz subclock oscillator on the XTAL_SUB1 and XTAL_SUB2 pins. It provides a low-frequency clock for the enhanced timer units and can be used as the system clock when low-frequency operation is desired. The subclock halts in Stop mode.

2.1.1.3 CCLK

The LZ87010 allows software to choose whether HFCLK or SUBCLK will be used as the processor core clock. The selected clock is divided by a software-selectable value (chosen from: 1, 2, 4, 8, 16, 32, 64, or 128). The resulting clock is called CCLK (Core Clock) and has a duty cycle of 50%. See Figure 2-2. CCLK halts in Idle and Stop modes.

2.1.1.4 SCLK

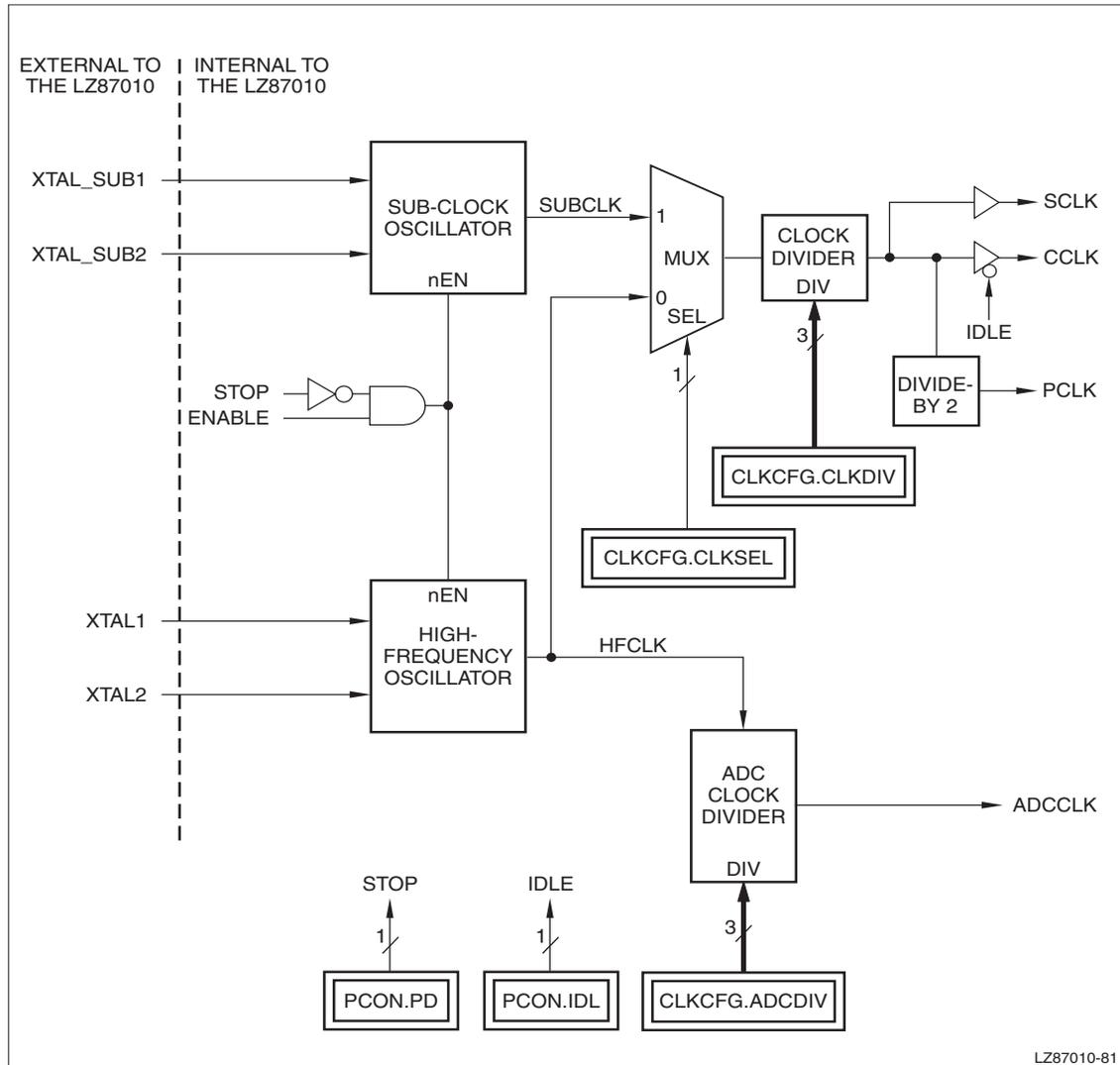
SCLK (State Machine Clock), runs at the same frequency as CCLK, but, unlike CCLK, it is not halted in Idle mode. Instead, it halts only in Stop mode. SCLK is used for internal state machines that are not visible to the user.

2.1.1.5 PCLK

PCLK (Peripheral Clock) is used to clock most of the peripherals in the LZ87010. PCLK always runs at half the speed of SCLK. It halts only in Stop mode.

2.1.1.6 ADCCLK

The ADC Clock (ADCCLK) is derived from HFCLK, and can be divided by 1, 3, 4, or 5. For proper ADC operation, the ADC clock divider should be selected to run ADCCLK within the range given in the AC Specifications. ADCCLK halts only in Stop mode.



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Figure 2-2. Internal Clock Generation

2.1.2 Power-Saving Modes

During periods when full operation is not required, significant power savings can be achieved by deactivating portions of the LZ87010 using the PCON register.

2.1.2.1 Idle Mode

When PCON.IDL is set to '1' by software, the microcontroller enters Idle Mode. In this mode, the processor core is halted (by stopping CCLK), but the peripherals (including the timers) continue to operate. The mode can be exited via an enabled interrupt (generated from either an internal or an external source). The interrupt causes the PCON.IDL bit to be reset to '0'.

Alternatively, Idle mode can be exited by asserting Reset.

Idle Mode is used in applications where continuous processing is not required, an example application being a keyboard controller. In this application, the core would be put into the Idle mode with a timer interrupt enabled and the timer running with an appropriate period (for instance, 15 ms). Each timer interrupt would cause the CPU to exit Idle Mode and execute a keyboard scanning routine to detect keypresses. At the end of the scanning routine, the CPU would be placed back in Idle mode.

The Watchdog Timer should be halted before the system is placed into Idle Mode, to preclude unwanted resets.

2.1.2.2 Stop Mode

Stop Mode is entered by setting PCON.PD to '1'. In this mode, the entire microcontroller is stopped. The oscillators are halted, and no clocking occurs within the device. Stop Mode can only be exited by asserting a Reset.

The external Reset that restarts the clocks after a Stop must allow for the recovery time of the high-frequency crystal oscillator, which is typically on the order of a few milliseconds.

In addition to explicit power-saving modes, it is possible to save power by reducing the clock frequency by choosing a large clock divisor in the CLKCFG.CLKDIV field, or by clocking the system with the subclock instead of the main clock.

2.2 Signals

Table 2-1 details the system clocking signals.

Table 2-1. System Clock Signals

SIGNAL NAME	SIGNAL TYPE	PIN NO.	PIN TYPE	FUNCTIONAL UNIT	DESCRIPTION
XTAL_SUB1	I	72	I/O	Clock	Subclock Crystal When a 32.768 kHz crystal is used, this pin connects to one of the crystal pins. When an external clock generator is used, this pin is the clock input. If the subclock is not needed, this pin should be tied to VDD.
XTAL_SUB2	O	73	I/O	Clock	Subclock Crystal When a 32.768 kHz crystal is used, this pin connects to one of the crystal pins. Otherwise, this pin is tied to VSS.
XTAL1	I	74	I/O	Clock	System Crystal When a 20-40 MHz crystal is used for the high-frequency system oscillator, this signal connects to one of the crystal pins. When an external clock generator is used, this pin is the clock input.
XTAL2	O	75	I/O	Clock	System Crystal When a 20-40 MHz crystal is used for the high-frequency system oscillator, this signal connects to one of the crystal pins. When an external clock generator is used, this pin connects to VSS.

2.3 Registers

2.3.1 CLKCFG (Clock Configuration) Register

The CLKCFG (Clock Configuration) register determines the active system clock, the current system clock divider, and the current ADC clock divider.

Table 2-2. CLKCFG (Clock Configuration) Register

BIT	7	6	5	4	3	2	1	0
FIELD	CLKSEL	///	CLKADC[2]	CLKADC[1]	CLKADC[0]	CLKDIV[2]	CLKDIV[1]	CLKDIV[0]
RESET	0	0	1	0	1	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0x94							

Table 2-3. CLKCFG Register Fields

BIT	NAME	DESCRIPTION
7	CLKSEL	Clock Select Selects the oscillator used for the system clocks (CCLK, SCLK, and PCLK). When '1', the core clock source is the 32 kHz subclock (SUBCLK) oscillator, when '0' it is the high-frequency (HFCLK) oscillator. The selected clock is divided as specified in the CLKDIV[2:0] field to generate CCLK and SCLK. SCLK is divided by 2 to generate PCLK.
6	///	Reserved Reads return 0; writes are ignored.
5:3	CLKADC	A/D Converter Clock Divider The ADC clock (ADCCLK) is derived from the high-frequency oscillator (HFCLK) by dividing it as specified in this field, which is decoded as shown in Table 2-4.
2:0	CLKDIV	Clock Divider CCLK and SCLK are generated by dividing HFCLK by a value encoded in the CLKDIV[2:0] field. The encoding is shown in Table 2-5.

Table 2-4. CLKADC[2:0] Encoding

CLKADC[2:0]	DIVIDE HFCLK BY
000	1
011	3
100	4
Others	5

Table 2-5. CLKDIV[2:0] Encoding

CLKDIV[2:0]	DIVIDE CLOCK BY
000	1
001	2
010	4
011	8
100	16
101	32
110	64
111	128

2.3.2 PCON (Power Control) Register

The PCON (Power Control) register selects the current power-saving mode (one of: Active, Idle, and Stop), and implements a bit to double the baud rate of UART 0 (in Modes 1 - 3). It also contains two general-purpose read/write bits that can be used by software for any desired purpose.

Table 2-6. PCON (Power Control) Register

BIT	7	6	5	4	3	2	1	0
FIELD	SMOD	///	///	///	GF1	GF0	PD	IDL
RESET	0	0	0	0	0	0	0	0
RW	RW	RO	RO	RO	RW	RW	RW	RW
ADDR	0x87							

Table 2-7. PCON Register Fields

BIT	NAME	DESCRIPTION
7	SMOD	Serial Clock Mode If '1', the baud rate of UART 0 will double in modes 1, 2, and 3. Otherwise, UART 0 runs at its nominal rate. This bit has no effect on UART 1.
6:4	///	Reserved Reads return '0'; writes are ignored.
3:2	GF[1:0]	General-purpose Flag Bits These read/write bits do not affect the operation of the device. They can be used by software for any desired purpose.
1	PD	Power Down The device enters Stop mode when this bit is set to '1'. In Stop mode, all circuitry is halted and power consumption is very low. Stop mode can only be exited through a device Reset.
0	IDL	Idle Mode The device enters Idle mode when this bit is set to '1'. In Idle mode, the processor core halts, but the UARTs, timers, and external interrupt signals are still active. Idle mode is exited automatically when an interrupt is received from an active peripheral, or on a device Reset.

Chapter 3

8051-Compatible Core

3.1 Theory of Operation

The LZ87010 has an 8051-compatible core that supports the full instruction set of the 8051 architecture. It supports all the 8051 Special Function Registers (SFRs, called simply 'registers' in this document), plus a large number of additional functions.

The LZ87010 has a 'machine cycle' of only two clock cycles. That is, most instructions execute in two system clock (CCLK) cycles, compared with 12 cycles in the original 8051.

In addition to the increase in per-cycle performance, the LZ87010 core integrates many special features, including on-chip hardware debugging features, four levels of interrupt priority, Watchdog reset timer, and many more. These features are covered in their respective chapters.

3.2 Registers

Most registers are associated with functional units covered in other chapters. For example, the SBUF (Serial Data Buffer) register is covered in the UART chapter. The descriptions of such registers are not repeated here.

Table 3-1. Core Registers

NAME	ADDRESS*	DESCRIPTION
ACC	0xE0*	Accumulator
B	0xF0*	B Register
DPH	0x83	Data Pointer [15:8]
DPH1	0x85	Data Pointer 1 [15:8]
DPL	0x82	Data Pointer [7:0]
DPL1	0x84	Data Pointer 1 [7:0]
DPS	0x86	Data Pointer Select and Extended Operation
PSW	0xD0*	Program Status Word
SP	0x81	Stack Pointer

NOTE: *Registers marked with an asterisk (*) are bit-addressable.

3.2.1 ACC (Accumulator) Register

The ACC (Accumulator) register provides an 8-bit value as one of the operands for many processor instructions.

Table 3-2. ACC (Accumulator) Register

BIT	7	6	5	4	3	2	1	0
FIELD	ACC[7]	ACC[6]	ACC[5]	ACC[4]	ACC[3]	ACC[2]	ACC[1]	ACC[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xE0							

3.2.2 B Register

The B register provides the second operand for a multiply or divide instruction, and can also be used as a read/write scratchpad register.

Table 3-3. B Register

BIT	7	6	5	4	3	2	1	0
FIELD	B[7]	B[6]	B[5]	B[4]	B[3]	B[2]	B[1]	B[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xF0							

3.2.3 DPH, DPL, DPH1, and DPL1 (Data Pointer) Registers

The DPL, DPH, DPL1, and DPH1 registers make up the two Data Pointer (DPTR) registers, of which only one is active at a time. DPTR uses a pair of registers, either DPL and DPH, or DPL1 and DPH1. Which register pair is used depends on the state of the DPS (Data Pointer Select) register. The DPTR register is used in instructions requiring 16-bit addressing. The lower 8 bits come from the DPL or DPL1 register, while the upper 8 bits come from the DPH or DPH1 register.

Table 3-4. DPH and DPH1 Registers

BIT	7	6	5	4	3	2	1	0
FIELD	DPTR[15]	DPTR[14]	DPTR[13]	DPTR[12]	DPTR[11]	DPTR[10]	DPTR[9]	DPTR[8]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	DPH: 0x83 DPH1: 0x85							

Table 3-5. DPL and DPL1 Registers

BIT	7	6	5	4	3	2	1	0
FIELD	DPTR[7]	DPTR[6]	DPTR[5]	DPTR[4]	DPTR[3]	DPTR[2]	DPTR[1]	DPTR[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	DPL: 0x82 DPL1: 0x84							

3.2.4 DPS (Data Pointer Select) Register

The DPS (Data Pointer Select) register determines whether the DPL/DPH or DPL1/DPH1 register pairs are used as the 16-bit DPTR register. It also contains the bit that determines whether opcode 0xA5 is the TRAP or the 'MOVC @(DPTR++),A' (program memory write) instruction.

Table 3-6. DPS Register

BIT	7	6	5	4	3	2	1	0
FIELD	///	///	///	TRAP_EN	///	///	///	DPSEL
RESET	0	0	0	0	0	0	0	0
RW	RO	RO	RO	RW	RO	RO	RO	RW
ADDR	0x86							

Table 3-7. DPS Register Bits

BIT	NAME	DESCRIPTION
7:5	///	Reserved Reads return '0'; write as '0'.
4	TRAP_EN	Trap Enable If '1', opcode 0xA5 functions as the TRAP (software breakpoint) instruction. If '0', opcode 0xA5 functions as the 'MOVC @(DPTR++),A' instruction
3:1	///	Reserved Reads return '0'; write as '0'.
0	DPSEL	Data Pointer Select Selects which register pair forms the 16-bit DPTR register: 0 = DPTR is taken from DPL and DPH 1 = DPTR is taken from DPL1 and DPH1

3.2.5 PSW (Program Status Word) Register

The PSW (Program Status Word) register contains processor status information.

Table 3-8. PSW Register

BIT	7	6	5	4	3	2	1	0
FIELD	CY	AC	F0	RS1	RS0	OV	F1	P
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RO
ADDR	0xD0							

Table 3-9. PSW Register Bits

BIT	NAME	DESCRIPTION
7	CY	ALU Carry Flag
6	AC	ALU Auxiliary Carry Flag
5	F0	User-Definable Flag 0
4	RS1	Register Bank Select 1
3	RS0	Register Bank Select 0
2	OV	ALU Overflow Flag
1	F1	User-Definable Flag 1
0	P	Accumulator Parity Flag (read-only)

3.2.6 SP (Stack Pointer) Register

The SP (Stack Pointer) register is a pointer for the subroutine and interrupt call stack. The stack can also be accessed by the PUSH and POP instructions. SP is pre-incremented on a stack push and post-decremented on a stack pop. The stack pointer points to the top of the stack, which holds the last byte written.

Table 3-10. SP Register

BIT	7	6	5	4	3	2	1	0
FIELD	SP[7]	SP[6]	SP[5]	SP[4]	SP[3]	SP[2]	SP[1]	SP[0]
RESET	0	0	0	0	0	1	1	1
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0x81							

Chapter 4

Internal RAM

The LZ87010 has two areas of on-chip Data RAM: 256 bytes of scratchpad RAM and 4,096 bytes of MOVX RAM.

4.1 Theory of Operation

The LZ87010 has four distinct addressing spaces:

1. A 256-byte data address space containing scratchpad RAM at addresses 0x00-0xFF.
2. A 128-byte data address space containing memory-mapped registers (also called 'special function registers') at addresses 0x80-0xFF. This overlaps scratchpad RAM in the memory map. The overlapping spaces are accessed by different addressing modes.
3. A 64KB data address space at addresses 0x000-0xFFFF, populated with 4KB of on-chip MOVX RAM. This memory is not expandable. The 4KB RAM is accessed with the MOVX instruction. It is mapped to fill the full 64KB space, meaning that any MOVX access in the range of 0x0000-0xFFFF will be treated as an access to the RAM at 0x0000-0x0FFF.
4. A 64KB code address space at addresses 0x0000-0xFFFF mapped either to on-chip Flash, external program memory, or partly Flash and partly external program memory. This program memory can also be used for data storage.

These overlapping address spaces can cause confusion. Code memory and data memory occupy different memory spaces. Data memory is subdivided into four memory spaces, as shown in Figure 4-1. In software, there is no ambiguity about which space is being addressed, because different opcodes are used for different address spaces. This is true everywhere except for selecting between on-chip Flash and external program memory, which is controlled through the XMCFG register.

Figure 4-1 shows the system memory map.

4.1.1 Scratchpad RAM (256 Bytes)

The 256-byte scratchpad RAM (also called 'internal' RAM) is used by the 8051 processor for registers R0-R7, for the return stack, and for miscellaneous uses. This RAM space is implemented as high-speed static RAM which can be accessed in a single clock cycle.

This RAM is mapped to the data address range of 0x00-0xFF. The area from 0x00-0x7F can be addressed with either the direct or indirect addressing modes, both of which use an 8-bit address. The area from 0x80-0xFF overlaps the special function register (SFR) space and can be accessed only by the indirect addressing mode; the direct addressing mode accesses the SFRs.

4.1.2 MOVX RAM (4,096 Bytes)

The 4,096 byte memory space is mapped to addresses 0x0000-0x0FFF and is accessed by the MOVX instruction, which allows 16-bit addresses. The upper 4 bits of the MOVX address are ignored. Any MOVX instruction will thus access the 4KB RAM. Like the 256-byte memory, the 4,096 byte MOVX RAM is implemented in high-speed, single-cycle-access memory.

In traditional 8051 terminology, this memory would be called 'external data RAM,' but it is internal to the LZ87010.

4.1.3 Expansion

Data memory is not expandable. Additional data storage can be obtained by using code memory, which can be accessed in software through the MOVC instruction. Code memory can be expanded through the external memory interface.

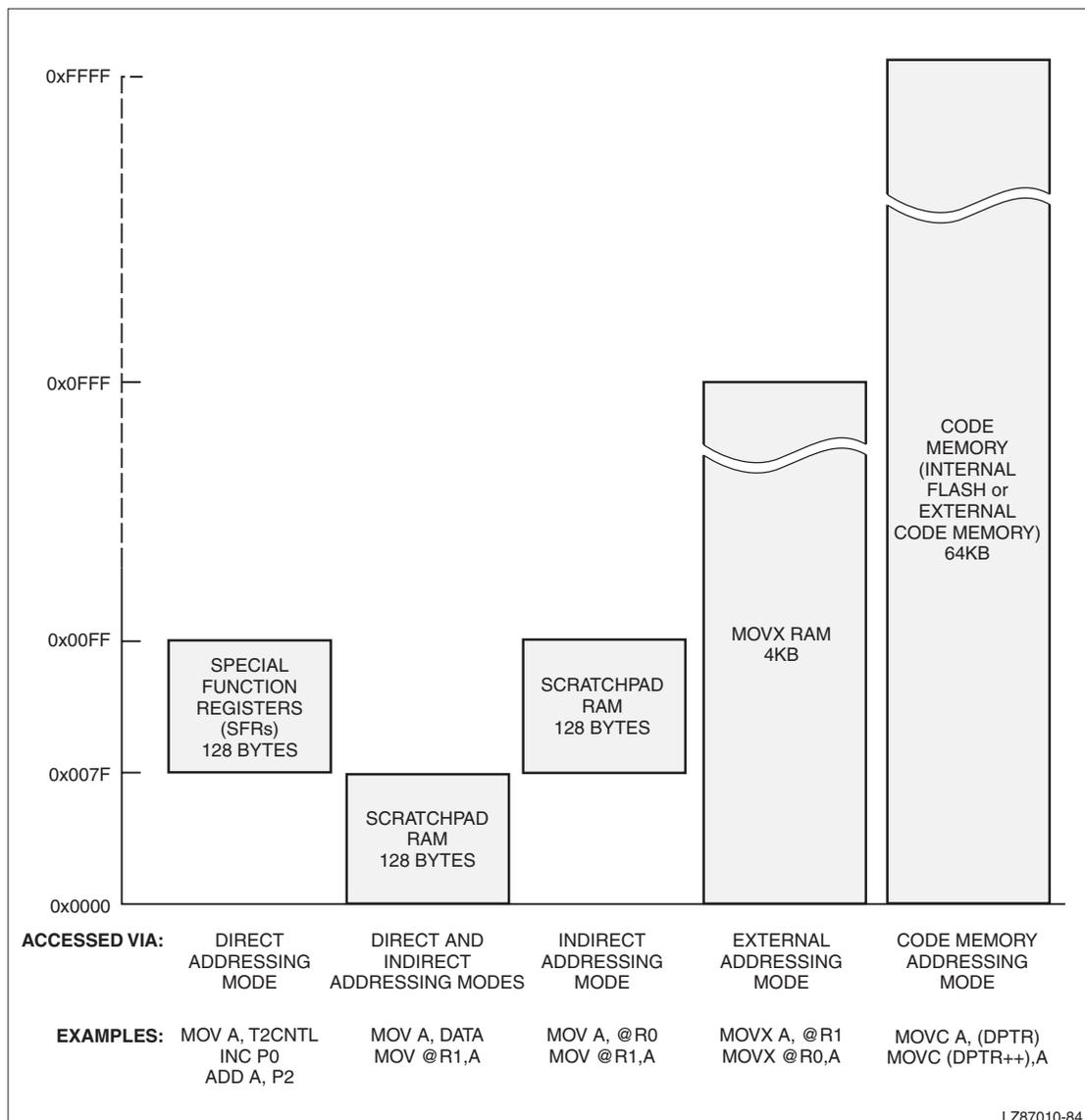


Figure 4-1. Memory Map

Chapter 5

Internal Flash

The LZ87010 has 64KB of internal Flash memory, mapped as program memory. At Reset, execution begins at address 0x0000 of this memory space. This memory supports zero-wait-state execution at full processor speed.

The Flash can be written under external control or through the control of on-chip software. Both Mass Erase of the entire Flash and Sector Erase of individual 512-byte sectors is supported. Once a sector is erased, individual bytes can be written with the enhanced 'MOVC @(DPTR++,A)' instruction.

External writing can take place over the SHARP Debug Interface or with a bulk programmer.

5.1 Theory of Operation

The Flash controller has four basic modes of operation that are selected in the FLASHCFG.FMOD field:

1. Normal Mode (a random-access read-only mode)
2. Program Mode (a random-access read/write mode)
3. Sector Erase (a write to an address erases the entire sector containing the address)
4. Mass Erase (any write erases the entire array).

Random-access reads are available in all modes. In Program Mode, data writes are random-access.

CAUTION

Care must be taken by the user when writing to the Flash. Improper write timing can damage the Flash cells.

Writing and erasing the Flash are guaranteed down to a minimum of 0°C.

5.1.1 The Info Array

In addition to the 64KB Data Array, there is a 128-byte Info Array. The last byte of the Info Array is used to implement Secure Mode. The remaining 127 bytes have no special significance to the Flash controller, and can be used for general-purpose storage.

The Info Array is mapped to the upper 128 bytes of memory (0xFF80-0xFFFF) if the FLASHCFG.FMAP bit is set to '1'. Otherwise, the Info Array is not accessible. When the Info Array is accessible, the Flash's Main Array is also still accessible except for this 128-byte segment.

5.1.2 Flash Timing

Timing of individual Flash operations is controlled by the Flash controller. In normal (read-only) operation, Flash reads have no wait states. When writing is enabled, reads have two wait states.

During programming and erasure, the Flash controller generates processor wait states to prevent access to the Flash while an operation is in progress.

To accommodate different system clock frequencies, a Flash timebase register (FLASHTB) must be set up to the number of HFCLK cycles in a 5 μ s period, minus one. For example, at a 40 MHz crystal, there are 200 HFCLK cycles in 5 μ s, so the FLASHTB register would be programmed to 199 (decimal).

The FLASHTB register can only be set when the clock divider in CLKCFG.CLKDIV is 0b000 (which sets the clock divider to 1). If the clock divider is subsequently changed, the Flash controller will adjust its internal copy of FLASHTB to maintain consistent timing.

The Flash controller does not scale its timing when the 32 kHz SUBCLK is used as the system clock. The Flash should not be written under these circumstances.

Write timing varies according to the type of operation, as shown in Table 5-1.

Table 5-1. Approximate Flash Timing

Timing Parameter	Value
Byte Write Time	20 - 40 μ s
Sector Erase Time	10 ms
Mass Erase Time	200 ms

5.1.3 Secure Mode

Secure Mode prevents the downloading or partial modification of the contents of Flash memory, to protect the software from copying, reverse-engineering, or tampering. Secure Mode can be exited by mass erasing the entire Flash.

In Secure Mode, the following restrictions apply:

- Data writes to Flash memory are ignored
- Sector Erase requests are ignored
- The Flash memory cannot be read via the Debug Interface
- External memory is disabled by forcing the XMCFG.XMALL bit to '1'.

Secure Mode is entered automatically on Reset if the last byte of the Info Array contains 0x55.

5.2 Registers

5.2.1 FLASHCFG (Flash Configuration) Register

The FLASHCFG register configures the operating mode of the Flash memory and determines whether the Info Array is visible or not.

Table 5-2. FLASHCFG Register

BIT	7	6	5	4	3	2	1	0
FIELD	SECURE	///	FMAP	FMOD[4]	FMOD[3]	FMOD[2]	FMOD[1]	FMOD[0]
RESET	0	0	0	0	0	0	0	1
RW	RO	RW	RW	RW	RW	RW	RW	RW
ADDR	0x96							

Table 5-3. FLASHCFG Register Bits

BIT	NAME	DESCRIPTION
7	SECURE	Secure Mode This read-only bit is '1' if the Flash controller is in Secure Mode. Secure Mode is entered on Reset if the last byte of the Info Array is 0x55. Secure Mode can be exited by Mass Erasing the Flash. In Secure Mode, byte writes and sector erasure is not allowed, nor is reading the Flash over the Debug Interface.
6	///	Reserved Returns '0', write as '0'.
5	FMAP	Flash Memory Map If '0', the main 64KB Data Array occupies the entire Flash memory space. If '1', the Info Array replaces the upper 128 bytes of the Data Array (addresses 0xFF80-0xFFFF).
4:0	FMOD	Flash Mode Selects between Normal, Program, Sector Erase, and Mass Erase modes. See Table 5-4.

Table 5-4. FMOD Field Decoding

FMOD[4:0]	DESCRIPTION
0b00001	Normal (Read-Only) Access Mode
0b00010	Reserved
0b00100	Program Mode Writes to the Flash are allowed. Note that in Program Mode, reads have 2 wait states. In all other modes, they have no wait states.
0b01000	Sector Erase Mode Writes perform Sector Erase cycle on the 512-byte sector containing the address written.
0b10000	Mass Erase Mode Writes trigger a Mass Erase cycle.

5.2.2 FLASHTB (Flash Timebase) Register

The FLASHTB (Flash timebase) register calibrates the Flash controller relative to the system clock, so the time-sensitive Flash operations can take place accurately.

Table 5-5. FLASHTB Register

BIT	7	6	5	4	3	2	1	0
FIELD	FTB[7]	FTB[6]	FTB[5]	FTB[4]	FTB[3]	FTB[2]	FTB[1]	FTB[0]
RESET	0	1	1	0	0	0	1	1
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0x97							

Table 5-6. FLASHTB Register Bits

BIT	NAME	DESCRIPTION
7:0	FTB	<p>Flash Timebase For proper Flash timing on Write and Erase cycles, this field must be set to the number of HFCLK periods (minus 1) that occur in a 5 μs period. For example, with a HFCLK of 40 MHz, there are 200 HFCLK cycles in 5 ms, so the FTB field should be set to 199 (decimal).</p> <p>Note that this register is read/write only when the system clock divisor is 1 (CLKCFG.CLKDIV = 0). It is read-only otherwise. The Flash controller will compensate by scaling its timing automatically whenever the CLKCFG.CLKDIV field is updated.</p>

Chapter 6

I/O Ports

The LZ87010 has seven 8-bit general-purpose I/O ports and two 8-bit high-current output ports. These ports are read and written under software control. Most ports are bit-addressable, allowing individual bits to be set or cleared without disturbing the other bits in the port.

Most of the general-purpose I/O pins are shared with other functions. In general, all functions sharing a pin are simultaneously active, and it is up to the programmer to ensure that functions not desired at the moment are not driving their output pins.

The nine ports have mnemonics PORT0 through PORT9. They are also called P0 through P9. PORT4 is not implemented on the LZ87010.

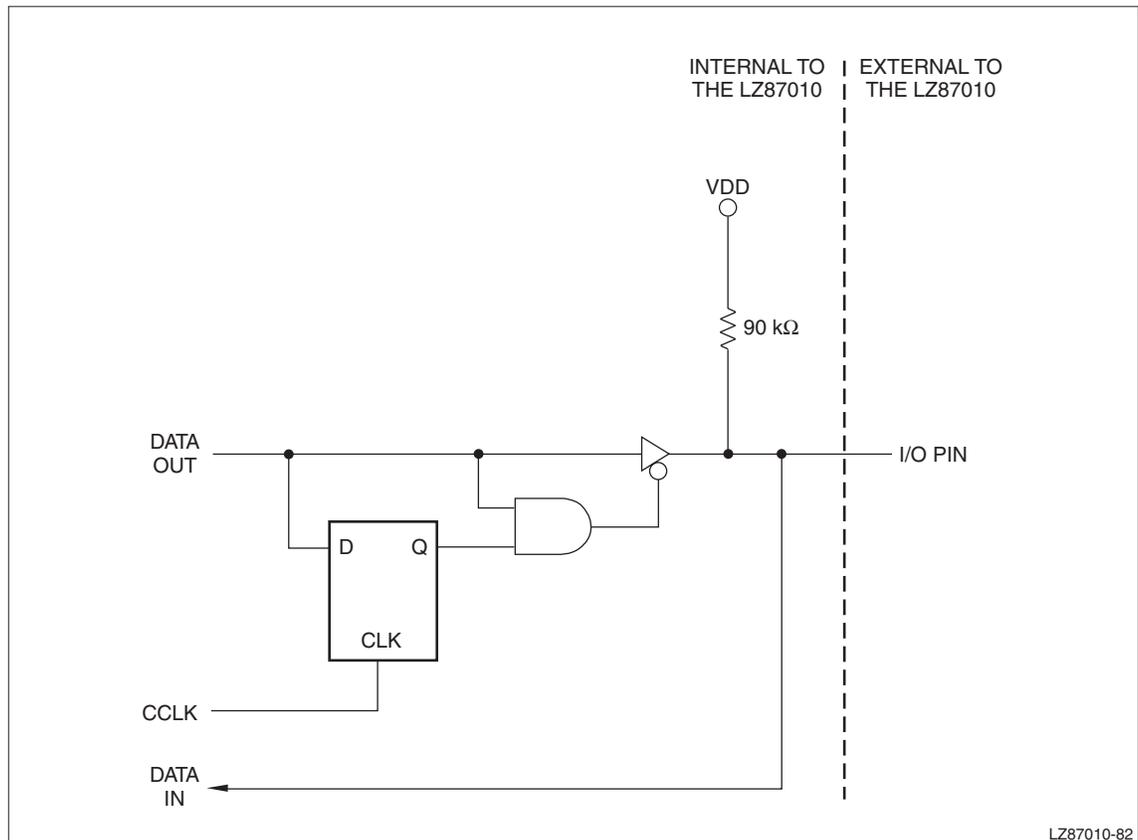


Figure 6-1. General-Purpose I/O Port (One Bit Shown)

6.1 Theory of Operation

From the point of view of the world outside the LZ87010, inputs and outputs are asynchronous, as no reference clock is provided.

From the LZ87010's point of view, reads and writes can take place at the rate of one every Peripheral Clock (PCLK) cycle. This is the same as the instruction rate.

6.1.1 General-Purpose I/O Ports

The general-purpose I/O ports are Port 0, Port 1, Port 3, Port 5, Port 6, Port 7, and Port 8. All of the ports except Port 5 and Port 8 are bit addressable.

General-purpose I/O ports can be both read and written. When a '0' is written to a general-purpose I/O port, a LOW level is driven continuously. When a '1' is written, the pin is driven HIGH for one Core Clock (CCLK) cycle, then the output driver is tri-stated. An internal weak pull-up resistor maintains the HIGH level after this drive is removed. Figure 6-1 shows a general-purpose I/O port.

The output state of a general-purpose I/O pin is not altered when using it as an input. To use a general-purpose I/O pin as an input, one must first write a '1' to it. This will turn off the output driver after one CCLK cycle and leave the pin in a high-impedance state (consisting of pin capacitance and the internal pull-up resistor with a nominal value of 90 k Ω).

The general-purpose I/O signals can drive a minimum of 4 mA when LOW.

NOTE: Pins P3[7:6] do not have internal pull-up resistors. These two pins also serve as I²C pins SCL and SDATA, and the I²C specification requires open-collector signals. When using these pins as general-purpose I/O signals, external pull-up resistors of approximately 90 k Ω should be supplied externally.

If a single 8-bit port is used for both inputs and outputs, care must be taken not to write a '0' to any of the pins used as an input. Reading a port and then writing the same data back to it will turn any input bit whose state was read as '0' into an output that drives '0' continuously. Read-modify-write instructions, including the bit-manipulation instructions 'SETB' and 'CLR bit', will also have this affect. In general, it is best to avoid using the same port for both input and output bits. When this is unavoidable, the port should be manipulated by:

1. Reading the port by copying it to a register, as in 'MOV A,PORT'.
2. Performing the desired operation on the port bits.
3. Explicitly masking the input bits to '1', as in 'ORL A,#0xF0' for a port whose 4 high bits are inputs.
4. Writing the port back, as in 'MOV PORT,A'.

6.1.1.1 Idle and Stop-Mode Current

When the logic level is LOW, current flows continuously through the pull-up resistors. This current continues to flow in low-power modes (Idle Mode and Stop Mode). To minimize power dissipation in low-power modes, general-purpose I/O ports should be set HIGH.

6.1.2 High-Current Output Ports

The high-current output ports are Port 2 and Port 9. Port 2 is bit-addressable; Port 9 is not.

These ports are driven continuously in both the HIGH and LOW output states. They can drive a minimum of 12 mA. Figure 6-2 shows an equivalent circuit for a high-current output pin.

While the output *pins* are write-only, the PORT2 and PORT9 *registers* are read/write. Reading the register will return the last value written.

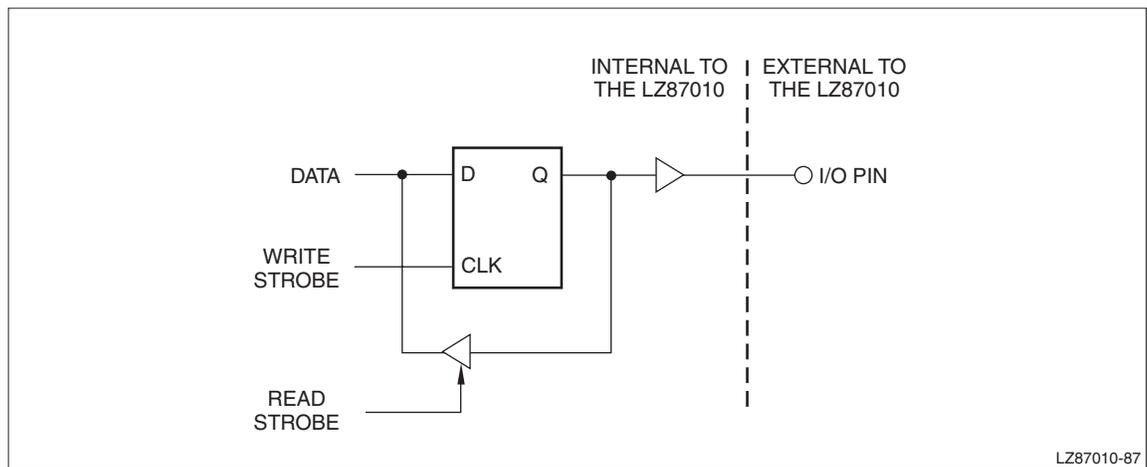


Figure 6-2. High-Current Output Port (One Bit Shown)

6.2 Signals

Table 6-1. I/O Port Signal Descriptions

SIGNAL NAME	SIGNAL TYPE*	PIN NO.	PIN TYPE	FUNCTIONAL UNIT	SHARED WITH	DESCRIPTION
P0[7:0]	I/O	83:76	I/O	Ports	INT[7:0]	General Purpose Input/Output Pin
P1[7]	I/O	8	I/O	Ports	nPSEN	General Purpose Input/Output Pin
P1[6]	I/O	7	I/O	Ports	nPSWR	General Purpose Input/Output Pin
P1[5]	I/O	6	I/O	Ports	CTCMP3B	General Purpose Input/Output Pin
P1[4]	I/O	5	I/O	Ports	CTCMP3A	General Purpose Input/Output Pin
P1[3]	I/O	4	I/O	Ports	CTCAP3B	General Purpose Input/Output Pin
P1[2]	I/O	3	I/O	Ports	CTCAP3A	General Purpose Input/Output Pin
P1[1]	I/O	2	I/O	Ports		General Purpose Input/Output Pin
P1[0]	I/O	1	I/O	Ports	CTIN3	General Purpose Input/Output Pin
P2[7:0]	O	25:18	O	Ports	XMA[15:8]	General Purpose Output-Only Port (High Current)
P3[7]	I/O	69	I/O	Ports	SDA	General Purpose Input/Output Pin (Open Collector)
P3[6]	I/O	68	I/O	Ports	SCL	General Purpose Input/Output Pin (Open Collector)
P3[5]	I/O	66	I/O	Ports	WFGIN0	General Purpose Input/Output Pin
P3[4]	I/O	65	I/O	Ports	WFGIN1	General Purpose Input/Output Pin
P3[3]	I/O	63	I/O	Ports	RXD1	General Purpose Input/Output Pin
P3[2]	I/O	62	I/O	Ports	TXD1	General Purpose Input/Output Pin
P3[1]	I/O	61	I/O	Ports	TXD0	General Purpose Input/Output Pin
P3[0]	I/O	60	I/O	Ports	RXD0	General Purpose Input/Output Pin
P4[7:0]						Port 4 is not implemented
P5[7:0]	I/O	17:10	I/O	Ports	XMD[7:0]	General Purpose Input/Output Pin
P6[7]	I/O	91	I/O	Ports	CTCMP5B	General Purpose Input/Output Pin
P6[6]	I/O	90	I/O	Ports	CTCMP5A	General Purpose Input/Output Pin
P6[5]	I/O	89	I/O	Ports		General Purpose Input/Output Pin
P6[4]	I/O	88	I/O	Ports	CTIN5	General Purpose Input/Output Pin
P6[3]	I/O	87	I/O	Ports	CTCMP4B	General Purpose Input/Output Pin
P6[2]	I/O	86	I/O	Ports	CTCMP4A	General Purpose Input/Output Pin
P6[1]	I/O	85	I/O	Ports		General Purpose Input/Output Pin
P6[0]	I/O	84	I/O	Ports	CTIN4	General Purpose Input/Output Pin
P7[7]	I/O	44	I/O	Ports	CTIN1	General Purpose Input/Output Pin
P7[6]	I/O	43	I/O	Ports	CTIN0	General Purpose Input/Output Pin
P7[5]	I/O	41	I/O	Ports	CTCMP2B	General Purpose Input/Output Pin
P7[4]	I/O	40	I/O	Ports	CTCMP2A	General Purpose Input/Output Pin
P7[3]	I/O	39	I/O	Ports	CTCAP2B	General Purpose Input/Output Pin
P7[2]	I/O	38	I/O	Ports	CTCAP2A	General Purpose Input/Output Pin
P7[1]	I/O	37	I/O	Ports		General Purpose Input/Output Pin
P7[0]	I/O	36	I/O	Ports	CTIN2	General Purpose Input/Output Pin
P8[7:0]	I/O	35:28	I/O	Ports	XMA[7:0]	General Purpose Input/Output Pin
P9[7:0]	O	100:93	I/O	Ports		General Purpose Output-Only Port (High Current)

NOTE: *The I/O Type is shown for each use of a multi-use pin. For example, TXD0 and P3[1] share a pin. TXD0 is shown as O, while P3[1] is shown as I/O.

6.3 Registers

6.3.1 General-Purpose I/O Registers

The general-purpose I/O registers sample external I/O pins when read by the processor and drive external I/O pins when written by the processor. These bits are set to '1' on Reset (with the exception of PORT3[7:6], which are set to '0') to set the pins HIGH, which is the state that allows the pins to function as inputs. The HIGH state also minimizes power consumption.

The PORT0, PORT1, ... PORT8 registers are also called the P0, P1, ... P8 registers.

Table 6-2. PORT0, PORT1, PORT3, PORT5, PORT6, PORT7, PORT8 Registers

BIT	7	6	5	4	3	2	1	0
FIELD	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]
RESET	1*	1*	1	1	1	1	1	1
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	PORT0: 0x80 PORT1: 0x90 PORT3: 0xB0 PORT5: 0x91 PORT6: 0xC0 PORT7: 0xD8 PORT8: 0x93							

NOTE: *On PORT3 only, bits [7:6] (which are shared with the I²C pins SCL and SDA) are zero on Reset.

Table 6-3. General-Purpose I/O Register Bits

BIT	NAME	DESCRIPTION
7:0	D	<p>Data When this field is read, the input pins will be sampled, and the register state will be updated to reflect the state of the pins (active HIGH logic; a HIGH signal will result in a '1' bit in the register). Those I/O ports that are bit-addressable (Ports 0, 1, 3, 6, and 7) can be updated one bit at a time. When this field is written, the state of the pins will be updated to match the state of the register. To put bits into a high-impedance state suitable for being used as inputs, '1' bits should be written prior to reading. Otherwise, bus contention will result.</p>

6.3.2 High-Current Output Registers

Writes to the high-current output registers cause the high-current output pins to change state to match the bits in the register. These bits default to '1' on Reset, corresponding to a HIGH output level.

Table 6-4. PORT2 and PORT9 Registers

BIT	7	6	5	4	3	2	1	0
FIELD	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]
RESET	1	1	1	1	1	1	1	1
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	PORT2: 0xA0 PORT9: 0xA9							

Table 6-5. High-Current Output Register Bits

BIT	NAME	DESCRIPTION
7:0	D	Data When this field is read, the value of the last write is returned. When this field is written, the output pins are updated to match the state of the register bits, with a logic HIGH corresponding to a '1' bit. Port 2 is bit addressible. Individual bits can be altered without affecting the others.

Chapter 7

8051-Compatible Timers

The LZ87010 includes standard 8051 counter/timers: Timer 0 and Timer 1. Both are 16-bit count-up timers that can be clocked internally by PCLK or externally through the CTIN0 pin (Timer 0) or CTIN1 pin (Timer 1).

7.1 Timer Theory of Operation

The timers are controlled by two registers: TCON (timer control) and TMOD (timer mode). Timer data is stored in four registers: TH0 and TL0 for Timer 0 high and low bytes, respectively, and TH1 and TL1 for Timer 1.

Up to four pins are used with these timers: CTIN0, CTIN1, INT[0], and INT[1]. CTIN0 and CTIN1 are the external clock signals for Timer 0 and Timer 1, respectively. The timer clock is selected from either the external clock input or PCLK. See Figure 7-1.

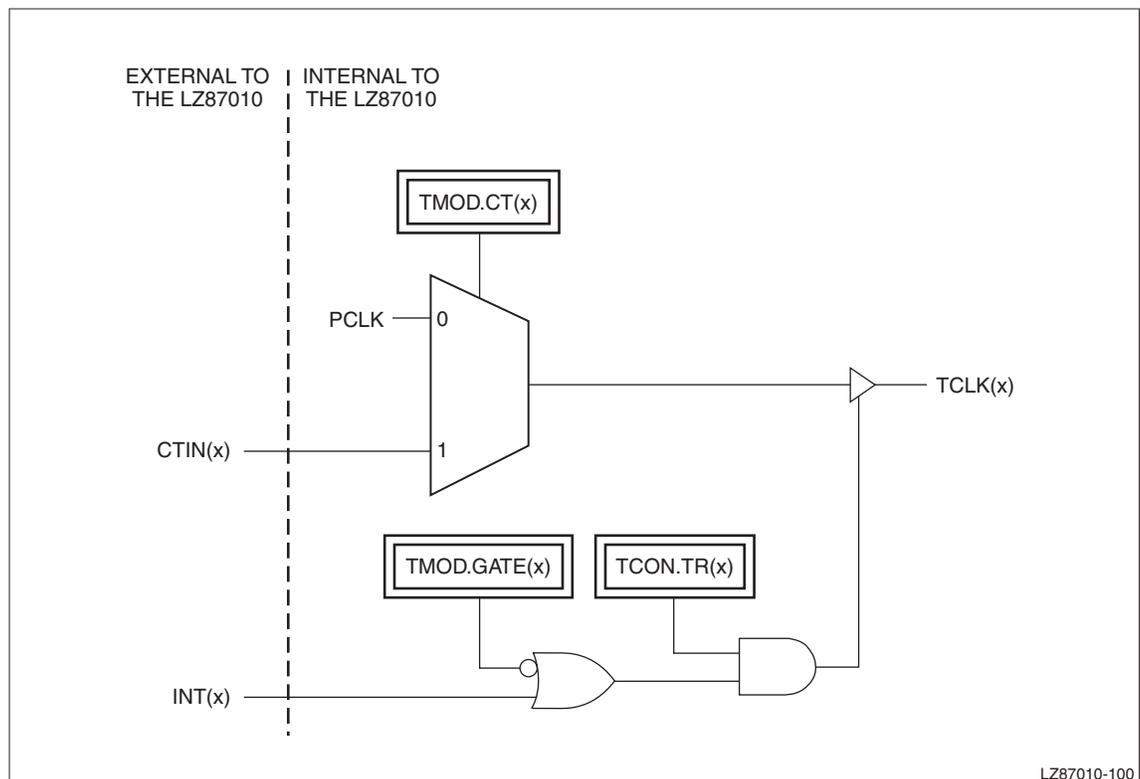


Figure 7-1. Timer 0-1 Clocking

7.1.1.2 Mode 1

Mode 1 is a 16-bit free-running mode. All 16 bits of TH(x) and TL(x) are used for the count. With a 20 MHz PCLK, the counter will overflow every 3.2768 ms (305.18 Hz). See Figure 7-3.

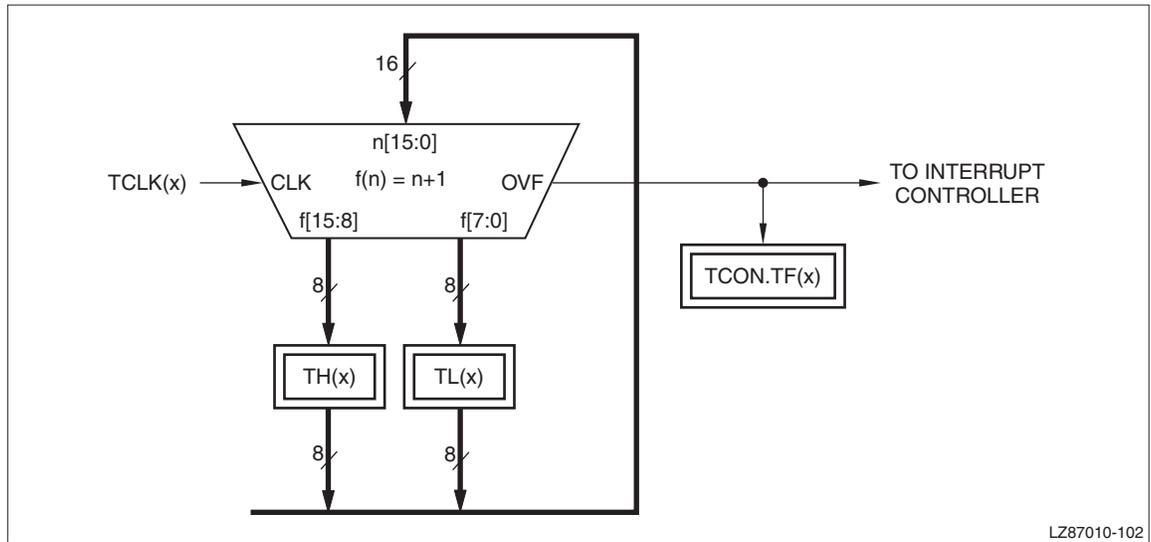


Figure 7-3. Timer Mode 1

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7.1.1.3 Mode 2

Mode 2 is an 8-bit auto-reload mode. TL(x) is the 8-bit counter. TH(x) holds the reload value. Whenever TL(x) overflows to zero, it is reloaded with TH(x). See Figure 7-4. The auto-reload feature allows timers running Mode 2 to generate overflows at the rate of $(256 - TH1)$ PCLK cycles if internal clocking is used (CTIN0 or CTIN1 replace PCLK if external clocking is used). For example, a TH1 value of 100 gives an overflow every 156 clock cycles, which with internal clocking and a PCLK rate of 20 MHz gives an overflow interval of 0.05 to 12.8 μ s (78,125 Hz to 20 MHz).

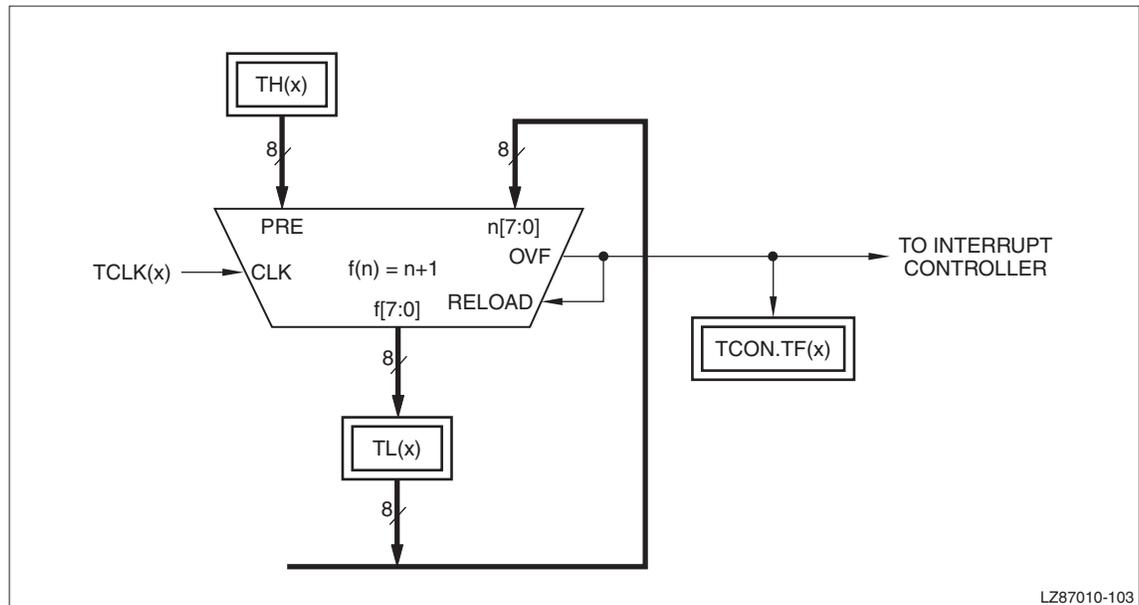


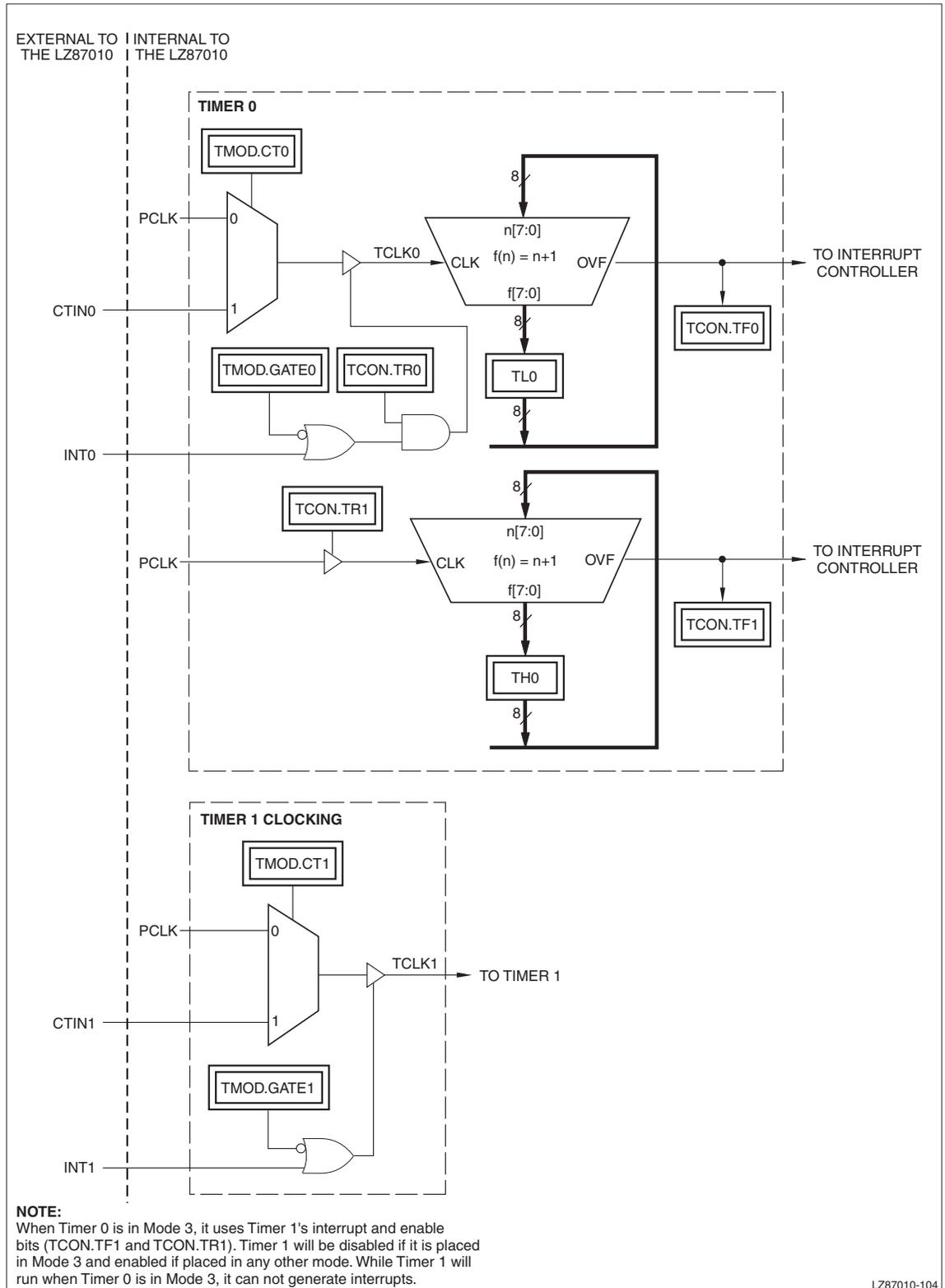
Figure 7-4. Timer Mode 2

7.1.1.4 Mode 3

Mode 3 operates differently in Timer 0 and Timer 1. When Timer 1 is placed into Mode 3, it halts. When Timer 0 is placed into Mode 3, it splits into two independent 8-bit timers, TL0 and TH0. Two bits are borrowed from Timer 1 and given to the timer using TH0. These bits are TCON.TR1 (Timer Run Enable 1) and TCON.TF1 (Timer Interrupt Flag 1). See Figure 7-5.

Because Timer 1 lacks an interrupt bit when Timer 0 is in Mode 3, it can only be used for tasks that do not require interrupts. For example, Timer 1 can be put into Mode 2 and used as a baud-rate generator for UART 0.

Because Timer 1 also lacks a run-enable bit when Timer 0 is in Mode 3, Timer 1 will run continuously if placed in Modes 0-2. If placed in Mode 3, it stops. This mechanism allows Timer 1 to be started and stopped when the TCON.TR1 bit is unavailable to it.



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Figure 7-5. Timer Mode 3

7.2 Timer 0 and Timer 1 Signals

Table 7-1. Timer 0 and Timer 1 I/O

NAME	DIRECTION	DESCRIPTION
CTIN0	In	External clock input, Timer 0
CTIN1	In	External clock input, Timer 1
EXT0	In	Clock enable/disable, Timer 0
EXT1	In	Clock enable/disable, Timer1

7.3 Timer 0 and 1 Registers

7.3.1 TCON (Timer 0 and 1 Control) Register

Table 7-2. TCON Register

BIT	7	6	5	4	3	2	1	0
FIELD	TF1	TR1	TF0	TR0	IE1	IT1	IE0	IT0
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0x88*							

Table 7-3. TCON Register Bits

BIT	NAME	DESCRIPTION
7	TF1	Timer 1 Overflow Set automatically by the timer hardware when Timer 1 overflows (that is, when it goes from all '1' bits to all '0' bits). Cleared automatically when the processor calls the Timer 1 interrupt service routine.
6	TR1	Timer 1 Run Control The timer runs if this bit is set and stops if it is cleared.
5	TF0	Timer 0 Overflow Set automatically by the timer hardware when Timer 0 overflows (that is, when it goes from all '1' bits to all '0' bits). Cleared automatically when the processor calls the Timer 0 interrupt service routine.
4	TR0	Timer 0 Run Control The timer runs if this bit is set and stops if it is cleared.
3	IE1	Interrupt Edge 1 (Not timer-related.) Set automatically in hardware when the assertion of external interrupt 1 is detected. Cleared automatically when the processor calls the interrupt service routine.
2	IT1	Interrupt Type 1 (Not timer-related.) Determines whether external interrupts are strobed (edge-triggered) or held asserted (level-triggered). If '1', external interrupt 1 is triggered by a falling signal edge. If '0', it is triggered by a LOW input signal.
1	IE0	Interrupt Edge 0 (Not timer-related.) Set automatically in hardware when the assertion of external interrupt 0 is detected. Cleared automatically when the processor calls the interrupt service routine.
0	IT0	Interrupt Type 0 (Not timer-related.) Determines whether external interrupts are strobed (edge-triggered) or held asserted (level-triggered). If '1', external interrupt 1 is triggered by a falling signal edge. If '0', it is triggered by a LOW input signal.

7.3.2 TMOD (Timer 0 and 1 Mode) Registers

Table 7-4. TMOD Register

BIT	7	6	5	4	3	2	1	0
FIELD	GATE1	CN1	M1[1]	M1[0]	GATE0	CT0	M0[1]	M0[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0x89							

Table 7-5. TMOD Register Bits

BIT	NAME	DESCRIPTION
7	GATE1	Timer 1 Gate Flag When this bit is '1' Timer 1 runs only when the INT[1] pin is HIGH. When this bit is '0', Timer 1 runs continuously. (In either case, the timer must be enabled in the TCON register.)
6	CT1	Counter/Timer 1 Selector If '1', Timer 1 is clocked by the CTIN1 pin (counter operation). If '0', Timer 1 is clocked internally by PCLK (timer operation).
5:4	M1[1:0]	Mode Select Field See Table 7-6.
3	GATE0	Timer 0 Gate Flag When this bit is '1' Timer 0 runs only when the INT[0] pin is HIGH. When this bit is '0', Timer 0 runs continuously. (In either case, the timer must be enabled in the TCON register.)
2	CT0	Counter/Timer 0 Selector If '1', Timer 0 is clocked by the CTIN0 pin (counter operation). If '0', Timer 0 is clocked internally by PCLK (timer operation).
1:0	M0[1:0]	Mode Select Field See Table 7-6.

Table 7-6. M(x)[1:0] Bit Field Decoding

M[1:0]	DESCRIPTION
00	13-bit Timer/Counter Operation The TH(x) register holds the upper 8 bits of the count. TL(x)[4:0] hold the lower five bits of the count. TL(x)[7:5] are undefined in this mode.
01	16-bit Timer/Counter Operation The TH(x) register holds the high byte of the count, and the TL(x) register holds the low byte of the count.
10	8-bit Auto-reload Timer/Counter TL(x) holds the count. When the count overflows to zero, TL(x) is reloaded with the value in TH(x).
11	Dual 8-bit Timer/Counter Operation Timer 0: TL0 operates in either timer or counter mode, controlled by TMOD[3:2]. TH0 operates in timer mode only, controlled by TMOD[7:6]. Timer 1: This mode halts the timer.

7.3.3 Timer Data Registers (TH0, TH1, TL0, TL1)

Table 7-7. TH0, TH1, TL0, TL1 Registers

BIT	7	6	5	4	3	2	1	0
FIELD	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	TH0: 0x8C TH1: 0x8D TL0: 0x8A TL1: 0x8B							

Chapter 8

Enhanced Timers

The LZ87010 has four enhanced 16-bit timer/counters: Timer 2, Timer 3, Timer 4, and Timer 5. These timers are not 8051-compatible. A top-level block diagram of these timers is given in Figure 8-1.

All four timers are 16-bit count-up timers with the following features:

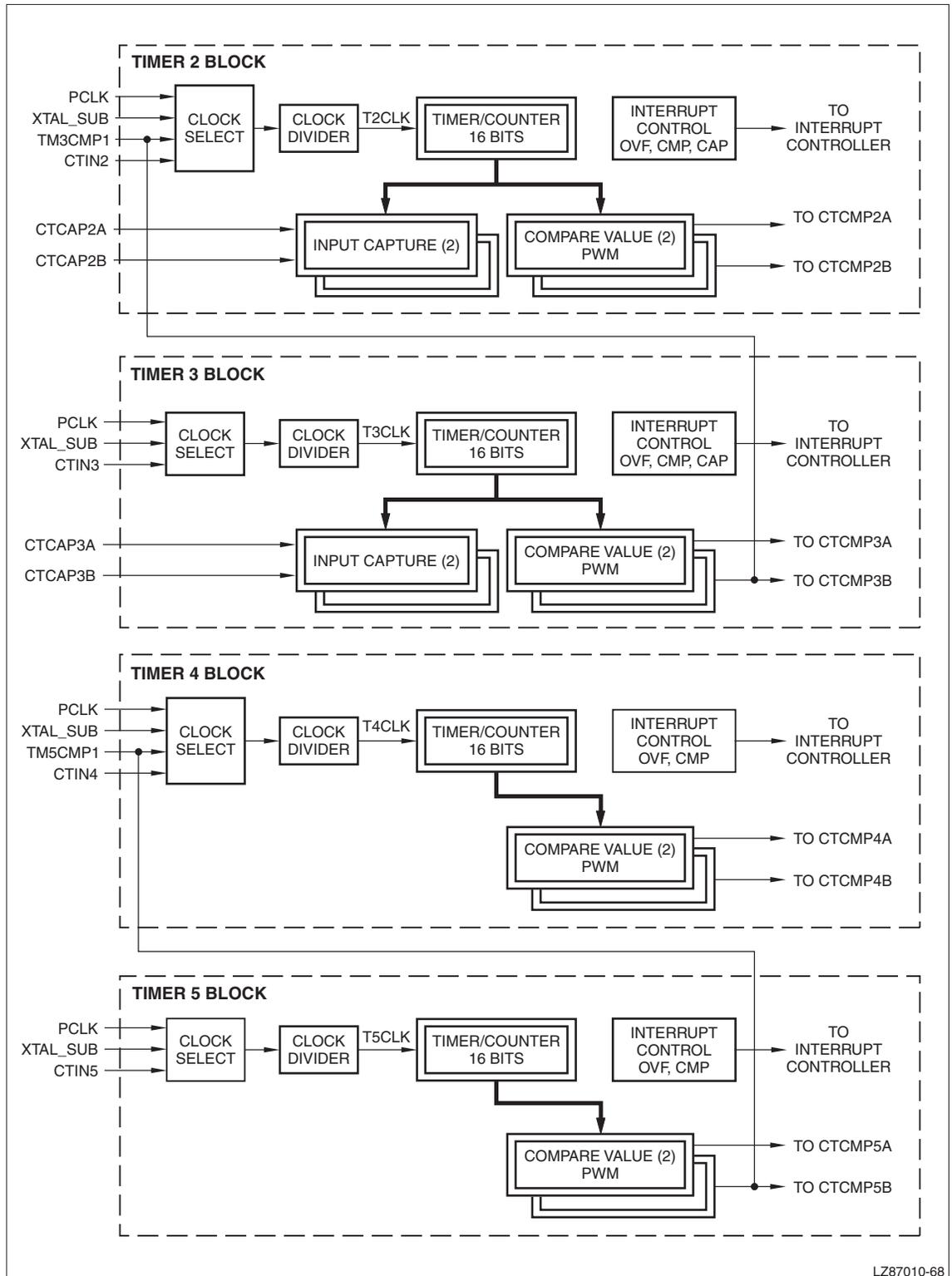
- Timing, where the counter free-runs and generates an interrupt when it overflows
- Counting, where the timer is incremented each time an external signal is asserted
- Compare, where each time the timer is incremented, it is compared to a specified value. An interrupt or output pin is optionally asserted on a match.
- Capture (external event timing), where the current timer value is copied to a capture register when an external capture signal is asserted, with an optional interrupt on capture. (Timers 4 and 5 do not have the capture function.)
- Pulse-width Modulation (PWM), where two compare registers are used together to produce an output signal of any desired duty cycle.

The four timers are very similar to one another, but are not identical. Their differences are:

- Timer 2 and Timer 3 have the capture function, while Timer 4 and Timer 5 do not
- Timer 2 and Timer 4 have the ability to choose as their clock input the output of one of the compare pins of Timer 3 and Timer 5, respectively
- Timer 2 and Timer 4 have a maximum clock divisor of 128. Timer 3 and Timer 5 have a maximum clock divisor of 32,768.

The timers are otherwise identical.

Throughout this chapter, discussions applying to multiple timers will replace the timer number with '(x)'. For example, the low-order timer count registers may be referred to as 'T(x)CNTL'. In addition, the multiple capture and compare units per timer lead to the use of, for example, the notation 'T(x)CAP(y)L' to indicate the low-order capture data in all the capture units of each timer that has capture capability.



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Figure 8-1. Overall Timer Block Diagram

8.1 Enhanced Timer Signals

Table 8-1. Timer 2 - Timer 5 I/O

NAME	DIRECTION	DESCRIPTION
CTIN2, CTIN3, CTIN4, CTIN5	In	External clock inputs for Timers 2 - 5
CTCMP2A, CTCMP2B, CTCMP3A, CTCMP3B, CTCMP4A, CTCMP4B, CTCMP5A, CTCMP5B	Out	Compare outputs
CTCAP2A, CTCAP2B, CTCAP3A, CTCAP3B	In	Capture inputs

8.2 Enhanced Timer Theory of Operation

8.2.1 Reading 16-bit Timer Registers

Because the LZ87010 has an 8-bit data path, while the timers are 16 bits wide, it takes two read operations for a program to retrieve the timer value. To allow the registers to be updated while the timers are running, while avoiding the coherency problems that can occur when the registers are updated one at a time, the LZ87010 has special circuitry for reading the 16-bit count data register pairs (T(x)CNTH and T((x)CNTL) and the capture data register pairs (T(x)CAP0H and T(x)CAP0L or T(x)CAP1H and T(x)CAP1L).

This mechanism is dependent on the programmer always reading the register pairs in 'Low, High' order. If the order is reversed, the value returned for the upper 8 bits will be that of the previous read, not the current one.

When the least significant byte of the register pair is read (for example, T2CNTL), the LZ87010 copies, at the same time, the most-significant byte (T2CNTH), to a shadow register. When a program reads T2CNTH, it is this holding register that is read, not the current value of the upper 8 timer bits. This guarantees that the value returned to the program will be the actual timer contents at the time T2CNTL was read. See Figure 8-2.

For example:

```
// Read Timer 2 while it is running.
// Correct order is always LSB first, then MSB.
MOV A,T2CNTL      // Read LSB first,
MOV TMPL,A        // save it,
MOV A,T2CNTH      // then read MSB.
MOV TMPH,A
```

NOTE: The conventional 8051 practice is to read the high byte, then the low byte, and then the high byte again, and repeat if the two high bytes are not equal. This method (while appropriate to 8051-compatible Timer 0 and Timer 1) is not necessary with Timers 2 through 5. It will work, but the comparison is likely to fail the first time through the loop and succeed on the second.

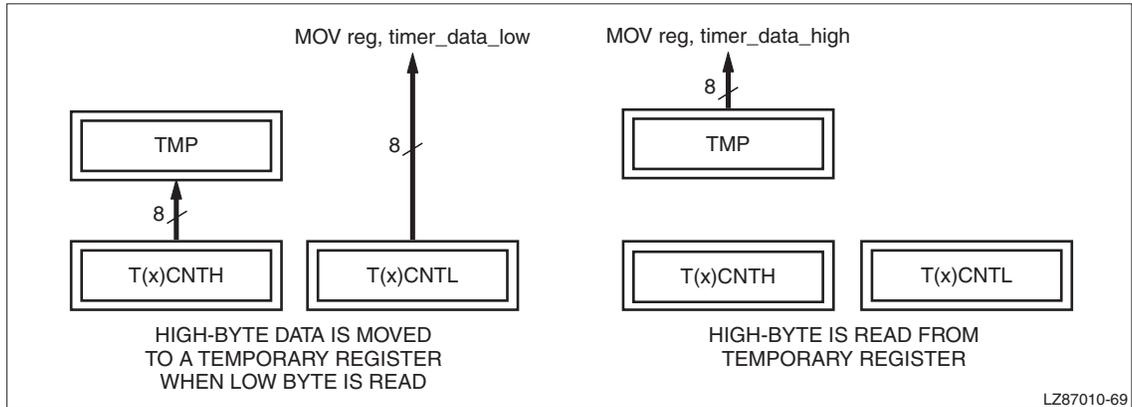


Figure 8-2. Reading from Count and Capture Registers

8.2.2 Writing 16-bit Timer Registers

Writes also have a mechanism to allow updating while the timer is running. This mechanism also uses a temporary register and works the compare data register pairs (T(x)CMP0H and T(x)CMP0L or T(x)CMP1H and T(x)CMP1L). Data is written first to the low-order register, which the LZ87010 holds in a temporary register. When the high-order register is written, the 16-bit target register pair is updated with the 16-bit quantity. See Figure 8-3.

For example:

```
// Write Timer 2 Compare 1 unit while Timer 2 is running.
// Correct order is always LSB first, then MSB.
MOV A, #EXAMPLE_LSB
MOV T2CMP1L, A           // Write the LSB first,
MOV A, #EXAMPLE_MSB
MOV T2CMP1H, A           // then the MSB.
```

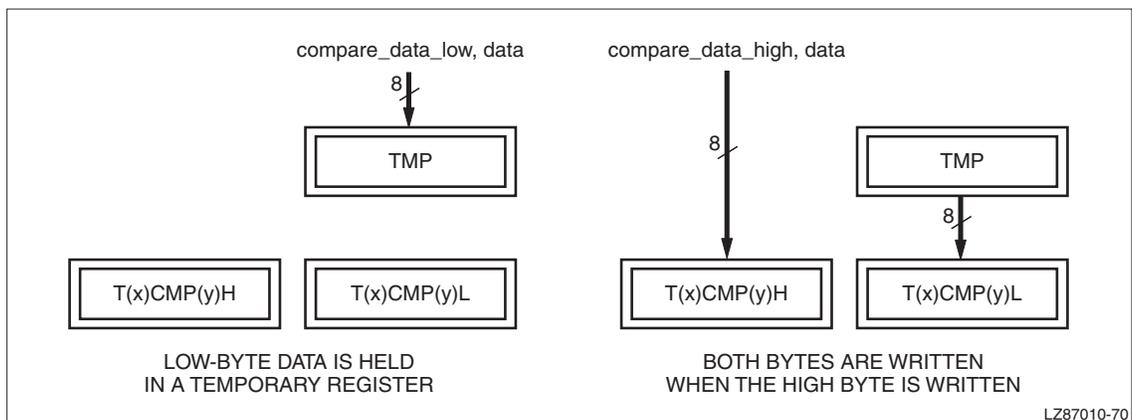


Figure 8-3. Writing to Compare Registers

8.2.3 Timer Clocking

Each timer has either three or four clock inputs, as shown in Figure 8-1. These always include PCLK (the peripheral clock, which is always half the core clock), SUBCLK (the 32.768 kHz subclock), and an external clock input. Each timer has its own dedicated clock input pin, CTIN2-CTIN5.

Timers 2 and 4 also have the option of using the output of an adjacent timer's compare unit output. Timer 2 can be clocked by TM3CMP1, and Timer 4 can be clocked by TM5CMP1. This allows one timer to be used as a programmable clock generator for another timer. Clock selection is controlled by the T(x)CON.CLK_SEL register field.

The maximum speed for external clocking on CTIN2-CTIN5 is two PCLK periods plus the setup and hold times for the selected input.

Regardless of its source, the selected input clock is divided by a clock divider value. For timers 2 and 4, the clock divider is one of: 1, 2, 4, 8, 16, 32, 64, 128. For timers 3 and 5, it is one of: 1, 2, 4, 8, 16, 32, 64, 32,768. By using the 32.768 kHz subclock and a clock divider of 32,768, one can achieve a one-second timer tick. The clock divider is selected in the T(x)CON.DIV field.

8.2.4 Timing and Counting

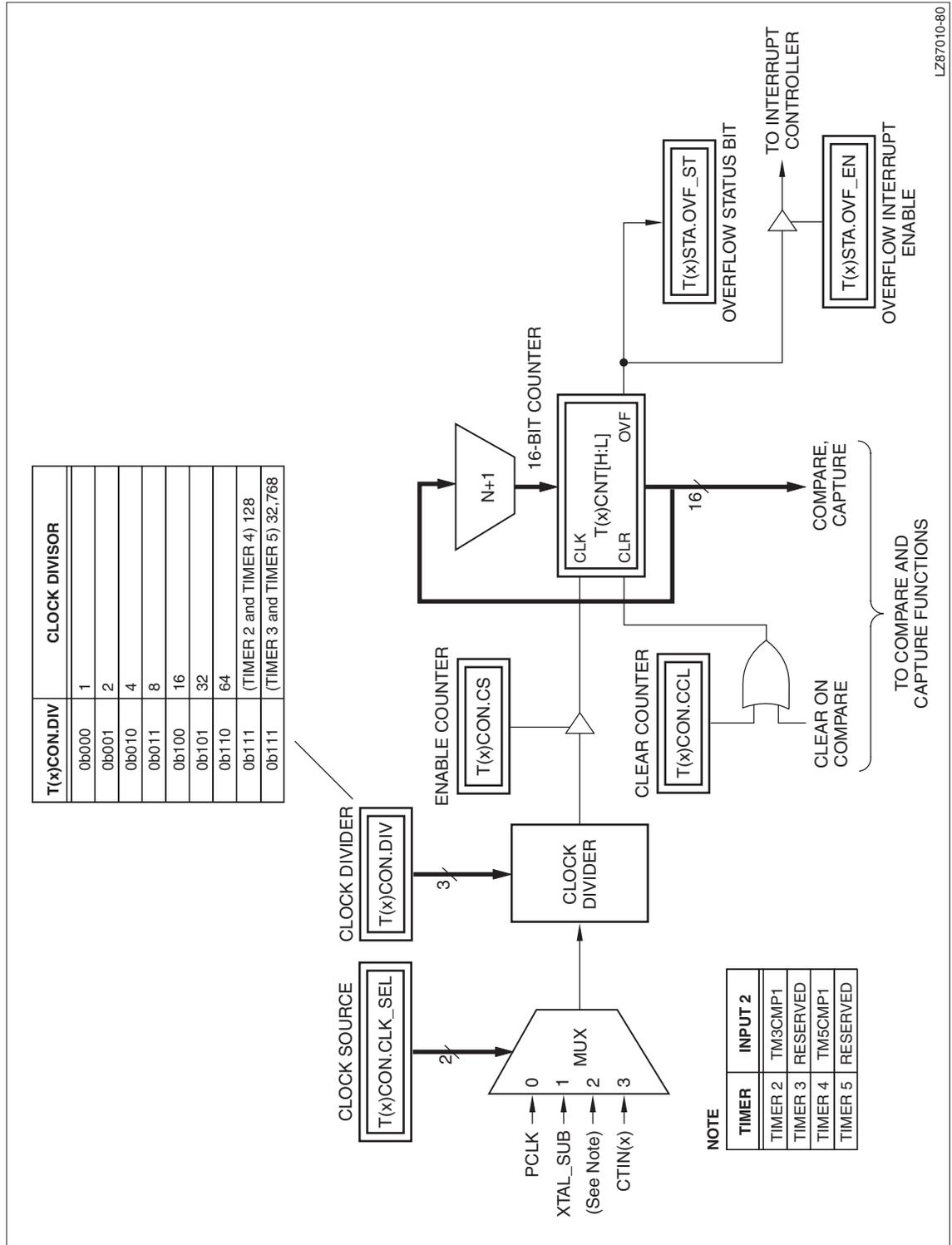
A timer increments on each rising edge of the selected, divided clock. The count is kept in the T(x)CNTL and T(x)CNTH registers. For example, the count of Timer 2 is kept in T2CNTH and T2CNTL. T2CNTH holds the upper 8 bits of the count, while T2CNTL holds the lower 8 bits. When the count overflows, the overflow bit in the timer's status register (T(x)STA.OVF_ST) will be set. This status bit will remain set until cleared by software. See Figure 8-4.

8.2.5 Capture

The input capture function is used to record the time at which external events occur. When an external capture signal is asserted, the current timer value is copied into the corresponding capture registers, a status bit is set, and an interrupt is optionally asserted. Timers 2 and 3 have two capture input signals each: CTCAP2A, CTCAP2B, CTCAP3A, and CTCAP3B. Timers 4 and 5 do not have capture inputs. See Table 8-2.

The capture signal is sampled on the rising edge of PCLK, and needs to be asserted for at least one PCLK period plus the sample and hold times for the input. The capture can be triggered on a rising edge, a falling edge, both, or neither. This is selected by the T(x)CAP.IED[1:0] field.

Because the capture inputs can generate an interrupt on any selected signal edges, they can be used as general-purpose edge-triggered interrupts.



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Figure 8-4. Timer Block Diagram (Does Not Show Capture and Compare)

8.2.6 Compare

All four enhanced timers have a dual compare function, where two 16-bit values can be stored and compared against the current timer value. When a match occurs, an external signal and an interrupt can be asserted. Both actions are optional and are independent of one another.

The $T(x)CMP(y).CMP0$ and $T(x)CMP(y).CMP1$ bit fields determine the output polarity of the compare unit. This is the polarity of the output on a compare match. The polarity of the compare output is given in Table 8-4.

If the $CMP(y)$ field is written with 0b01 or 0b10 (setting a HIGH on compare match or LOW on compare match, respectively), its output is driven to the opposite of the polarity. When a compare match occurs, the compare output is driven to the selected state for the duration of the match—one timer clock cycle—then the output returns to the 'no match' state.

If the $CMP(y)$ field is written with 0b00, the output is not changed, either before or after a compare match.

If the $CMP(y)$ field is written with 0b11, the output remains in its current state until a match occurs. The compare output is then toggled on each compare match. The output is not strobed for one timer cycle, but is held until the next compare match.

The output of the compare unit can be driven onto the $CTCMP(x)(y)$ pins. Whether the output pins are driven depends on bit-mapped output enables in the TCMPOE register. Independently of whether an output *pin* is driven, the compare *output* can be used as the input clock for a waveform generator or (in the case of Timer 3 and Timer 5) the input clock for another timer.

Writing to the GPIO ports that share the $CTCMP(x)(y)$ pins has no effect on the compare unit. In toggle mode, the compare unit inverts an internal state bit; it does not read the GPIO bit.

The interrupt status of the compare unit is not affected by the output polarity or the state of the TCMPOE enables. The status bit is set and, if enabled, an interrupt is asserted when a timer match occurs. This interrupt is edge-triggered to ensure that multiple interrupts will not happen with slow timer clocks.

The higher-numbered compare units ($T(x)CMP1$) can clear the counter on a compare match. This is controlled by the $T(x)CMP.TC$ bit.

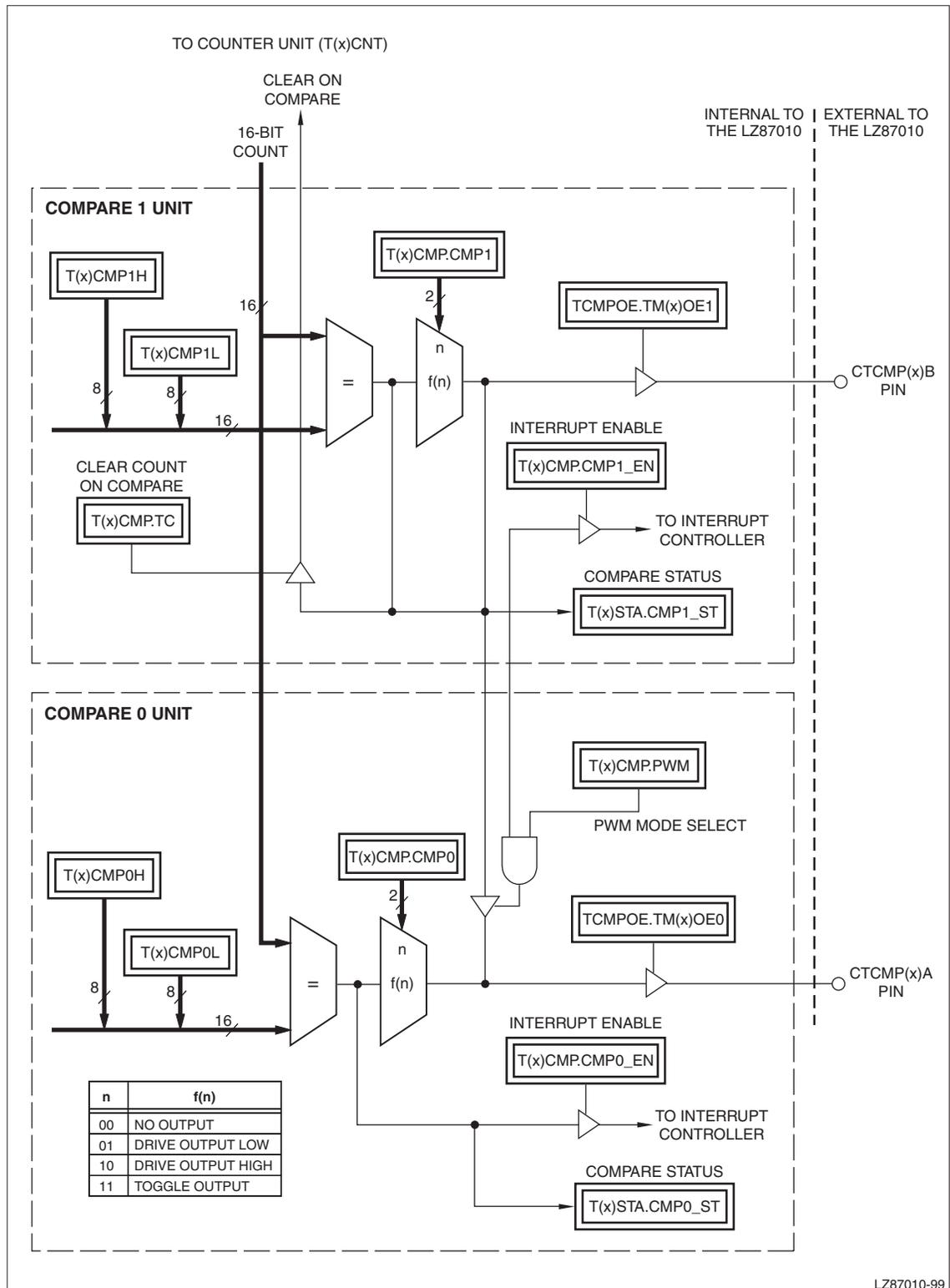


Figure 8-6. Compare Unit Block Diagram

Table 8-3. Compare Function

TIMER	SIGNAL	OUTPUT POLARITY	REGISTERS	STATUS BIT	INTERRUPT ENABLE	OUTPUT ENABLE
2	CTCMP2A	T2CMP.CMP0[1:0]	T2CMP0H, T2CMP0L	T2STA.CMP0_ST	T2CMP.IOE0	TCMPOE[7]
	CTCMP2B	T2CMP.CMP1[1:0]	T2CMP1H, T2CMP1L	T2STA.CMP1_ST	T2CMP.IOE1	TCMPOE[6]
3	CTCMP3A	T3CMP.CMP0[1:0]	T3CMP0H, T3CMP0L	T3STA.CMP0_ST	T3CMP.IOE0	TCMPOE[5]
	CTCMP3B	T3CMP.CMP1[1:0]	T3CMP1H, T3CMP1L	T3STA.CMP1_ST	T3CMP.IOE1	TCMPOE[4]
4	CTCMP4A	T4CMP.CMP0[1:0]	T4CMP0H, T4CMP0L	T4STA.CMP0_ST	T4CMP.IOE0	TCMPOE[3]
	CTCMP4B	T4CMP.CMP1[1:0]	T4CMP1H, T4CMP1L	T4STA.CMP1_ST	T4CMP.IOE1	TCMPOE[2]
5	CTCMP5A	T5CMP.CMP0[1:0]	T5CMP0H, T5CMP0L	T5STA.CMP0_ST	T5CMP.IOE0	TCMPOE[1]
	CTCMP5B	T5CMP.CMP1[1:0]	T5CMP1H, T5CMP1L	T5STA.CMP1_ST	T5CMP.IOE1	TCMPOE[0]

Table 8-4. Output Polarity for Compare Pins

T(x)CMP.CMP(y)[1:0]	DESCRIPTION
00	No change in output state.
01	Output pin driven LOW during compare match and HIGH otherwise.
10	Output pin driven HIGH during compare match and LOW otherwise.
11	Output pin toggled on compare match and held steady between matches.

8.2.7 PWM

In PWM mode, a timer's two compare units are used together to form an output oscillator with controllable frequency and duty cycle. Both compare units control the same pin, CTCMP(x)A. The lower-numbered compare unit is programmed to drive the signal to one state (LOW, for example) on a compare match, and the other compare unit is programmed to drive the signal to the opposite state on a compare match, and to clear the counter. The count starts again from zero, and the process repeats. PWM mode is enabled by setting the T(x)CMP.PWM bit. See Figure 8-7. Output to the CTCMP(x)A pin must also be enabled in the TCMPOE register.

To get the required duty cycle, set the 16-bit register pair of T(x)CMP0[H:L] to HIGH time minus 1 (or LOW time minus 1, as desired) and the T(x)CMP1[H:L] registers to the period minus 1.

For example, to get a 75% duty cycle, the PWM unit can be set to give 3 cycles of HIGH time and 1 cycle of LOW time. This can be done by setting T(x)CMP1[H:L] = 3 (period minus one), and T(x)CMP0[H:L] = 0 (LOW time minus one). See Figure 8-8. It can also be achieved by setting T(x)CMP1[H:L] = 3 as before, but setting T(x)CMP0[H:L] = 2 (HIGH time minus one) and inverting the polarity of the output in the T(x)CMP.CMP0 and T(x)CMP.CMP1 fields.

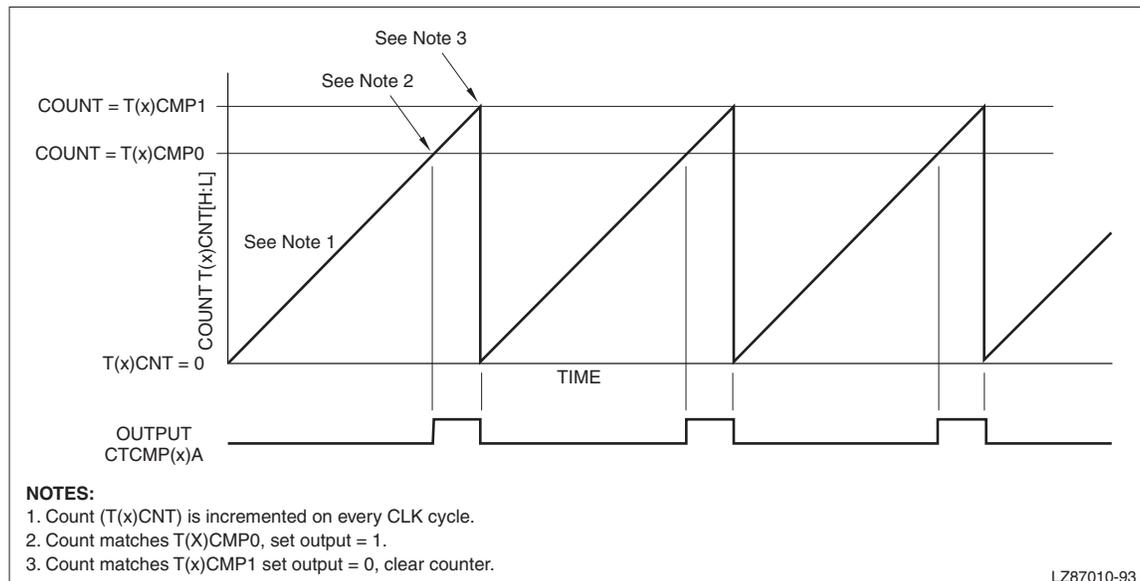


Figure 8-7. PWM Operation

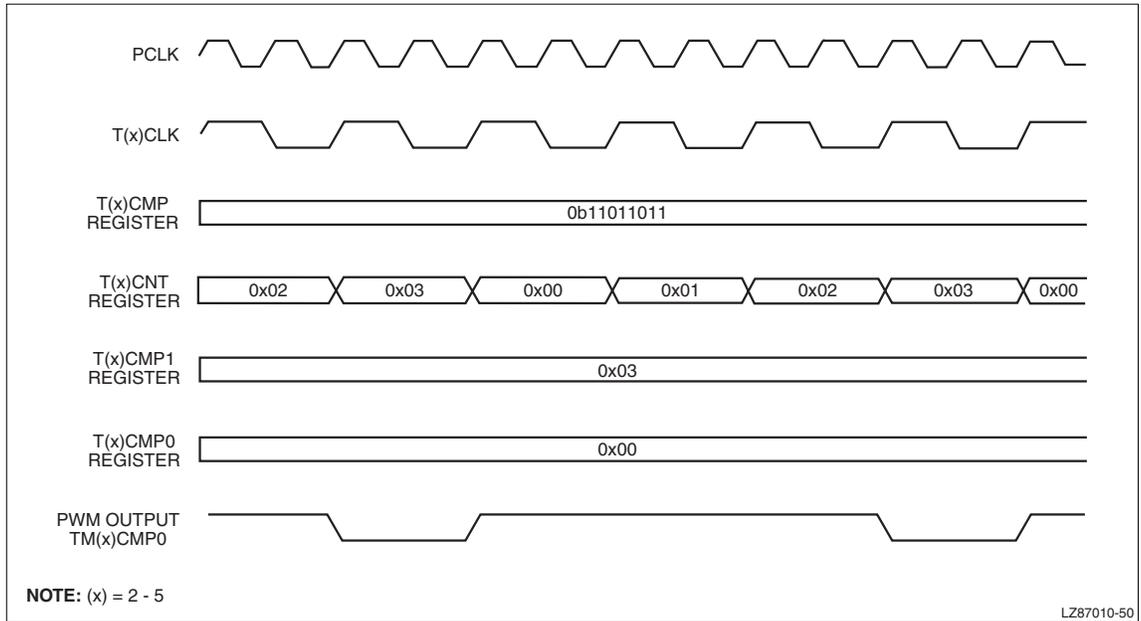


Figure 8-8. PWM Output Signal Timing

8.2.8 Timer Interrupts

Timer 2 and Timer 3 share interrupt vector 0x003B and interrupt level 7. Interrupt sources are: Overflow, Compare 0, Compare 1, Capture 0, and Capture 1.

When any enabled interrupt condition in either of the two timers occurs, the interrupt service routine at 0x003B will be called. The interrupt software is responsible for identifying the interrupt source (by reading the interrupt status registers T2STA and T3STA) and clearing the interrupt status bits. Clearing the interrupt bits in the T(x)STA registers will clear the interrupt condition. However, setting the bits will not cause an interrupt.

Timer 4 and Timer 5 share interrupt vector 0x0033, with interrupt level 6. Interrupt sources are: Overflow, Compare 0, and Compare 1. Interrupt handling is the same as with Timer 2 and Timer 3.

8.3 Enhanced Timer Registers

8.3.1 T2CAP and T3CAP (Capture Control) Registers

The two capture control registers, T2CAP and T3CAP, set the operating mode of the Timer 2 and Timer 3 capture units. Both timers have two capture units. These registers select the active edge (rising, falling, both, or none) on the external capture input signal that triggers a capture operation, and selects whether a capture will also generate an interrupt.

Table 8-5. T2CAP Register

BIT	7	6	5	4	3	2	1	0
FIELD	///	///	IIE1	IIE0	IDE1[1]	IDE1[0]	IDE0[1]	IDE0[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xD9							

Table 8-6. T3CAP Register

BIT	7	6	5	4	3	2	1	0
FIELD	///	///	IIE1	IIE0	IED1[1]	IDE1[0]	IED0[1]	IDE0[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xE9							

Table 8-7. T2CAP and T3CAP Register Bits

BIT	NAME	DESCRIPTION
7:6	///	Reserved Reads '0', write '0'.
5	IIE1	Interrupt Enable for Capture 1 If '1', interrupts are generated on capture complete. If '0', no interrupt is generated
4	IIE0	Interrupt Enable for Capture 0 If '1', interrupts are generated on capture complete. If '0', no interrupt is generated
3:2	IED1[1:0]	Input Edge Select for Capture 1 Detects which edge will trigger data capture. Choices are: rising edge, falling edge, both edge, neither edge (disable capture). The capture input for the Capture 1 channel is CTCAP2B for Timer 2, and CTCAP3B for Timer 3. 00 = Capture input is ignored 01 = Rising edge 10 = Falling edge 11 = Both edges
1:0	IED0[1:0]	Input Edge Select for Capture 0 Detects which edge will trigger data capture. Choices are: rising edge, falling edge, both edge, neither edge (disable capture). The capture input for the Capture 1 channel is CTCAP2A for Timer 2, and CTCAP3A for Timer 3. 00 = Capture input is ignored 01 = Rising edge 10 = Falling edge 11 = Both edges

8.3.2 T(x)CAP(y) (Captured Data) Registers

When a capture event is triggered by asserting an external capture pin, the current 16-bit timer value is copied into a pair of 8-bit captured data registers, shown in Table 8-8. These registers are read-only. Half of these registers are low-byte registers (with names ending in 'L'), which contain the lower 8 bits of the compare value. Half are high-byte registers (with names ending in 'H'), which contain the upper 8 bits of the compare value.

NOTE: Always read the LSB first, then the MSB. See Section 8.2.1.

Table 8-8. Capture Registers

CHANNEL	BITS[15:8]	BITS[7:0]
Capture 2A	T2CAP0H	T2CAP0L
Capture 2B	T2CAP1H	T2CAP1L
Capture 3A	T3CAP0H	T3CAP0L
Capture 3B	T3CAP1H	T3CAP1L

Table 8-9. T2CAP0H Register

BIT	7	6	5	4	3	2	1	0
FIELD	T2CAP0[15]	T2CAP0[14]	T2CAP0[13]	T2CAP0[12]	T2CAP0[11]	T2CAP0[10]	T2CAP0[9]	T2CAP0[8]
RESET	0	0	0	0	0	0	0	0
RW	RO	RO	RO	RO	RO	RO	RO	RO
ADDR	0xDB							

Table 8-10. T2CAP0L Register

BIT	7	6	5	4	3	2	1	0
FIELD	T2CAP0[7]	T2CAP0[6]	T2CAP0[5]	T2CAP0[4]	T2CAP0[3]	T2CAP0[2]	T2CAP0[1]	T2CAP0[0]
RESET	0	0	0	0	0	0	0	0
RW	RO	RO	RO	RO	RO	RO	RO	RO
ADDR	0xDA							

Table 8-11. T2CAP1H Register

BIT	7	6	5	4	3	2	1	0
FIELD	T2CAP1[15]	T2CAP1[14]	T2CAP1[13]	T2CAP1[12]	T2CAP1[11]	T2CAP1[10]	T2CAP1[9]	T2CAP1[8]
RESET	0	0	0	0	0	0	0	0
RW	RO	RO	RO	RO	RO	RO	RO	RO
ADDR	0xDD							

Table 8-12. T2CAP1L Register

BIT	7	6	5	4	3	2	1	0
FIELD	T2CAP1[7]	T2CAP1[6]	T2CAP1[5]	T2CAP1[4]	T2CAP1[3]	T2CAP1[2]	T2CAP1[1]	T2CAP1[0]
RESET	0	0	0	0	0	0	0	0
RW	RO	RO	RO	RO	RO	RO	RO	RO
ADDR	0xDC							

Table 8-13. T3CAP0H Register

BIT	7	6	5	4	3	2	1	0
FIELD	T3CAP0[15]	T3CAP0[14]	T3CAP0[13]	T3CAP0[12]	T3CAP0[11]	T3CAP0[10]	T3CAP0[9]	T3CAP0[8]
RESET	0	0	0	0	0	0	0	0
RW	RO	RO	RO	RO	RO	RO	RO	RO
ADDR	0xEB							

Table 8-14. T3CAP0L Register

BIT	7	6	5	4	3	2	1	0
FIELD	T3CAP0[7]	T3CAP0[6]	T3CAP0[5]	T3CAP0[4]	T3CAP0[3]	T3CAP0[2]	T3CAP0[1]	T3CAP0[0]
RESET	0	0	0	0	0	0	0	0
RW	RO	RO	RO	RO	RO	RO	RO	RO
ADDR	0xEA							

Table 8-15. T3CAP1H Register

BIT	7	6	5	4	3	2	1	0
FIELD	T3CAP1[15]	T3CAP1[14]	T3CAP1[13]	T3CAP1[12]	T3CAP1[11]	T3CAP1[10]	T3CAP1[9]	T3CAP1[8]
RESET	0	0	0	0	0	0	0	0
RW	RO	RO	RO	RO	RO	RO	RO	RO
ADDR	0xED							

Table 8-16. T3CAP1L Register

BIT	7	6	5	4	3	2	1	0
FIELD	T3CAP1[7]	T3CAP1[6]	T3CAP1[5]	T3CAP1[4]	T3CAP1[3]	T3CAP1[2]	T3CAP1[1]	T3CAP1[0]
RESET	0	0	0	0	0	0	0	0
RW	RO	RO	RO	RO	RO	RO	RO	RO
ADDR	0xEC							

8.3.3 T(x)CMP (Compare Control) Registers

Each timer has two compare units, T(x)CMP0 and T(x)CMP1, whose operating modes are set in the T(x)CMP registers. The fields in these registers include interrupt enables, output edge selects, and PWM mode select.

Table 8-17. T(x)CMP Registers

BIT	7	6	5	4	3	2	1	0
FIELD	IOE1	IOE0	CMP1[1]	CMP1[0]	CMP0[1]	CMP0[0]	TC	PWM
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	T2CMP: 0xD3 T3CMP: 0xE3 T4CMP: 0xF3 T5CMP: 0xA3							

Table 8-18. T(x)CMP Register Bits

BIT	NAME	DESCRIPTION
7	IOE1	Interrupt Enable for Compare 1 If '1', interrupts are generated on compare complete. If '0', no interrupt is generated.
6	IOE0	Interrupt Enable, Compare 0 If '1', interrupts are generated on compare complete. If '0', no interrupt is generated.
5:4	CMP1[1:0]	<p>Compare Output Value Select 1 Sets the reference value (at which compare match should occur) that is to be output to CTCMP(x)B when $T(x)CNT = T(x)CMP1$.</p> <p>00 = No change to CTCMP(x)B 01 = Output '0' to CTCMP(x)B 10 = Output '1' to CTCMP(x)B 11 = Toggle the output on each compare match</p> <p>Each time this field is written with 0b01 or 0b10, the output state is set to the opposite of the selected state to signal the 'no match' condition.</p>
3:2	CMP0[1:0]	Compare Output Value Select 0 As CMP1[1:0], but for Compare unit 0.
1	TC	<p>Timer Clear This bit selects between operation as a free running-counter or as an interval counter. When '1', the counter clears upon matching TxCMP1. When '0', the count continues after the match. This operation is only available with the T(x)CMP1 registers.</p> <p>0 = Inhibit counter clear (operates as free running counter) 1 = Clear counter upon $T(x)CNT = T(x)CMP1$</p>
0	PWM	Pulse Width Modulator This bit allows the use of CTCMP(x)A as a PWM output. This is done by properly setting up this bit as well as other bits in this register. If '1', the CTCMP(x)A output operates in PWM mode. If '0', it operates in Compare mode.

8.3.4 T(x)CMP[1:0][H:L] (Compare Data) Registers

There are 16 Compare Data registers (four timers times two compare units times two registers per compare unit): T2CMP0H, T2CMP0L, T2CMP1H, T2CMP1L, T3CMP0H, T3CMP0L, T3CMP1H, T3CMP1L, T4CMP0H, T4CMP0L, T4CMP1H, T4CMP1L, T5CMP0H, T5CMP0L, T5CMP1H, T5CMP1L. All are read/write registers.

Half of these registers are low-byte registers (with names ending in 'L'), which contain the lower 8 bits of the compare value. Half are high-byte registers (with names ending in 'H'), which contain the upper 8 bits of the compare value.

NOTE: Always write the LSB first, then the MSB. See Section 8.2.2.

Table 8-19. T(x)CMP0H Registers

BIT	7	6	5	4	3	2	1	0
FIELD	CMP0[15]	CMP0[14]	CMP0[13]	CMP0[12]	CMP0[11]	CMP0[10]	CMP0[9]	CMP0[8]
RESET	1	1	1	1	1	1	1	1
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	T2CMP0H: 0xD5 T3CMP0H: 0xE5 T4CMP0H: 0xF5 T5CMP0H: 0xA5							

Table 8-20. T(x)CMP0L Registers

BIT	7	6	5	4	3	2	1	0
FIELD	CMP0[7]	CMP0[6]	CMP0[5]	CMP0[4]	CMP0[3]	CMP0[2]	CMP0[1]	CMP0[0]
RESET	1	1	1	1	1	1	1	1
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	T2CMP0L: 0xD4 T3CMP0L: 0xE4 T4CMP0L: 0xF4 T5CMP0L: 0xA4							

Table 8-21. T(x)CMP1H Register

BIT	7	6	5	4	3	2	1	0
FIELD	CMP1[15]	CMP1[14]	CMP1[13]	CMP1[12]	CMP1[11]	CMP1[10]	CMP1[9]	CMP1[8]
RESET	1	1	1	1	1	1	1	1
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	T2CMP1H: 0xD7 T3CMP1H: 0xE7 T4CMP1H: 0xF7 T5CMP1H: 0xA7							

Table 8-22. T(x)CMP1L Register

BIT	7	6	5	4	3	2	1	0
FIELD	CMP1[7]	CMP1[6]	CMP1[5]	CMP1[4]	CMP1[3]	CMP1[2]	CMP1[1]	CMP1[0]
RESET	1	1	1	1	1	1	1	1
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	T2CMP1L: 0xD6 T3CMP1L: 0xE6 T4CMP1L: 0xF6 T5CMP1L: 0xA6							

8.3.5 T(x)CNTH and T(x)CNTL (Timer Count) Registers

The T(x)CNTH (timer count high) and T(x)CNTL (timer count low) registers contain the current value of the 16-bit timers. These registers can be read at any time, but writes to these registers while the timer is running will be ignored.

The timers are enabled and disabled in the T(x)CON (timer control) registers, which also contain clock divider, interrupt enable, and other control fields. The T(x)CMP(y) (compare control) registers contain a 'clear on compare match' field that, when enabled, will set the timer count registers to zero whenever the count equals the compare value.

NOTE: Always read or write the LSB first, then the MSB. See Section 8.2.1 and Section 8.2.2.

Table 8-23. T(x)CNTH Register

BIT	7	6	5	4	3	2	1	0
FIELD	CNT[15]	CNT[14]	CNT[13]	CNT[12]	CNT[11]	CNT[10]	CNT[9]	CNT[8]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	Timer 2: 0xDF Timer 3: 0xEF Timer 4: 0xFF Timer 5: 0xAF							

Table 8-24. T(x)CNTL Register

BIT	7	6	5	4	3	2	1	0
FIELD	CNT[7]	CNT[6]	CNT[5]	CNT[4]	CNT[3]	CNT[2]	CNT[1]	CNT[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	Timer 2: 0xDE Timer 3: 0xEE Timer 4: 0xFE Timer 5: 0xAE							

8.3.6 T(x)CON (Timer Configuration) Registers

The T(x)CON (timer configuration) registers set up the timers, with input clock source, input clock divider, enable/disable/clear control, and overflow interrupt enable fields. The timer should be stopped first (by setting the T(x)CON.CS field to zero) before other changes are made.

Table 8-25. T(x)CON Register

BIT	7	6	5	4	3	2	1	0
FIELD	CLK_SEL[1]	CLK_SEL[0]	CS	OVF_EN	CCL	DIV[2]	DIV[1]	DIV[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	Timer 2: 0xD1 Timer 3: 0xE1 Timer 4: 0xF1 Timer 5: 0xA1							

Table 8-26. T(x)CON Register Bits

BIT	NAME	DESCRIPTION
7:6	CLK_SEL[1:0]	Clock Select Selects the input clock, which is then divided by the clock divisor selected in the DIV[2:0] field. This field should not be changed unless the timer is stopped. 00 = PCLK 01 = CLK_SUB 10 = Timer 2: TM3CMP1, Timer4: TM5CMP1, Others: Reserved 11 = CTIN(x)
5	CS	Counter Start 0 = Stop count 1 = Start count
4	OVF_EN	Overflow Interrupt Enable 0 = No interrupt request occurs when counter overflow 1 = Interrupt request occurs when counter overflows
3	CCL	Clear Count Setting this bit to '1' clears the contents of the counter to 0x0000. The bit is reset to '0' automatically when the counter is cleared.
2:0	DIV[2:0]	Clock Divider These bits select the divisor for this timer. The source for the clock is determined by CLK_SEL. This field should not be changed unless the timer is stopped. 000 = CLK 001 = CLK ÷ 2 010 = CLK ÷ 4 011 = CLK ÷ 8 100 = CLK ÷ 16 101 = CLK ÷ 32 110 = CLK ÷ 64 111 = CLK ÷ 128 (Timer 2 and Timer 4) 111 = CLK ÷ 32,768 (Timer 3 and Timer 5)

8.3.7 T(x)STA (Timer Status) Registers

The T(x)STA (timer status) registers contain status bits for the individual interrupt sources in the Timer unit. These bits are set when the corresponding condition occurs, regardless of whether the interrupt is enabled. Bits in this register remain set until cleared by software. Clearing a bit also clears the associated interrupt. Setting a bit does not cause an interrupt.

Table 8-27. T(x)STA Register

BIT	7	6	5	4	3	2	1	0
FIELD	///	///	///	OVF_ST	CMP1_ST	CMP0_ST	CAP1_ST	CAP0_ST
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	Timer 2: 0xD2 Timer 3: 0xE2 Timer 4: 0xF2 Timer 5: 0xA2							

Table 8-28. T(x)STA Register Bits

BIT	NAME	DESCRIPTION
7:5	///	Reserved Reads '0', write '0'.
4	OVF_ST	Overflow Status Set to '1' when the timer rolls over to zero.
3	CMP1_ST	Compare 1 Status Set to '1' when the Compare 1 value matches the count.
2	CMP0_ST	Compare 0 Status Set to '1' when the Compare 0 value matches the count.
1	CAP1_ST	Capture 1 Status Timer 2 and Timer 3: Set to '1' when the Capture 1 unit is triggered. Timer 4 and Timer 5: Reserved.
0	CAP0_ST	Capture 0 Status Timer 2 and Timer 3: Set to '1' when the Capture 0 unit is triggered. Timer 4 and Timer 5: Reserved.

8.3.8 TCMPOE (Timer Compare Output Enable) Register

The TCMPOE (timer compare output enable) register determines which compare units are driven onto external pins. By enabling the compare units but disabling output, the compare units can be used to generate interrupts without occupying I/O pins.

Table 8-29. TCMPOE Register

BIT	7	6	5	4	3	2	1	0
FIELD	TM5OE1	TM5OE0	TM4OE1	TM4OE0	TM3OE1	TM3OE0	TM2OE1	TM2OE0
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xB3							

Table 8-30. TCMPOE Register Bits

BIT	NAME	DESCRIPTION
7	TM5OE1	Timer 5 Output Enable 1 If '1', the output of the Timer 5 Compare 1 unit is driven onto pin CTCMP5B.
6	TM5OE0	Timer 5 Output Enable 0 If '1', the output of the Timer 5 Compare 0 unit is driven onto pin CTCMP5A.
5	TM4OE1	Timer 4 Output Enable 1 If '1', the output of the Timer 4 Compare 1 unit is driven onto pin CTCMP4B.
4	TM4OE0	Timer 4 Output Enable 0 If '1', the output of the Timer 4 Compare 0 unit is driven onto pin CTCMP4A.
3	TM3OE1	Timer 3 Output Enable 1 If '1', the output of the Timer 3 Compare 1 unit is driven onto pin CTCMP3B.
2	TM3OE0	Timer 3 Output Enable 0 If '1', the output of the Timer 3 Compare 0 unit is driven onto pin CTCMP3A.
1	TM2OE1	Timer 2 Output Enable 1 If '1', the output of the Timer 2 Compare 1 unit is driven onto pin CTCMP2B.
0	TM2OE0	Timer 2 Output Enable 0 If '1', the output of the Timer 2 Compare 0 unit is driven onto pin CTCMP2A.

Chapter 9

Watchdog Timer

The Watchdog Timer can be used to detect a 'hung' system and reset it, causing it to resume operation. If enabled, the Watchdog Timer will reset the system when it counts down to zero. The system software prevents this from occurring by periodically reloading the Watchdog Timer as part of a timer interrupt routine. If the software ceases functioning, the Watchdog Timer will not be reloaded before counting down to zero, and the system will be reset.

9.1 Theory of Operation

The Watchdog Timer is implemented as two cascaded count-down timers, a prescale timer, which cannot be read by software, and an 8-bit Watchdog Timer. The prescale timer reloads automatically each time it counts down to zero, using a value specified in the WTCTL.WDTPR field. The Watchdog Timer also has a reload value, which is set by writing the WDCNT register as part of Watchdog initialization.

Each time the prescale timer counts down to zero, the Watchdog Timer is decremented. A Watchdog reset occurs if both the Watchdog Timer and the prescale timer are zero, and the Watchdog Timer Enable bit (WDCTL.WDTEN) is set.

The Watchdog Timer is reloaded whenever the WTCTL.WDTRL bit is cleared and then set within 32 CCLK periods. If an interrupt occurs between the two writes, the operation may not succeed. The two writes can be followed by a read of the WDCNT register to see if it has been reloaded. If not, the writes to the WTCTL.WDTRL bit can be attempted again.

The Watchdog Timer is disabled following a reset, including those it asserts itself.

9.1.1 Setting the Timer Interval

The Watchdog interval depends on the prescaler value, the TIMEOUT reload value, and the PCLK frequency:

$$\text{Watchdog interval(s)} = \text{prescaler} \times (\text{reload} + 1) / \text{PCLK (Hz)}$$

For example, with a prescaler value of 32,768, a reload value of 256, and a PCLK of 20 MHz, the interval would be (to three significant figures) 0.421 seconds.

9.1.2 Stopping the Watchdog Timer in Idle Mode

If enabled, the Watchdog Timer continues to count in Idle mode, which is undesirable unless the system is guaranteed to spend only a short period in Idle mode. During long periods in Idle Mode, the Watchdog Timer might count down all the way to zero. If this happened, it would assert a Reset when Idle mode was exited. To prevent this, the Watchdog Timer should be disabled before entering Idle mode, which will stop the counters. After Idle mode is exited, the Watchdog Timer can be re-enabled.

9.2 Watchdog Timer Registers

9.2.1 WDTCTL Register

Table 9-1. WDTCTL Register

BIT	7	6	5	4	3	2	1	0
FIELD	///	///	///	WDTPR[2]	WDTPR[1]	WDTPR[0]	WDTEN	WDTL
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	W
ADDR	0xAC							

Table 9-2. WDTCTL Register Bits

BIT	NAME	DESCRIPTION
7:5	///	Reserved Reads '0', write '0'.
4:2	WDTPR[2:0]	Watchdog Timer Prescaler These bits determine the reload value of the PRESCALE counter. 000b = PCLK ÷ 256 001b = PCLK ÷ 512 010b = PCLK ÷ 1,024 011b = PCLK ÷ 2,048 100b = PCLK ÷ 4,096 101b = PCLK ÷ 8,192 110b = PCLK ÷ 16,384 111b = PCLK ÷ 32,768
1	WDTEN	Watchdog Timer Enable When set, the Watchdog Timer is enabled. When clear, the Watchdog counters do not run and a reset will not be generated.
0	WDTL	Watchdog Timer Reload Reads from this bit return zero. This is a write-only bit. Writing a '0' to this bit and then writing a '1' within 32 CCLKs forces a reload of the TIMEOUT counter. Otherwise, the writes have no effect. The reload value is provided by the WDTCNT register. The reload operation is not affected by the state of the WDTEN bit.

9.2.2 WDTCNT Register

Table 9-3. WDTCNT Register

BIT	7	6	5	4	3	2	1	0
FIELD	WDTCD[7]	WDTCD[6]	WDTCD[5]	WDTCD[4]	WDTCD[3]	WDTCD[2]	WDTCD[1]	WDTCD[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xAD							

Table 9-4. WDTCNT Register Bits

BIT	NAME	DESCRIPTION
7:0	WDTCD[7:0]	Counter Data These bits have different read/write functions. Writes to this register set the reload value for the TIMEOUT counter and have no immediate effect on watchdog operation. Reads from this register return the value of the TIMEOUT counter.

Chapter 10

UARTs

10.1 Theory of Operation

The LZ87010 has two UARTs, UART 0 and UART 1. UART 0 is 8051-compatible. UART 1 is almost identical to UART 0, except that in Modes 1 and 3, it derives its serial clock from a dedicated baud rate generator, while UART 0 uses Timer 1.

10.1.1 Receive Operation

In modes 1-3, incoming data on the RXD0 or RXD1 pin is signaled by a start bit that pulls the input LOW for one bit period. This is sampled on every cycle of a clock running at 16 times the UART's baud rate. The falling edge of the start bit synchronizes the transfer with a resolution of 1/16 of a bit period. The UART then samples the RXD0 or RXD1 pin during each bit period until it accumulates an entire character. The transfer ends with a HIGH stop bit. On a successful transfer, the serial data is copied into SBUF or SBUF1 (and, in 9-bit modes, into the SCON.RB8 or SCON1.RB8 bit as well) and the receive interrupt bit (SCON.RI or SCON1.RI) is set. If the RI bit is already set, indicating that a previous transfer has not yet been serviced, the new serial data is discarded.

For greater noise immunity, each bit is sampled three times near the middle of the bit period, at intervals of one 16x serial clock period. Whichever logic level is sampled at least two of the three times will be the one used.

In Mode 0, there are no start or stop bits, and the character is 8 bits long. Mode 0 is a synchronous mode in which the serial clock is provided on TXD0 or TXD1, and input data is read on RXD0 or RXD1. The serial clock is provided by the LZ87010. The data rate is fixed at one bit per PCLK cycle. A falling edge on TXD0 or TXD1 signals that a new data bit should be written to RXD0 or RXD1. This bit is sampled at the rising edge of TXD0 or TXD1. See Figure 10-1.

In the other modes, each character has one start bit and one stop bit. Mode 1 transfers 8 data bits; Modes 2 and 3 transfer 9 data bits. The lower 8 bits are stored in the SBUF register (UART 0) or SBUF1 register (UART 1). The ninth bits are stored in the SCON.RB8 or SCON1.RB8 register bits. See Figure 10-2.

There is one character of buffering on receive; the previous character can be read from the SBUF or SBUF1 register (and, in nine-bit modes, SCON.RB8 or SCON1.RB8) at any time before the next character is fully received.

The RXD0 and RXD1 pins are shared with general/purpose I/O ports. To prevent spurious serial data from being received when the pin is not being used for that purpose, the receive function of the UART can be disabled in the SCON (UART 0) or SCON1 (UART 1) register, using the SCON.REN or SCON1.REN (receive enable) bits.

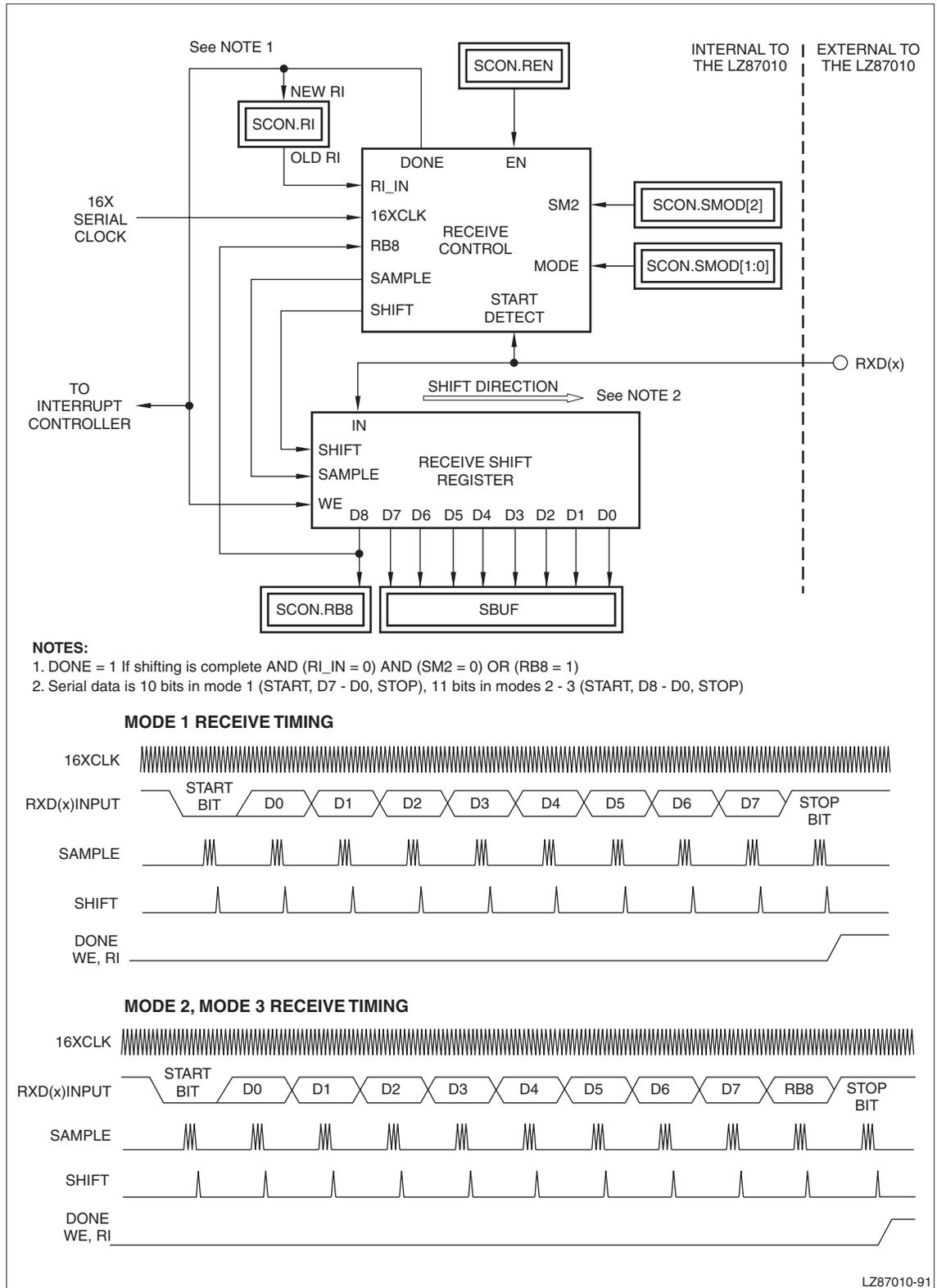


Figure 10-1. Receive Operation, Modes 1-3

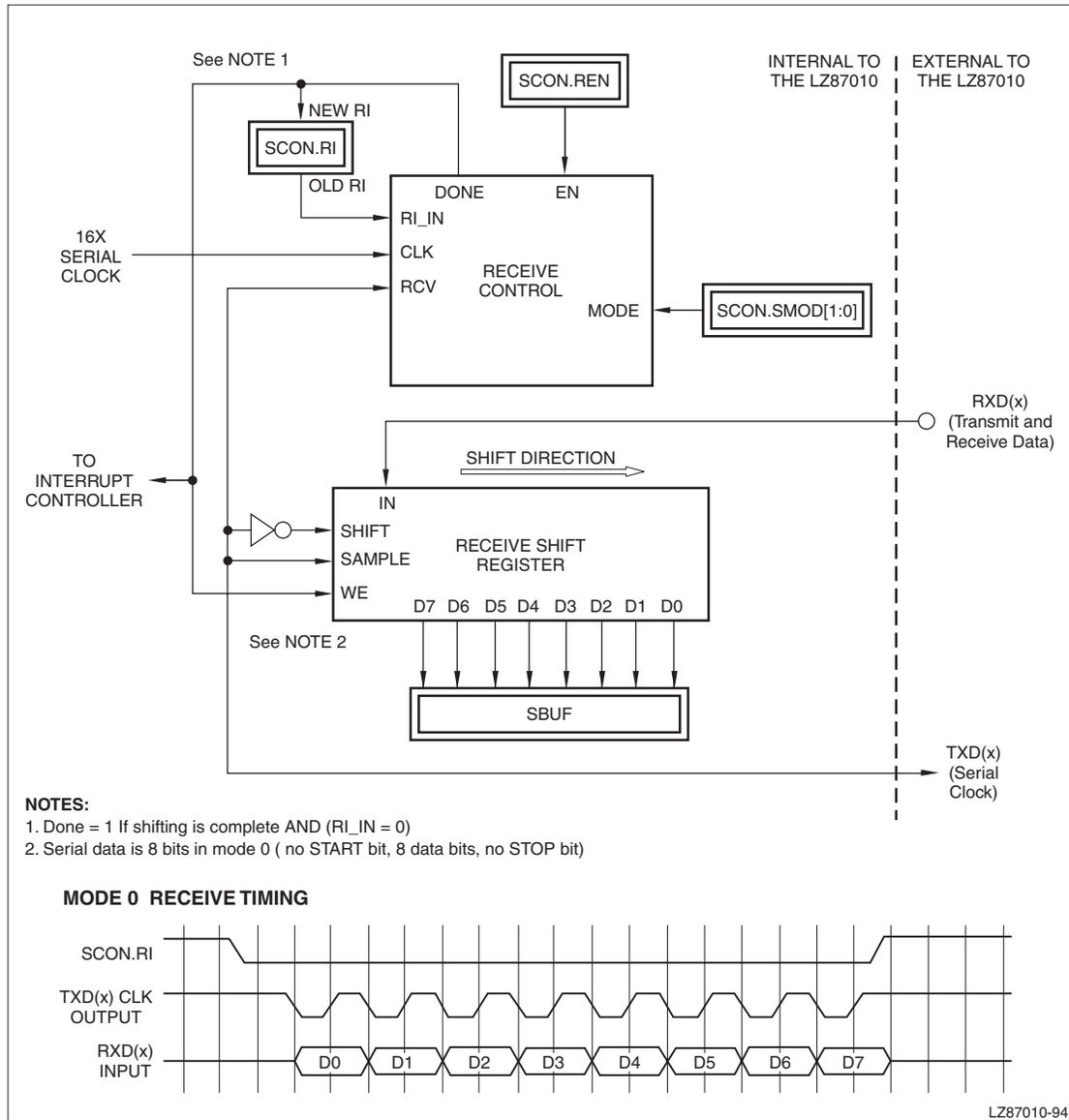


Figure 10-2. Receive Operation, Mode 0

10.1.2 Transmit Operation

In Modes 1-3, writing to the SBUF or SBUF1 register causes the data written to be sent out the TXD0 or TXD1 pin in the same serial format as described for the received data. For formats with nine-bit data (Modes 2 and 3), the ninth bit comes from the SCON.TB8 or SCON1.TB8 bit field. See Figure 10-3.

In Mode 0, writing to the SBUF or SBUF1 register causes the data to be sent out the RXD0 or RXD1 pin (which is used for both sending and receiving data in this mode). The serial clock is provided on TXD0 or TXD1. The receiving device should sample the serial data on the rising edge of the serial clock. See Figure 10-4.

Because the transmit section will not drive the bus unless software writes to SBUF or SBUF1 register, the transmit section does not require an enable/disable bit to allow the pin to be shared with other functions.

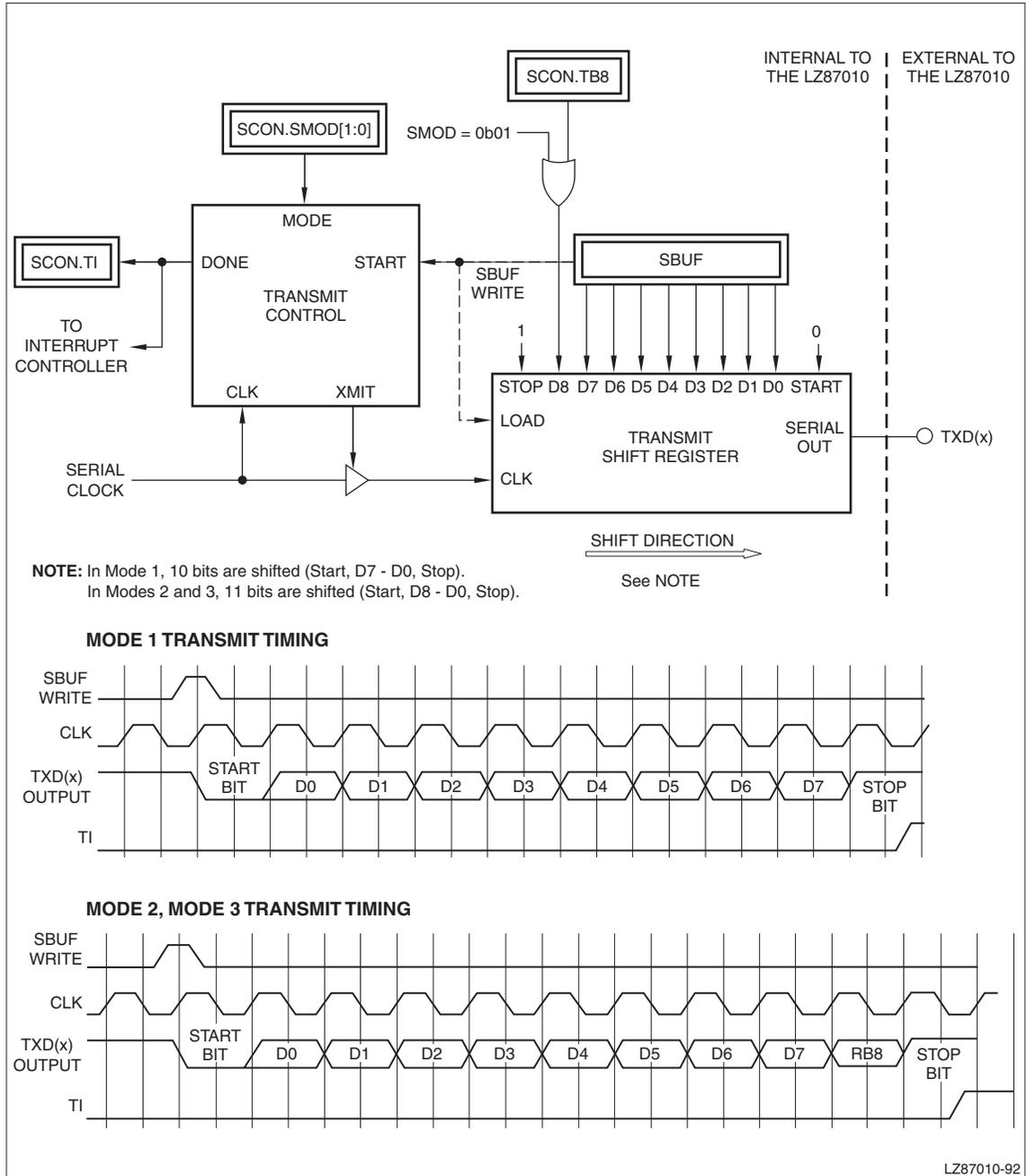
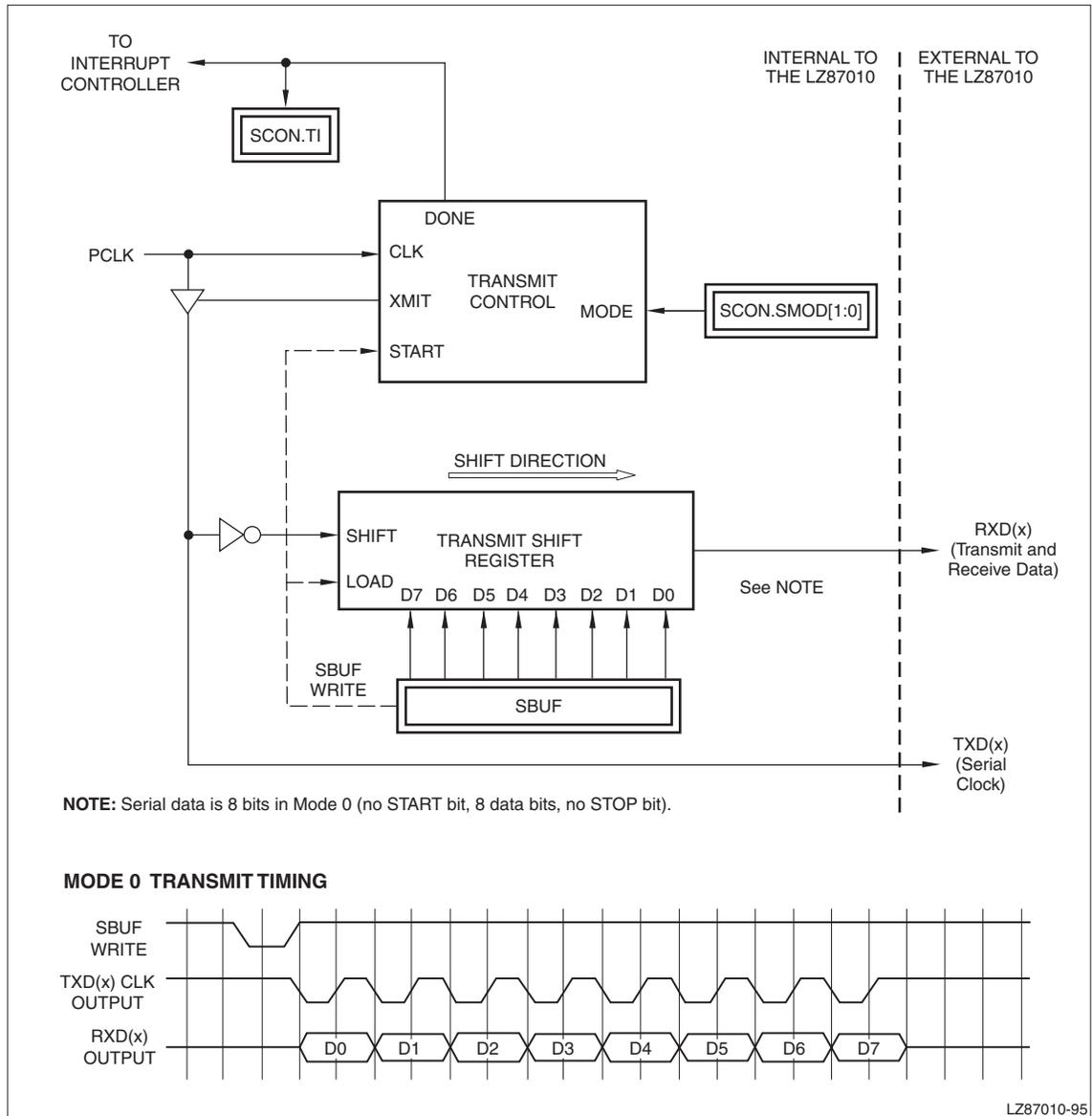


Figure 10-3. Transmit Operation, Modes 1 - 3



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Figure 10-4. Transmit Operation, Mode 0

10.1.3 Generating Baud Rates

Baud-rate generation is mode-dependent, as shown in Figure 10-5 and Figure 10-6.

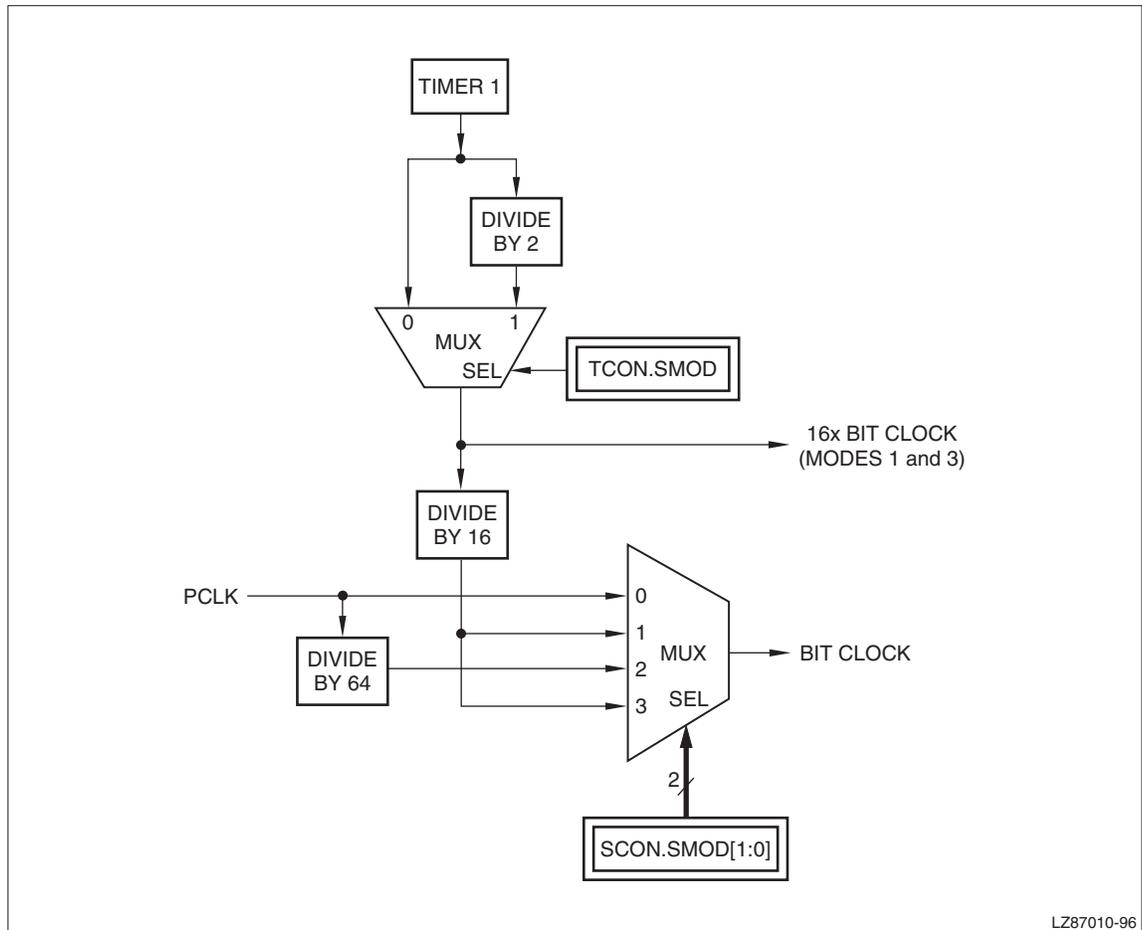


Figure 10-5. Clock Selection, UART 0

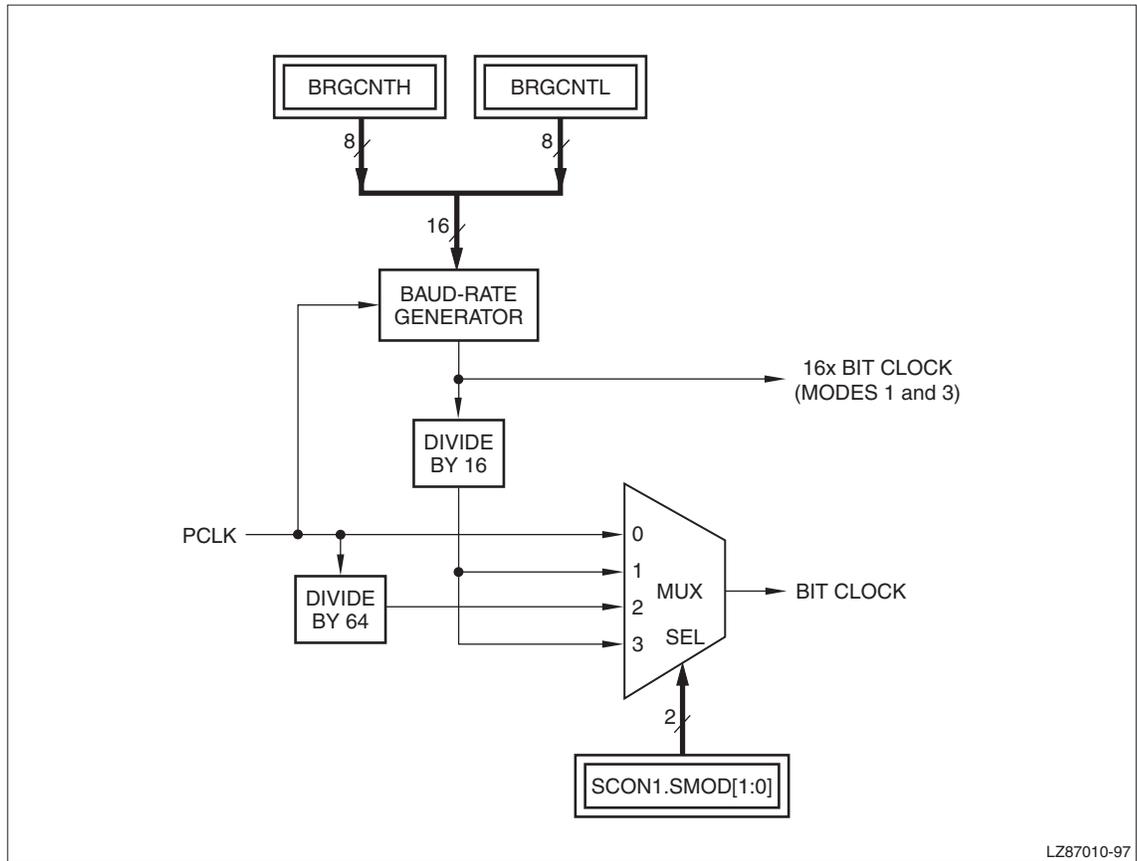


Figure 10-6. Clock Selection, UART 1

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10.1.3.1 Mode 0

In both UARTs, Mode 0 uses a fixed baud rate equal to PCLK.

10.1.3.2 Modes 1 and 3

UART 0 and 1 have a variable baud rate in these modes.

In UART 0, the baud rate is generated by setting Timer 1 to auto-reload mode (Timer Mode 2). The formula for the baud rate is:

$$\text{UART 0 Baud Rate} = \frac{(\text{PCON.SMOD} + 1) \times \text{PCLK}}{32 \times (256 - \text{TH1})}$$

For example, if PCLK is 20 MHz (XTAL = 40 MHz) and PCON.SMOD is 0, a TH1 value of 0 will give 2,441 baud (2,441 bits/s).

This equation can be restated as:

$$\text{TH1} = 256 - \frac{(\text{PCON.SMOD} + 1) \times \text{PCLK}}{32 \times \text{Baud}}$$

UART 1 uses a dedicated baud-rate generator, which is a 16-bit frequency divider that divides PCLK by any integer in the range of 1 and 65,536. See Figure 10-7. The baud-rate generator must be enabled by setting the ALTFEN1.UEN bit to '1'. The frequency divisor is selected by writing to the register pair BRGCNTH and BRGCNTL. UART 1 has a range of 19 baud to 1.25 Mbaud when the system oscillator is 40 MHz.

$$\text{UART 1 Baud Rate} = \frac{\text{PCLK}}{16 \times (\text{BRGCNT}[H:L] + 1)}$$

This equation can be restated as:

$$\text{BRGCNT}[H:L] = \frac{\text{PCLK}}{16 \times \text{Baud}} - 1$$

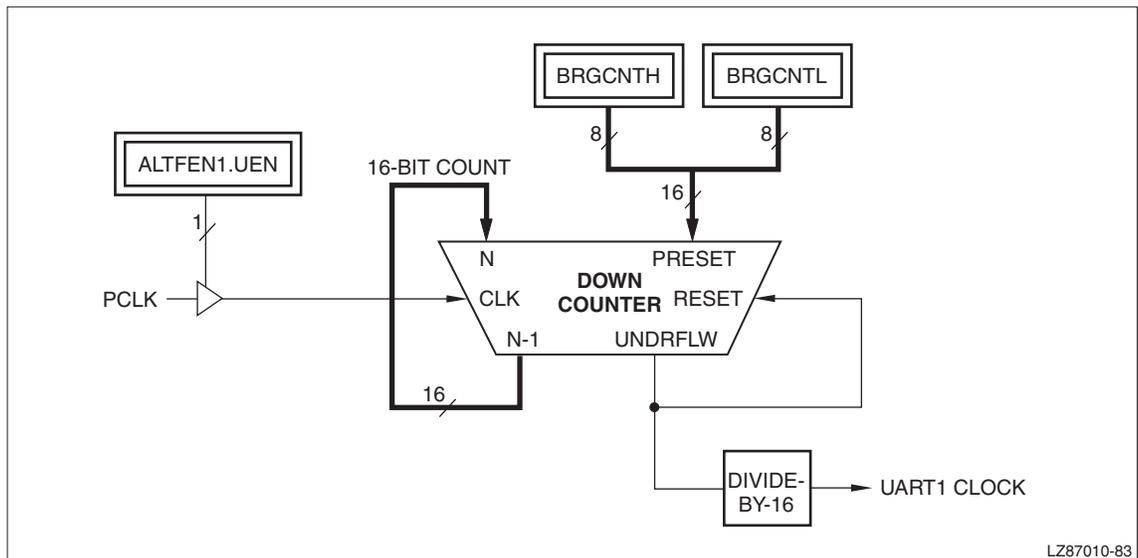


Figure 10-7. Baud Rate Generator, UART 1

10.1.3.3 Mode 2

In Mode 2, both UARTs use a fixed baud rate of PCLK/64.

10.1.3.4 Crystal Selection for RS-232 Baud Rates

Modes 1 and 3 can be used to generate standard RS-232 baud rates. Some readily available crystal frequencies are ideal for RS-232 baud-rate generation because they are an exact integer multiple of all the desired RS-232 data rates. For example, a 22.184 MHz crystal will provide bit rates with a nominal frequency error of zero between 2,400 and 76,800 baud on UART 0, and between 110 baud and 115,200 baud on UART 1. Other standard crystals are not exact multiples of standard baud rates, and only an approximation to the desired rate will be possible. Crystal frequencies of 20 MHz or 40 MHz will give frequency errors in excess of 1% for several baud rates in these ranges. This is shown in Table 10-1 and Table 10-2.

The maximum theoretical timing error margin (from all causes) in RS-232 communications occurs when the cumulative error adds up to one-half of a bit period across the entire character of 10-11 bits, or roughly 5%. This is reduced by the start-bit synchronization granularity of 1/16 bit period, with an addition 1/16 bit period in either direction caused by triple-sampling, which reduces the theoretical tolerance to 3/8 of a bit period, or roughly 3.75%.

Communications will be more reliable if the frequency error on each end is kept well below this value, which is the total combined error of both the sending and receiving devices. Errors such as the 1.4% to 1.7% errors shown in Table 10-1 and Table 10-2 are not advisable when connecting to unknown serial devices, but can be tolerated under favorable circumstances, such as debugging, where cable lengths are short and the other device is a standard PC serial port, which is known to have zero nominal error at normal baud rates.

Table 10-1. UART 0 Baud Rate Example, Modes 1 and 3

BAUD RATE, SMOD = 0	BAUD RATE, SMOD = 1	20 MHz XTAL		22.1184 MHz XTAL		40 MHz XTAL	
		TH1	Error	TH1	Error	TH1	Error
1,200	2,400	0	-1.7%				
2,400	4,800	126	-0.2%	112	0.0%	0	-1.7%
4,800	9,600	191	-0.2%	184	0.0%	126	-0.2%
9,600	19,200	223	1.4%	220	0.0%	191	-0.2%
19,200	38,400	240	-1.7%	238	0.0%	223	1.4%
38,400	76,800	248	-1.7%	247	0.0%	240	-1.7%

Table 10-2. UART 1 Baud Rate Example, Modes 1 and 3

BAUD RATE	20 MHz XTAL		22.1184 MHz XTAL		40 MHz XTAL	
	BRGCNT	Error	BRGCNT	Error	BRGCNT	Error
110	4,681	0.0%	6,283	0.0%	11,363	0.0%
134.5	4,646	0.0%	5,138	0.0%	9,293	0.0%
300	2,082	0.0%	2,303	0.0%	4,166	0.0%
600	1,041	0.0%	1,151	0.0%	2,082	0.0%
1,200	520	0.0%	575	0.0%	1041	0.0%
2,400	259	-0.2%	287	0.0%	520	0.0%
4,800	129	-0.2%	143	0.0%	259	-0.2%
9,600	64	-0.2%	71	0.0%	129	-0.2%
19,200	32	1.4%	35	0.0%	64	-0.2%
38,400	15	-1.7%	17	0.0%	32	1.4%
76,800	7	-1.7%	8	0.0%	15	-1.7%
115,200	4	-8.5%	5	0.0%	10	1.4%

10.1.4 Serial Interrupts

The UARTs can generate both transmit and receive interrupts. Receive interrupts are generated at the end of the receive operation, which is when the last bit is sampled on the RXD0 or RXD1 pin. This last bit is a stop bit except in Mode 0, when it is a data bit. Transmit interrupts are generated when the last data bit has been transmitted to the TXD0 or TXD1 pin. Received data is available when the receive interrupt bit (RI) is set in the SCON or SCON1 register.

The processor will call an interrupt routine if the interrupt is enabled. UART 0 has interrupt vector 0x0023. Its interrupt is enabled setting the IE.ES interrupt enable bit. UART 1 has interrupt vector 0x004B and is enabled by setting the IE1.IES0 interrupt enable bit.

The same vector is used by both transmit and receive interrupts. The interrupt handler determines which interrupts are pending by testing the RI and TI bits of the SCON or SCON1 register. These bits must be cleared by the interrupt handler to clear the pending interrupt. In particular, if RI is still set from a previous data transfer, any new received data transfers will be discarded. This test of RI is made when the stop bit is received on a new character, which means that the interrupt handler has one character time (ten or eleven bit periods, depending on the serial mode) to process the previous character.

10.2 Signals

Table 10-3 details the external signals for the UARTs.

Table 10-3. UART Signals

SIGNAL NAME	SIGNAL TYPE	PIN NUMBER	PIN TYPE	FUNCTIONAL UNIT	SHARED WITH	DESCRIPTION
RXD0	I	60	I/O	UART	P3[0]	UART 0 Receive Data
RXD1	I	63	I/O	UART	P3[3]	UART 1 Receive Data
TXD0	O	61	I/O	UART	P3[1]	UART 0 Transmit Data
TXD1	O	62	I/O	UART	P3[2]	UART 1 Transmit Data

10.3 UART Registers

10.3.1 SCON and SCON1 (Serial Control) Registers

The SCON and SCON1 registers control the operating modes of UART 0 and UART 1.

SCON and SCON1 set the serial port operating mode and enable or disable the serial receive and transmit functions. In addition, the Transmit and Receive Data interrupt status bits are reported in these registers. For serial modes where ninth data bits or stop bits are significant, the state of this extra bit is reported in RB8 for received data, or set in TB8 for transmitted data.

Table 10-4. SCON and SCON1 Registers

BIT	7	6	5	4	3	2	1	0
FIELD	SM[0]	SM[1]	SM[2]	REN	TB8	RB8	TI	RI
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	SCON: 0x98 SCON1: 0xC8							

Table 10-5. SCON and SCON1 Register Bits

BIT	NAME	DESCRIPTION
7	SM[0]	Serial Mode Determines the operating mode of the UART. See Table 10-6.
6	SM[1]	Serial Mode Determines the operating mode of the UART. See Table 10-6.
5	SM[2]	Serial Mode In Mode 0, this bit must be '0'. In other modes, this bit, if '1', will suppress the Receive Data Interrupt if the data is not valid. The definition of 'valid' depends on the mode, as described below. If '0', the Receive Data Interrupt functions normally. In Mode 1, this bit, if '1', will cause the receive data interrupt to be suppressed if a valid stop bit was not received. In Modes 2 and 3, this bit, if '1', enables the 'multiprocessor communication' feature, where the receive data interrupt is suppressed if the ninth data bit (RB8) is '0'. This feature is intended to allow multiple receiving units on a single serial line. Characters with the ninth data bit (RB8) set to '1' are broadcast characters received by all listeners.
4	REN	Receive Enable 1 = The receive data channel of the UART is enabled. 0 = The receive data channel of the UART is disabled.
3	TB8	Transmit Data Bit[8] In Modes 2 and 3, this is the ninth bit transmitted.
2	RB8	Receive Data Bit[8] In Modes 2 and 3, this is the ninth bit received. In Mode 1, if SM[0:1] = 0 this is the stop bit received. In Mode 0, this bit is not used.
1	TI	Transmit Interrupt Flag Set by hardware at the end of the eighth bit in Mode 0 or at the beginning of the stop bit in other modes. Must be cleared by software. Setting this bit in software will generate an interrupt.
0	RI	Receive Interrupt Flag Set by hardware at the end of the eighth bit in Mode 0 or halfway through the stop bit in other modes. If at that point the RI bit is already set, the received data will be discarded: RI, RB8, and SBUF will not be updated. Must be cleared by software. Setting this bit in software will generate an interrupt.

Table 10-6. SM[0:1] UART 0 and UART 1 Mode Bits

SM[0]	SM[1]	MODE	BAUD RATE
0	0	0	Baud rate is PCLK. For example, if PCLK is 10 MHz, the baud rate is 10 Mbit/s.
0	1	1	UART 0: The baud rate is determined by the SMOD bit in the PCON register and by Timer 1: Baud Rate = (PCON.SMOD + 1) × PCLK ÷ (32 × (256 – TH1)). Timer 1 is set up to run in auto-reload mode (Timer Mode 2). UART 1: The baud rate is determined by the baud rate generator's 16-bit counter value: Baud Rate = PCLK ÷ ((BRGCNTH, BRGCNTL + 1) × 16).
1	0	2	The baud rate is PCLK/64.
1	1	3	Same as Mode 1.

10.3.2 SBUF and SBUF1 (Serial Data Buffer) Registers

Each UART has a serial buffer register (SBUF for UART 0, and SBUF1 for UART 1), which has different functions on reads and writes. Writing to SBUF or SBUF1 copies the written data to the output section of the UART, where it is shifted out the TXD0 or TXD1 pin as serial data. Reading SBUF or SBUF1 reads the least-significant eight bits of the character most recently received.

The UARTs each have one character of data buffering for reads and one for writes. On writes, a character can be written while the previous character is being shifted out through the UART's transmit shift register. On reads, the previously received character can be read while the next character is being shifted in through the UART's receive shift register. Additional writes to the SBUF or SBUF1 register will overrun the transmit side and will corrupt the transmitted data. To prevent this, handshaking is provided through the RI and TI bits (receive and transmit interrupt bits) of the SCON and SCON1 registers.

Table 10-7. SBUF and SBUF1 Registers

BIT	7	6	5	4	3	2	1	0
FIELD	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]
RESET	—	—	—	—	—	—	—	—
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	SBUF: 0x99 SBUF1: 0xC9							

Table 10-8. SBUF, SBUF1 Register Bits

BIT	NAME	DESCRIPTION
7:0	D[7:0]	Serial Data When data is written to this register, it is copied to a shift register and sent as serial data over a Transmit Data pin. When a full character of serial data is received over a Receive Data pin, it is copied from the receive data shift register to this field. Nine-bit formats use the TB8 and RB8 bits of the UART's control register (SCON or SCON1) as well. These registers are undefined on Reset.

10.3.3 BRGCNTH and BRGCNTL (Baud Rate Generator Count) Registers

The UART 1 baud rate generator is implemented as an auto-reloading 16-bit countdown time clocked by PCLK. When the counter rolls over, it is reloaded with the 16-bit value in the BRGCNTH and BRGCNTL registers. The baud rate is determined by the following equation:

$$\text{Baud Rate} = \text{PCLK} \div ((\text{BRGCNTH}, \text{BRGCNTL}) + 1) \times 16$$

Loading BRGCNTL and BRGCNTH with 0xffff gives the minimum possible clock rate (19 baud with a 40 MHz CCLK), and loading them with 0x0 gives the maximum baud rate (1.25 Mbaud). UART1 will not function unless the ALTFEN1.UEN bit is set to '1'.

Table 10-9. BRGCNTH Register

BIT	7	6	5	4	3	2	1	0
FIELD	CNT[15]	CNT[14]	CNT[13]	CNT[12]	CNT[11]	CNT[10]	CNT[9]	CNT[8]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xC7							

Table 10-10. BRGCNTL Register

BIT	7	6	5	4	3	2	1	0
FIELD	CNT[7]	CNT[6]	CNT[5]	CNT[4]	CNT[3]	CNT[2]	CNT[1]	CNT[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xC6							

Chapter 11

External Memory

11.1 Theory of Operation

The LZ87010 supports up to 64KB of external memory, using an interface bus consisting of a 16-bit address bus (XMA[15:0]), an 8-bit data bus (XMD[7:0]), a write-enable signal (nPSWR), and an output enable signal (nPSEN). This interface is suitable for glueless operation with asynchronous memory devices such as static RAMs, EPROMs, and EEPROMs.

At reset, Flash is enabled and external memory is disabled. External memory can replace all or part of Flash memory by setting the XMCFG (external memory configuration) register. If the Flash has been placed into Secure mode, however, the Flash is always enabled, and no external memory accesses are possible. This is because the use of external program memory is inconsistent with program security.

A programmable number of wait states is inserted between the assertion of the address and the end of the transfer.

A block diagram of the LZ87010's external memory interface is shown in Figure 11-1.

11.1.1 Writing to External Memory

External memory is mapped to the program memory space of the 8051-compatible core. In the standard 8051 architecture, program memory is read-only. The LZ87010 implements read/write access to both internal Flash memory and external memory through a new instruction, MOVC (@DPTR++),A at opcode 0xA5. This instruction uses the Data Pointer register to refer to a 16-bit address. The Data Pointer is auto-incremented after each write.

NOTE: Opcode 0xA5 is shared with another instruction, the software break command TRAP. The MOVC (@DPTR++),A instruction is enabled when the TRAP_EN bit in the DPS register is '0'.

11.1.2 Reading from External Memory

While external memory is mapped as 'program memory', it can also be used for data storage. It is read with the standard 8051 MOVC instruction and (as already described) written with the MOVC (@DPTR++),A instruction.

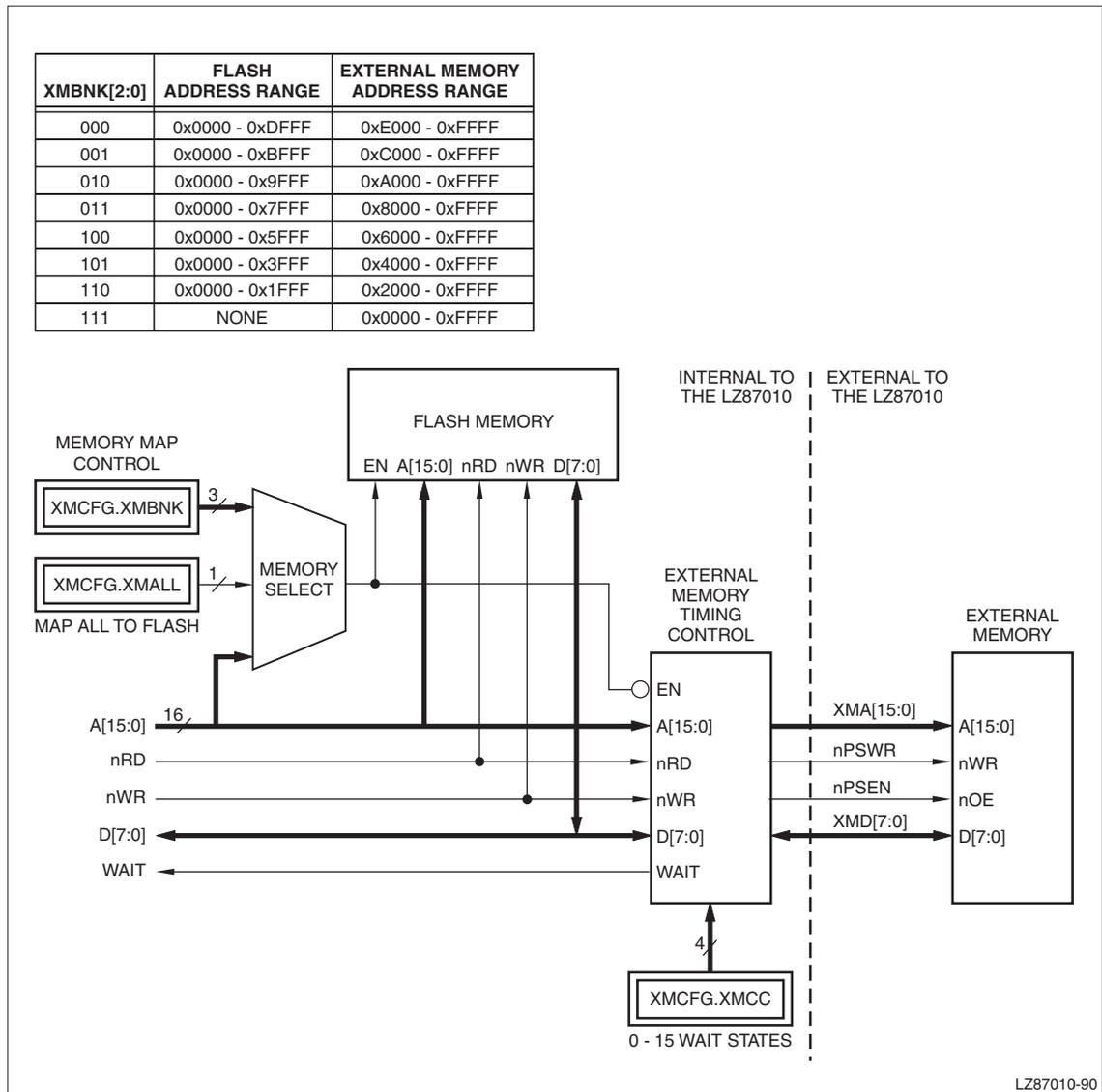


Figure 11-1. External Memory Interface

11.2 Signals

All of the external memory signals are shared with I/O ports, as shown in Table 11-1. Port 2, Port 5, and Port 8 are used in their entirety for address and data buses, while two bits of Port 1 provide output enable and write enable signals.

The 16-bit address uses two 8-bit ports. One of these, Port 2, is a high-current output port, while the other, Port 8, is a general-purpose I/O port. Designers should note that the output timing and characteristics of the two halves of the address are therefore not identical.

Table 11-1. External Memory Signals

SIGNAL NAME	SIGNAL TYPE	PIN NUMBERS	PIN TYPE	FUNCTIONAL UNIT	SHARED WITH	DESCRIPTION
nPSEN	O	8	I/O	External Memory	P1[7]	External Memory Output Enable
nPSWR	O	7	I/O	External Memory	P1[6]	External Memory Read/Write
XMA[15:8]	O	25:18	O	External Memory	P2	External Memory Address Bus, Upper 8 Bits
XMA[7:0]	O	35:28	I/O	External Memory	P8	External Memory Address Bus, Lower 8 Bits
XMD[7:0]	I/O	17:10	I/O	External Memory	P5	External Memory Data Bus

11.3 Registers

The external memory system is controlled by a single register, XMCFG. This register enables external memory, determines how much of the Flash memory is replaced by external memory, and sets the number of wait states to use on memory accesses.

Table 11-2. XMCFG Register

BIT	7	6	5	4	3	2	1	0
FIELD	XMCC[3]	XMCC[2]	XMCC[1]	XMCC[0]	XMBNK[2]	XMBNK[1]	XMBNK[0]	XMALL
RESET	0	0	0	0	0	0	0	1
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xC5							

Table 11-3. XMCFG Register Bits

BIT	NAME	DESCRIPTION
7:4	XMCC[3:0]	<p>External Memory Command Control Sets the number of wait states used in both read and write cycles. For reads, nPSEN will be asserted for one CCLK cycle plus the number of wait states specified in this field. For writes, nPSWR will be asserted for CCLK cycle plus the number of wait states specified in this field. For example, if XMCC[3:0] is set to 0b0101, five wait states will be used, meaning that nPSEN will be asserted for six cycles on reads, and nPSWR will be asserted for six cycles on writes.</p> <p>Since the external memory interface has no handshaking, this field must be programmed to take care of the worst-case timing of the external memory device.</p>
3:1	XMBNK[2:0]	<p>External Memory Bank Select These bits determine how much of the internal Flash memory will be replaced with external memory. See Table 11-4 for the decoding of this field.</p>
0	XMALL	<p>External Memory All On-chip Enable When set to '1', all program memory accesses refer to on-chip Flash. When '0', the mapping given in the XMBNK[2:0] field determines whether a given access uses on-chip Flash or external program memory. If the Flash has been placed in Secure Mode, this bit will be set to '1' and writes to it will be ignored. This prevents external memory access in Secure Mode. The default on Reset is for this bit to be set, enabling only the on-chip Flash.</p>

Table 11-4. XMBNK[2:0] Field Encoding

XMBNK[2:0]	FLASH ADDRESS RANGE	EXTERNAL MEMORY ADDRESS RANGE
000	0x0000 - 0xDFFF	0xE000 - 0xFFFF
001	0x0000 - 0xBFFF	0xC000 - 0xFFFF
010	0x0000 - 0x9FFF	0xA000 - 0xFFFF
011	0x0000 - 0x7FFF	0x8000 - 0xFFFF
100	0x0000 - 0x5FFF	0x6000 - 0xFFFF
101	0x0000 - 0x3FFF	0x4000 - 0xFFFF
110	0x0000 - 0x1FFF	0x2000 - 0xFFFF
111	None	0x0000 - 0xFFFF

11.4 External Memory Timing

When the LZ87010 reads data, the address is asserted first on XMA[15:0], followed by the assertion of the output enable, nPSEN, as shown in Figure 11-2. nPSEN is asserted for one cycle plus the number of wait states specified in the XMCFG register. Figure 11-3 shows a read with one wait state. The data on the XMD[7:0] pins is latched when nPSEN is deasserted.

Writes involve the successive assertion of address (XMA[15:0]), data (XMD[7:0]), and nPSWR, as shown in Figure 11-4. nPSWR is asserted for one cycle plus the number of wait states specified in the XMCFG register. Figure 11-5 shows a write with one wait state. The external memory device is expected to sample the data when nPSWR is deasserted.

As can be seen in Figure 11-2 through Figure 11-5, both reads and writes have a minimum cycle time of 7 CCLK periods, which can be extended by wait states. The minimum access time is 5 CCLK periods for both reads and writes.

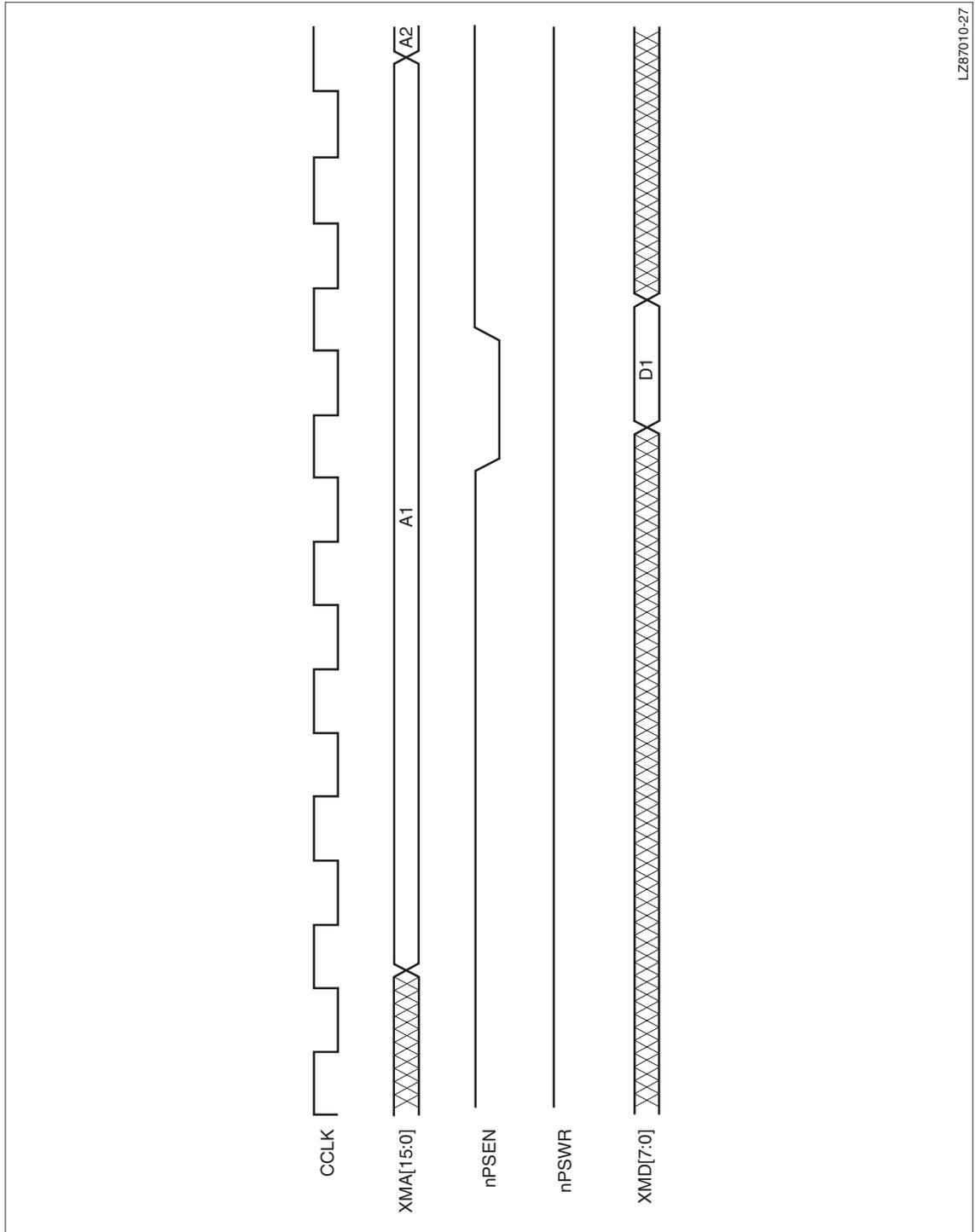


Figure 11-2. External Memory Read, No Wait States

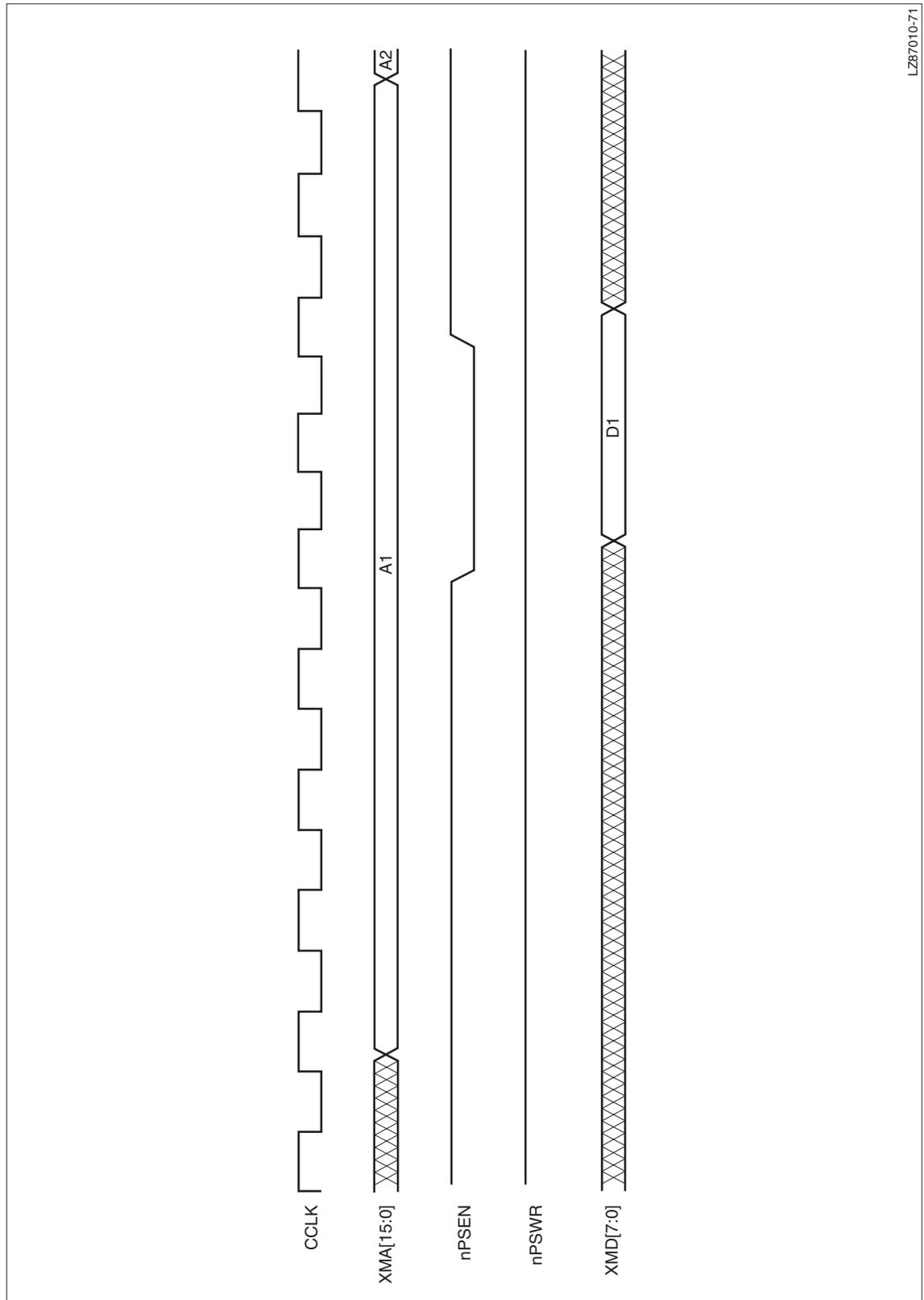


Figure 11-3. External Memory Read, One Wait State

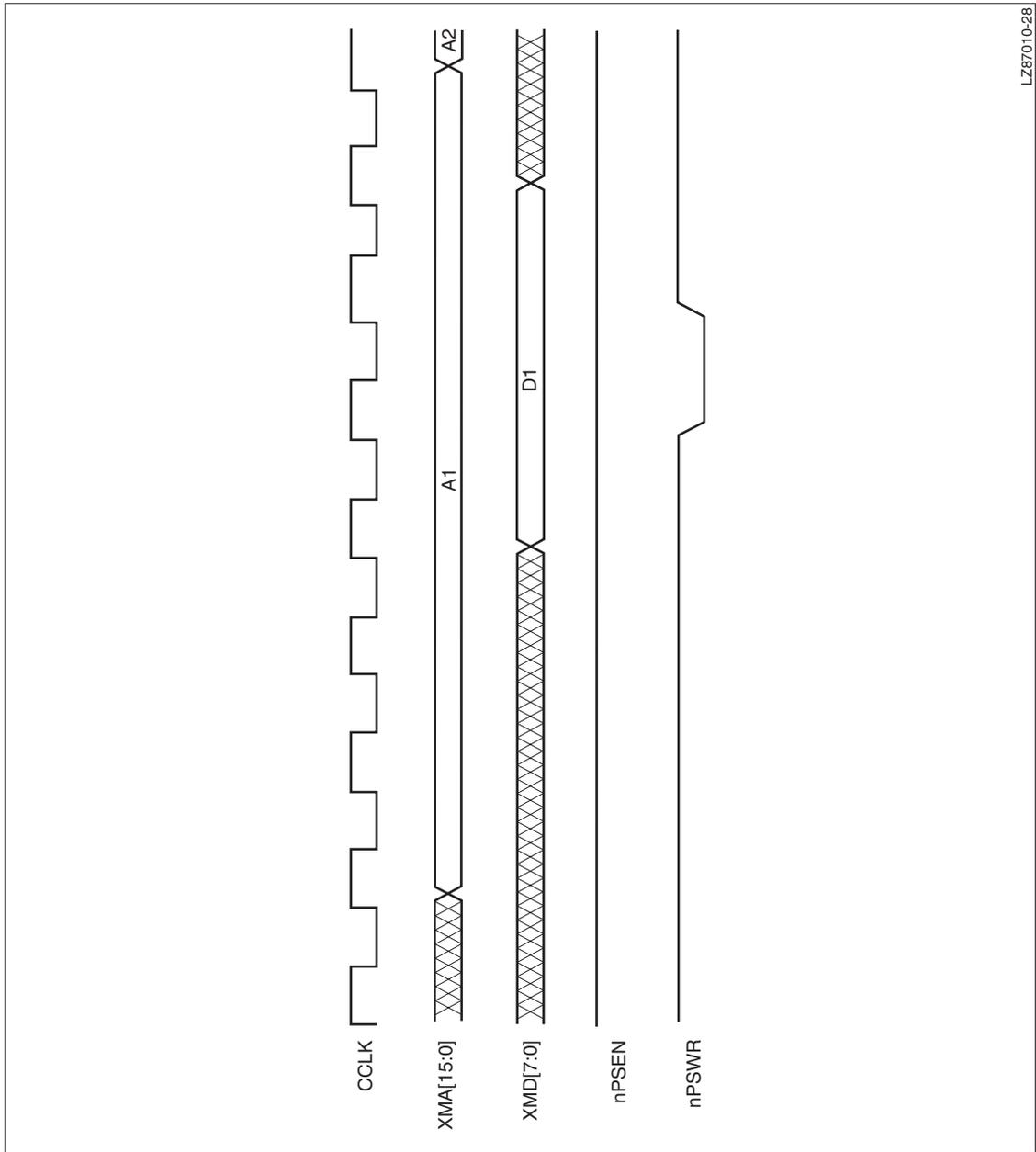
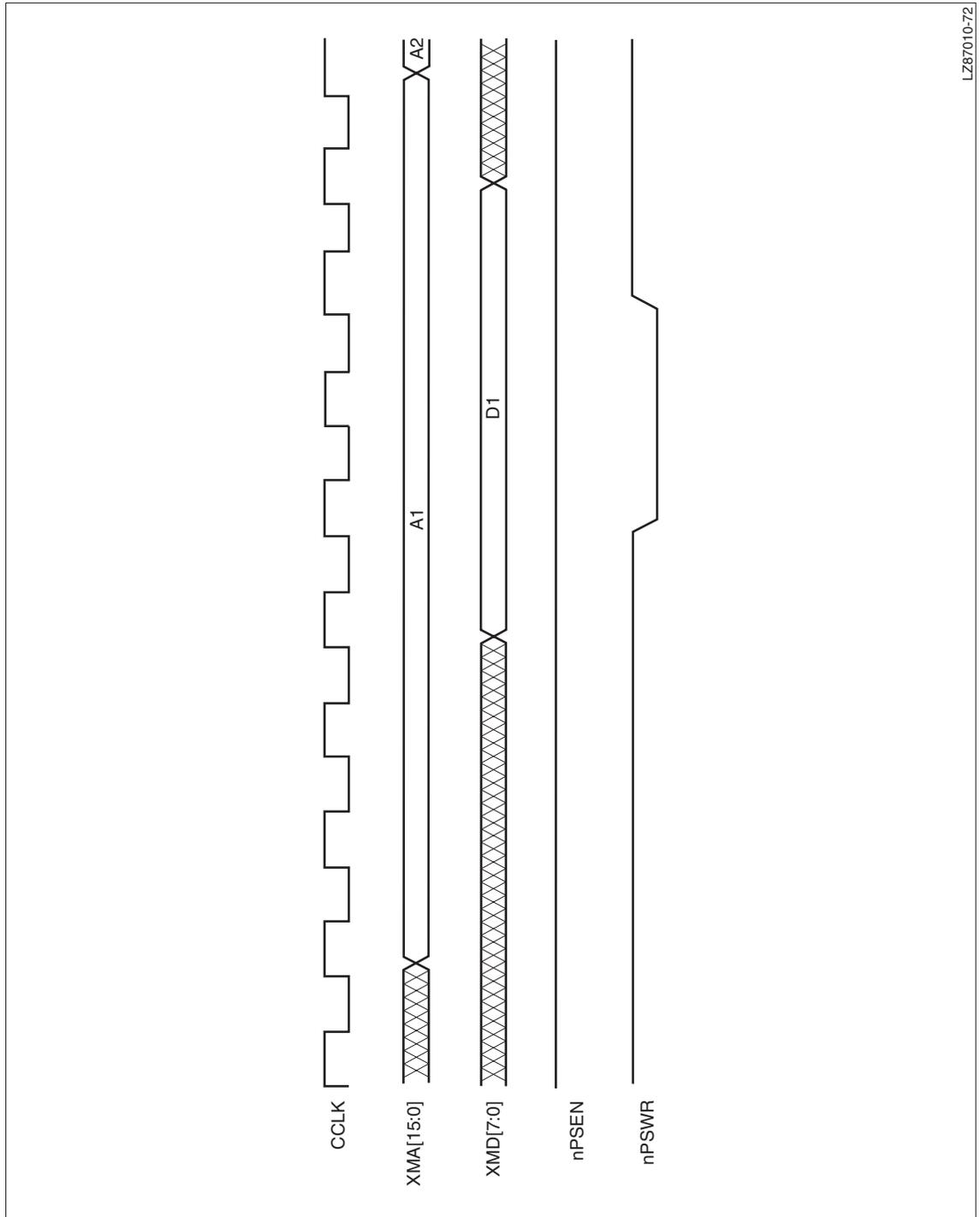


Figure 11-4. External Memory Write, No Wait States



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Figure 11-5. External Memory Write, One Wait State

Chapter 12

Interrupts

12.1 Theory of Operation

12.1.1 Interrupt-Related Registers

Many of the registers in the LZ87010 are interrupt-related, containing interrupt enable, status, or priority bits. Table 12-1 is a list of registers with interrupt-related functions.

Table 12-1. Interrupt-Related Registers

NAME	ADDRESS	DESCRIPTION	UNIT	
ALTFEN1	0x95	Alternate Function Enables	UARTs External Interrupts	
ICSTATE	0xBF	I ² C Status	I ² C	
IE	0xA8*	Interrupt Enable	Interrupts	
IE1	0xE8*	Interrupt Enable 1		
IP	0xB8*	Interrupt Priority Control		
IP1	0xF8*	Interrupt Priority Control		
IPH	0xB9	Interrupt Priority Control		
IPH1	0xF9	Interrupt Priority Control		
SCON	0x98*	UART 0 Control	UARTs	
SCON1	0xC8*	UART 1 Control		
T2CAP	0xD9	Timer 2 Capture Control	Enhanced Timers	
T2CMP	0xD3	Timer 2 Compare Control		
T2CON	0xD1	Timer 2 Control		
T2STA	0xD2	Timer 2 Status		
T3CAP	0xE9	Timer 3 Capture Control		
T3CMP	0xE3	Timer 3 Compare Control		
T3CON	0xE1	Timer 3 Control		
T3STA	0xE2	Timer 3 Status		
T4CMP	0xF3	Timer 4 Compare Control		
T4CON	0xF1	Timer 4 Control		
T4STA	0xF2	Timer 4 Status		
TCON	0x88*	Timer/Counter 0 and 1 Control		8051-Compatible Timers
TMOD	0x89	Timer/Counter 0 and 1 Mode		
WDTCTL	0xAC	Watchdog Timer Control		Watchdog Reset
WGCFG0	0xCC	Waveform Generator 0 Configuration		Waveform Generators
WGCFG1	0xCD	Waveform Generator 1 Configuration		

NOTE: *Registers with addresses ending in '8' or '0' are bit-addressable.

12.1.2 Interrupt Vectors

The LZ87010 uses 13 different interrupt vectors, each dedicated to a particular use. For example, a Timer 0 interrupt causes the interrupt controller to call the interrupt routine at 0x000B, while a Timer 1 interrupt calls the interrupt routine at 0x001B. Table 12-2 lists all of the interrupt vectors and their sources.

Each interrupt vector has an associated interrupt level, which determines the order in which interrupts are serviced if they have been assigned the same interrupt priority (That is, interrupt priority takes precedence over interrupt level). Interrupts with low interrupt levels are serviced before interrupts with higher interrupt levels. The interrupt vector is related to the interrupt level as follows:

$$\text{Vector} = (\text{Level} \times 8) + 3$$

Thus, the vector for interrupt level 0 is at address 0x0003. Eight bytes are reserved for each vector. Some interrupt service routines are short enough to fit in this space. Otherwise, a jump can be made to another point in code memory. (Address 0x0000 is reserved for the reset vector, and the three bytes allotted to it are just enough for a long jump instruction.)

Table 12-2. Interrupt Vectors

DESCRIPTION	VECTOR ADDRESS	INTERRUPT LEVEL *
External Interrupt 0 (INT0 pin)	0x0003	0
Timer 0	0x000B	1
External Interrupt 1 (INT1 pin)	0x0013	2
Timer 1	0x001B	3
UART 0	0x0023	4
Timer 4/Timer 5	0x0033	6
Timer 2/Timer 3	0x003B	7
I ² C	0x0043	8
UART 1	0x004B	9
ADC	0x0053	10
DAC 0 Waveform Generator	0x005B	11
DAC 1 Waveform Generator	0x0063	12
External Interrupt 2 (INT7:2 pins)	0x006B	13

NOTE: *The interrupt level shows the order in which simultaneous interrupts will be serviced if they are all set to the same priority level. The lowest level is serviced first. Levels 5 and 14 are not implemented in the LZ87010.

12.1.2.1 Vectors and Status Bits

An interrupt vector that is shared between two or more interrupt sources requires a status register so the interrupt handler can determine which interrupt was asserted. For example, Timer 2 has five interrupt sources that are handled by a single vector. The T2STA register contains a bit for each interrupt source, allowing the interrupt handler to determine which sources are active.

An interrupt source that has a vector to itself does not require a status bit. The fact that the interrupt handler has been called indicates that the interrupt has been asserted. For this reason, some interrupts do not have status at all, and others have status bits that are cleared upon entry to the associated interrupt handler. In the latter case, the interrupt status bits can be used when polling is preferred to interrupts.

12.1.3 Interrupt Sources

Most of the functional units in the LZ87010 can assert interrupts. The different interrupt sources are listed in Table 12-3.

Table 12-3. Interrupt Summary

INTR.	PIN	ENABLE	STATUS	DESCRIPTION
ADC		IE1.EADC	ADCC.STATUS*	ADC Interrupt Asserted at end of analog conversion.
DAC0		IE1.EDAC0		DAC 0, DAC 1 Interrupts Asserted after a pre-selected number of waveform generator outputs, as set in WGCFG(x).IVL[2:0]
DAC1		IE1.EDAC1		
I ² C	SDATA	IE1.EI2C	ICSTAT.INTR	I²C Interrupt Asserted when any I ² C interrupt occurs.
INT[0]	INT[0]	IE.EX0	TCON.IE0*	External Interrupt 0 Asserted on LOW level if TCON.IT0 = 0; asserted on falling edge if TCON.IT0 = 1
INT[1]	INT[1]	IE.EX1	TCON.IE1*	External Interrupt 1 Asserted on LOW level if TCON.IT1 = 0; asserted on falling edge if TCON.IT1 = 1
INT[7:2]	INT[7:2]	IE1.EX2	P0[7:2]	External Interrupts 7:2 Asserted on AND(INT[7:0]) = 0 (any signal LOW) when ALTFEN1.IT2 = 0. Asserted on rising edge of OR(INT[7:0]) = 1 (rising edge of any signal) if ALTFEN.IT2 = 1. Status of individual pins can be read on P0[7:2] (same pins as INT[7:2]) if interrupt source is still asserted when P0 is read by the interrupt handler.
TIMER 0		IE.ET0		Timer 0 Interrupt Asserted when Timer 0 overflows.
TIMER 1		IE.ET1		Timer 1 Interrupt Asserted when Timer 1 overflows.
TIMER 2, TIMER 3	CTCAP2A, CTCAP2B, CTCAP3A, CTCAP3B	IE1.ET2T3, T(x)CAP.IIE0, T(x)CAP.IIE1, T(x)CMP.IOE0, T(x)CMP.IOE1, T(x)CON.OVF_EN	T(x)STA.CAP0_ST, T(x)STA.CAP1_ST, T(x)STA.CMP0_ST, T(x)STA.CMP1_ST, T(x)STA.OVF_ST,	Timer 2 and Timer 3 Interrupts Asserted when any enabled interrupt condition in either Timer 2 or Timer 3 occurs. Set status bits must be cleared in software. The four CTCAP(x)(y) pins can be used as general-purpose edge-triggered interrupts as well as external event timers.
TIMER 4, TIMER 5		IE1.ET4T5, T(x)CMP.IOE0, T(x)CMP.IOE1, T(x)CON.OVF_EN	T(x)STA.CMP0_ST, T(x)STA.CMP1_ST, T(x)STA.OVF_ST,	Timer 4 and Timer 5 Interrupts Asserted when any enabled interrupt condition in either Timer 4 or Timer 5 occurs. The status bits must be cleared in software.
UART 0	RXD0, TXD0	IE.ES	SCON.RI, SCON.TI	UART 0 Interrupt Asserted when either the receive buffer is full or the transmit buffer is empty. The SCON.RI bit must be cleared in software for further receive interrupts to occur.
UART1	RXD1, TXD1	IE1.ES1	SCON1.RI, SCON1.TI	UART 1 Interrupt As UART 0.

NOTE: *These status registers are cleared automatically upon entry to the interrupt handler, which means that the interrupt routine cannot test them successfully.

12.1.4 Interrupt Priority

There are four interrupt priority levels, given as a two-bit quantity. The LSB is in IP or IP1, while the MSB is in IPH or IPH1. For example, the Timer 0 interrupt priority LSB is in IP1 and its MSB is in IPH1. Interrupt 0b00 is the lowest priority and 0b11 is the highest. Note that this is the reverse of the numbering scheme used for interrupt levels.

12.1.5 External Interrupts

External interrupts have two modes: level-triggered and edge-triggered (also called level-sensitive and edge-sensitive). These are handled differently in both hardware and software.

With level-triggered interrupts, the interrupt is asserted by pulling one of the external interrupt pins LOW. This signal is held LOW until the interrupt handler explicitly signals that it be released, generally by dedicating I/O port pins as interrupt acknowledge outputs. Care should be taken to ensure that an incoming interrupt cannot be dropped if it is asserted too close to the acknowledge, and that, on the other hand, a single interrupt assertion will never be serviced twice.

With edge-triggered interrupts, the interrupt is asserted by strobing the external interrupt pin (a falling edge in the case of INT[0] or INT[1], and a rising edge in the case of INT[7:2]). With edge-triggered interrupts, the interrupt source does not have to be cleared explicitly, simplifying hardware design. The minimum pulse width for edge-triggered interrupts is two PCLK cycles.

12.1.5.1 INT[0] and INT[1]

External interrupts 0 and 1 use the INT[0] and INT[1] pins. Each has its own interrupt vector and status bit. These two interrupts are 8051-compatible. They can be individually selected as being edge-triggered on a falling edge or level-triggered on a LOW level, using the TCON.IT0 and TCON.IT1 bits.

12.1.5.2 INT[7:2]

The external interrupts INT[7:2] consist of six interrupt pins sharing a single vector. The six pins are either all level-triggered on a LOW level or all edge-triggered on a rising edge. See Figure 12-1.

The INT[7:2] pins have no status register. Instead, these interrupts are mapped to the same pins as P0[7:2]. Because both functions of dual-function pins are simultaneously active, the state of the interrupt pins can be read by reading P0. P0[7] gives the state of INT[7], for example.

This works well with level-triggered interrupts, but when INT[7:2] are used as edge-triggered interrupts, a strobed interrupt assertion is likely to have been deasserted before the interrupt handler can test P0, making it impossible to determine which interrupt pin was asserted. This problem does not occur if only one of the INT[7:2] interrupt pins is used, or if the interrupt strobe is held in the same manner as level-triggered level-triggered interrupts.

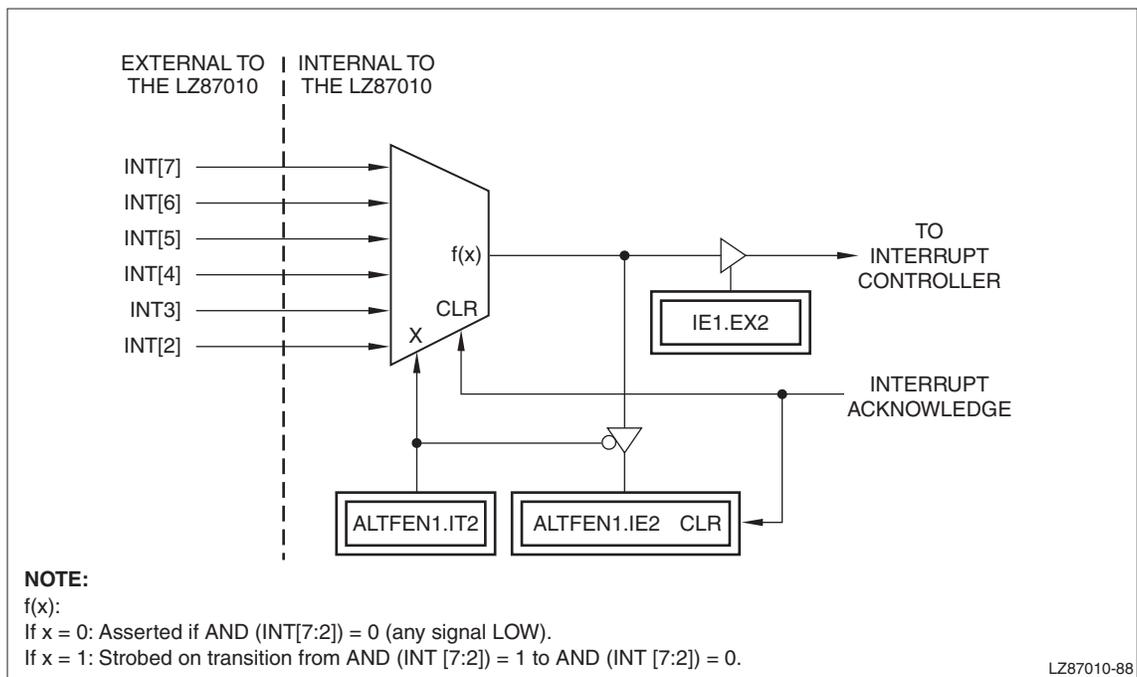


Figure 12-1. External Interrupts INT[7:2]

12.2 Signals

Table 12-4 shows the interrupt request signals in the LZ87010.

Table 12-4. Interrupt Signals

SIGNAL NAME	SIGNAL TYPE	PIN NUMBER	PIN TYPE	FUNCTIONAL UNIT	SHARED WITH	DESCRIPTION
INT[7:0]	I	83:76	I/O	Interrupts	P0[7:0]	Interrupt Request Signals

12.3 Registers

This section lists registers that deal primarily with interrupts. Many other registers have some interrupt-related functions. These are listed in Table 12-1 and are covered in other chapters.

12.3.1 ALTFEN1 (Alternate Function Enable) Register

The ALTFEN1 (Alternate Function Enable) register enables and disables UART 1 and selects between edge and level triggering on the INT[7:2] pins.

Table 12-5. ALTFEN1 Register

BIT	7	6	5	4	3	2	1	0
FIELD	///	///	///	///	///	UEN	IE2	IT2
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RO	RW
ADDR	0x95							

Table 12-6. ALTFEN1 Register Bits

BIT	NAME	DESCRIPTION
7:3	///	Reserved Reads return 0; write as 0.
2	UEN	UART 1 Enable When '1', UART 1 is enabled. When '0', UART 1 is inactive.
1	IE2	Interrupt Edge Flag When 'interrupt 2' (INT[7:2]) is set to be edge-sensitive (ALTFEN1.IT2 = 1), this bit is set whenever the hardware detects a rising edge on the OR function of INT[7:2]. It is cleared automatically upon entry to the interrupt service routine. When INT[7:2] is set to be level-sensitive (ALTFEN1.IT2 = 0), this bit always returns 0.
0	IT2	Interrupt Trigger Mode This bit selects whether interrupt pins INT[7:2] are level-sensitive or edge sensitive. If '1', the interrupts are edge-sensitive and will be asserted when a rising edge is detected on the OR function of INT[7:2]. If '0', the interrupts are level-sensitive and are asserted whenever any interrupt input in INT[7:2] is LOW (that is, whenever a bitwise AND of INT[7:2] is zero).

12.3.2 IE (Interrupt Enable) Register

The IE (interrupt enable) register contains a global interrupt enable bit and individual interrupt enable bits for the standard 8051 interrupts.

Table 12-7. IE Register

BIT	7	6	5	4	3	2	1	0
FIELD	EA	///	///	ES	ET1	EX1	ET0	EX0
RESET	0	0	0	0	0	0	0	0
RW	RW	RO	RO	RW	RW	RW	RW	RW
ADDR	0xA8							

Table 12-8. IE Register Bits

BIT	NAME	DESCRIPTION
7	EA	Enable All Global interrupt enable bit. If '1', interrupt processing is enabled. If '0', all interrupts are disabled.
6:5	///	Reserved Reads return 0; write as 0.
4	ES	Enable Serial Port 0 Interrupts If '1', UART 0 interrupts are enabled. If '0', they are disabled.
3	ET1	Enable Timer 1 Interrupt If '1', Timer 1 interrupts are enabled. If '0', they are disabled.
2	EX1	Enable External Interrupt 1 If '1', INT[1] interrupts are enabled. If '0', they are disabled.
1	ET0	Enable Timer 0 Interrupt If '1', Timer 0 interrupts are enabled. If '0', they are disabled.
0	EX0	Enable External Interrupt 0 If '1', INT[0] interrupts are enabled. If '0', they are disabled.

12.3.3 IE1 (Interrupt Enable 1) Register

The IE1 (Interrupt Enable 1) register contains individual interrupt enable bits for extended interrupts.

Table 12-9. IE1 Register

BIT	7	6	5	4	3	2	1	0
FIELD	EX2	EDAC1	EDAC0	EADC	ES1	EI2C	ET2T3	ET4T5
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xE8							

Table 12-10. IE1 Register Bits

BIT	NAME	DESCRIPTION
7	EX2	Enable Extended Interrupt 13 (INT[7:2]) If '1', external interrupts INT[7:2] are enabled. If '0', they are disabled.
6	EDAC1	Enable Extended Interrupt 12 (DAC 1) If '1', DAC 1 interrupts are enabled. If '0', they are disabled.
5	EDAC0	Enable Extended Interrupt 11 (DAC 0) If '1', DAC 0 interrupts are enabled. If '0', they are disabled.
4	EADC	Enable Extended Interrupt 10 (ADC) If '1', ADC interrupts are enabled. If '0', they are disabled.
3	ES1	Enable Extended Interrupt 9 (UART 1) If '1', UART 1 interrupts are enabled. If '0', they are disabled.
2	EI2C	Enable Extended Interrupt 8 (I²C) If '1', I ² C interrupts are enabled. If '0', they are disabled.
1	ET2T3	Enable Extended Interrupt 7 (Timer 2 and Timer 3) If '1', Timer 2 and Timer 3 interrupts are enabled. If '0', they are disabled.
0	ET4T5	Enable External Interrupt 6 (Timer 4 and Timer 5) If '1', Timer 4 and Timer 5 interrupts are enabled. If '0', they are disabled.

12.3.4 IP and IPH (Interrupt Priority) Registers

The IP and IPH (Interrupt Priority) registers set the priority of the standard 8051 interrupts. Priority level is a two-bit number, with priority 0b00 being the lowest priority and 0b11 the highest. The least-significant bits of the individual interrupt priorities are in the IP and IP1 registers, while the most-significant bits are in the IPH and IPH1 registers.

For example, to set a priority level of 0b10 for UART 0, IP.PS would be 0b0 and IPH.PS would be 0b1.

Table 12-11. IP and IPH Register

BIT	7	6	5	4	3	2	1	0
FIELD	///	///	///	PS	PT1	PX1	PT0	PX0
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	IP: 0xB8 IPH: 0xB9							

Table 12-12. IP, IPH Register Bits

BIT	NAME	DESCRIPTION
7:5	///	Reserved Reads return '0'; write as '0'.
4	PS	Priority for Serial Port 0
3	PT1	Priority for Timer 1
2	PX1	Priority for INT[1]
1	PT0	Priority for Timer 0
0	PX0	Priority for INT[0]

12.3.5 IP1 and IPH1 (Interrupt Priority) Registers

The IP1 and IPH1 (Interrupt Priority) registers set the priority of the extended interrupts. Priority level is a two-bit number, with priority 0b00 being the lowest priority and 0b11 the highest. The least-significant bits of the individual interrupt priorities are in the IP and IP1 registers, while the most-significant bits are in the IPH and IPH1 registers.

Table 12-13. IP1 and IPH1 Register

BIT	7	6	5	4	3	2	1	0
FIELD	PI13	PI12	PI11	PI10	PI9	PI8	PI7	PI6
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	IP1: 0xF8 IPH1: 0xF9							

Table 12-14. IP1, IPH1 Register Bits

BIT	NAME	DESCRIPTION
7	PI13	Priority of Interrupt 13 (INT[7:2])
6	PI12	Priority of Interrupt 12 (DAC 1)
5	PI11	Priority of Interrupt 11 (DAC 0)
4	PI10	Priority of Interrupt 10 (ADC)
3	PI9	Priority of Interrupt 9 (UART 1)
2	PI8	Priority of Interrupt 8 (I ² C)
1	PI7	Priority of Interrupt 7 (Timer 2 and Timer 3)
0	PI6	Priority of Interrupt 6 (Timer 4 and Timer 5)

Chapter 13

Analog Inputs (ADC)

13.1 Theory of Operation

The 8 analog inputs AN[7:0] connect to an 8:1 analog multiplexer, which in turn connects to a 12-bit analog-to-digital converter (ADC), using a successive approximation register (SAR) algorithm. Figure 13-1 shows a block diagram of the ADC. The maximum voltage of the ADC is set by the voltage reference signal ADVREF. The maximum conversion rate is 500,000 samples per second (with a 10 MHz ADC clock). The ADC unit is clocked by a divided HFCLK signal. The CLKCFG.ADCDIV field (described in Chapter 2) sets the divisor. The ADC unit should be clocked between 1.6 MHz and 10 MHz.

The value returned by the ADC is formatted as a 16-bit unsigned integer with zeroes in the least-significant 4 bits. The upper 8 bits are returned in ADCDH and the lower 4 bits are returned in ADCDL. This value represents a fraction, where:

$$\text{ADCD}[H:L] = V(\text{AN}[\text{ADCC.SEL}]) / V(\text{ADVREF})$$

A value of 0xFFFF0 (the maximum value) indicates that the analog input is greater than $(0xFFFF0/0x10000) \times \text{ADVREF}$, or $(4,095/4,096) \times \text{ADVREF}$. All voltages are referenced to VSSA.

Using the ADC requires the following steps:

1. Set the ADC clock divisor to achieve an ADC clock rate between 1.6 and 10 MHz. This uses the CLKCFG.ADCCLK field. For example, a value of 0b100 selects a clock divisor of 4, suitable for a 40 MHz HFCLK oscillator.
2. Enable the ADC by setting ADCC.PWEN = 0b1. Wait for the ADC to power up (see the ADC AC Specifications).
3. Select the desired ADC input pin (one of AN[7:0]) by writing the ADCC.SEL field with a value equal to the signal number. For example, select AN[3] by setting ADCC.SEL = 0b011.
4. Before each conversion, set ADCC.START to 0b1 to begin sampling (tracking) the selected signal. The ADCC.STATUS bit will change to 0b0 to indicate that a start-of-conversion request is now pending. The output of the previous conversion will remain in the ADCDH and ADCDL registers until Step 6.
5. Wait at least one ADCCLK period to allow the inputs to settle after MUX selection.
6. Start the conversion by setting ADCC.START to 0b0. This will capture (hold) the analog sample and process the A-to-D conversion.
7. Wait for conversion to complete. If the ADC interrupt is enabled, the interrupt handler will be called upon completion. If polling, completion is indicated by ADCC.STATUS = 0b1. (Note that ADCC.STATUS will be cleared on entry to the interrupt handler, so this bit should only be tested in a polled environment.) Conversion takes 16 ADCCLK cycles.
8. Read the resulting 12-bit unsigned ADC value from ADCDH and ADCDL.

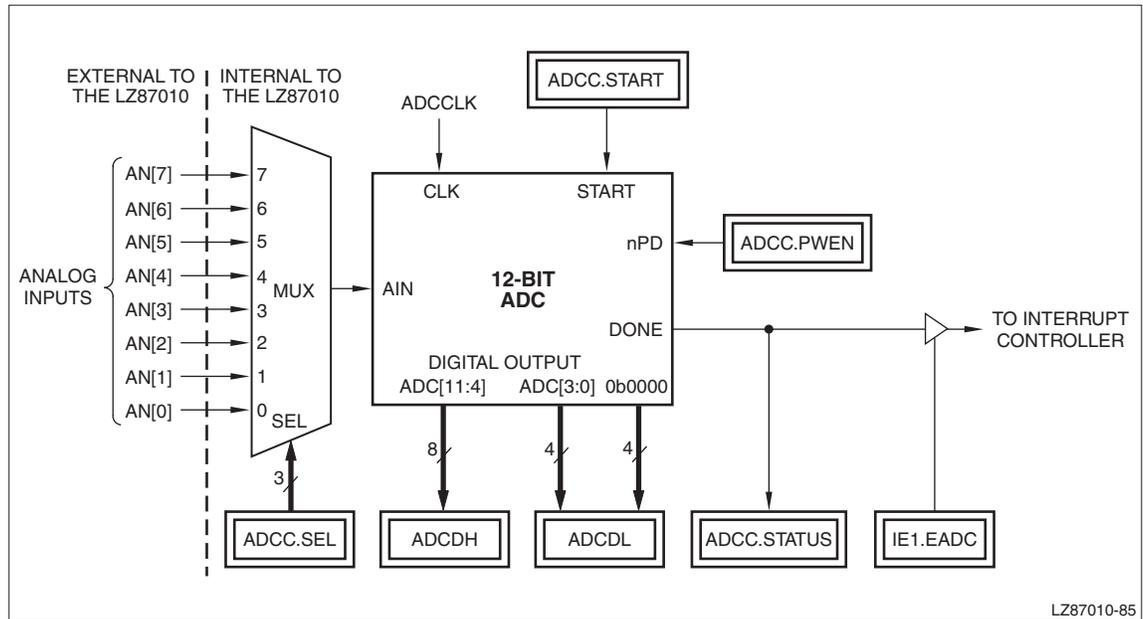


Figure 13-1. ADC Block Diagram

13.2 Signals

Table 13-1 details the ADC Signals.

Table 13-1. ADC Signal Descriptions

SIGNAL NAME	SIGNAL TYPE	PIN NUMBER	PIN TYPE	FUNCTIONAL UNIT	SHARED WITH	DESCRIPTION
ADVREF	I	50	I	ADC		Analog input. Voltage Reference for Analog-to-Digital Converter. This pin sets the upper limit of the voltage conversion range. See the DC Specifications for the maximum and minimum ADVREF voltages.
AN[7:0]	I	58:51	I	ADC		Analog Input Ports

13.3 Registers

13.3.1 ADCC (ADC Control) Register

The ADCC (ADC Control) register contains the ADC's configuration and status bits.

Table 13-2. ADCC Register

BIT	7	6	5	4	3	2	1	0
FIELD	PWEN	///	///	STATUS	START	SEL[2]	SEL[1]	SEL[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	R	RW	RW	RW	RW
ADDR	0xC3							

Table 13-3. ADCC Register Bits

BIT	NAME	DESCRIPTION
7	PWEN	Power Enable Allows the ADC to be turned off when not in use to conserve power. 0 = Off 1 = On
6:5	///	Reserved Reads return '0'. Write as '0'.
4	STATUS	Status Read-only status bit. A '1' indicates that the conversion is complete. This bit is cleared on entry to the interrupt handler and when a new conversion is started.
3	START	Start Conversion To start a conversion, write a '1' to this bit, followed by a '0'. The time between these two writes defines the sampling window and must be at least one ADCCLK period.
2:0	SEL[2:0]	Input Select Selects the analog input pin. The three-bit value maps directly to AN[7:0]. The settling time of the ADC is the time between selecting the input and the second write to ADCC.START (the '0' that starts the conversion).

13.3.2 ADCDH (ADC Data High) Register

The ADCDH (ADC Data High) register returns the upper 8 bits of the 12-bit analog-to-digital conversion.

Table 13-4. ADCDH Register

BIT	7	6	5	4	3	2	1	0
FIELD	ADCD[11]	ADCD[10]	ADCD[9]	ADCD[8]	ADCD[7]	ADCD[6]	ADCD[5]	ADCD[4]
RESET	0	0	0	0	0	0	0	0
RW	RO	RO	RO	RO	RO	RO	RO	RO
ADDR	0xC2							

Table 13-5. ADCDH Register Bits

BIT	NAME	DESCRIPTION
7:0	ADCD[11:4]	ADC Data Register High Bits This register holds the 8 most-significant bits of the converted analog signal.

13.3.3 ADCDL (ADC Data Low) Register

The ADCDL (ADC Data Low) register returns the lower 4 bits of the 12-bit analog-to-digital conversion. Note that these bits are left-aligned in the register.

Table 13-6. ADCDL Register

BIT	7	6	5	4	3	2	1	0
FIELD	ADCD[3]	ADCD[2]	ADCD[1]	ADCD[0]	///	///	///	///
RESET	0	0	0	0	0	0	0	0
RW	RO	RO	RO	RO	RO	RO	RO	RO
ADDR	0xC1							

Table 13-7. ADCDL Register Bits

BIT	NAME	DESCRIPTION
7:4	ADCD[3:0]	ADC Data Register Low Bits This register holds the least significant 4 bits of the converted analog signal.
3:0	///	Reserved Reads return '0'.

Chapter 14

Analog Outputs (DAC)

14.1 Theory of Operation

The LZ87010 has two identical 8-bit digital-to-analog converters (DACs), DAC0 and DAC1. Each DAC has an associated waveform generator with 128 bytes of RAM. Figure 14-1 shows a block diagram of one DAC and waveform generator.

14.1.1 Digital-to-Analog Converter (DAC)

The DAC is implemented as a pair of 4-bit static sub-ranging DACs with power-down. It consists of input decoders, coarse and fine resolution resistor networks and an output buffer amplifier. The maximum voltage of the output is set by the voltage reference DAVREF relative to VSSA. The DAC's maximum settling time is 0.45 μ s (99.9%).

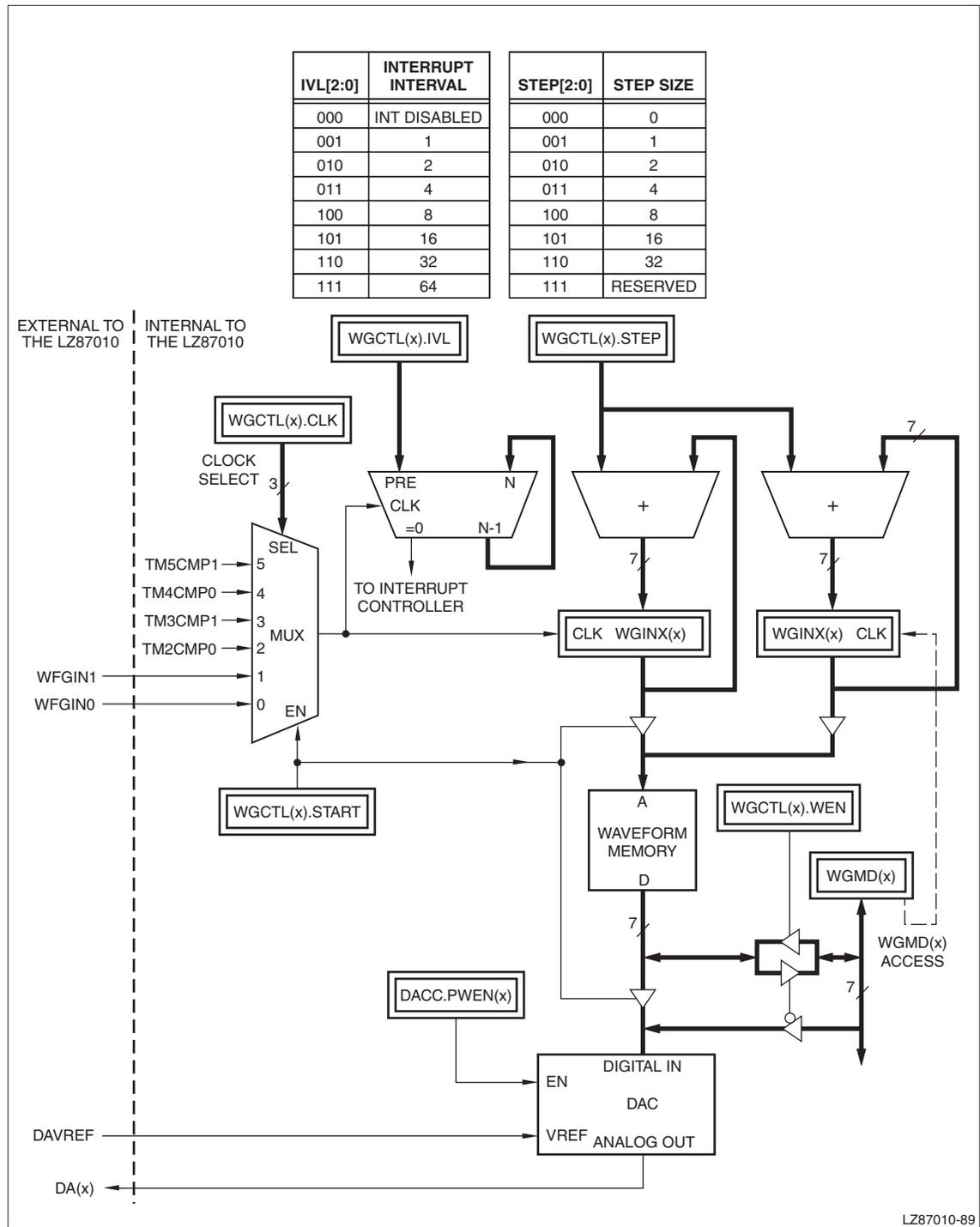


Figure 14-1. DAC and Waveform Generator (One Channel Shown)

14.1.2 Waveform Generator

The waveform generator can send a new value to the DAC automatically, on each cycle of its selected input clock. This clock can be external, on the WFGIN0 or WFGIN1 pin, or internal, using the output of one of the Timer 2-5 Compare units. The waveform generator has a selectable step size and a programmable interrupt rate. See Figure 14-2. An index register allows patterns to begin at any point in waveform memory, and multiple patterns may be stored if desired. Patterns can wrap around from the end of the 128-byte memory to the beginning. The processor can write also directly to a DAC if the waveform feature is not desired.

The waveform generator can be clocked at speeds of up to PCLK/2.

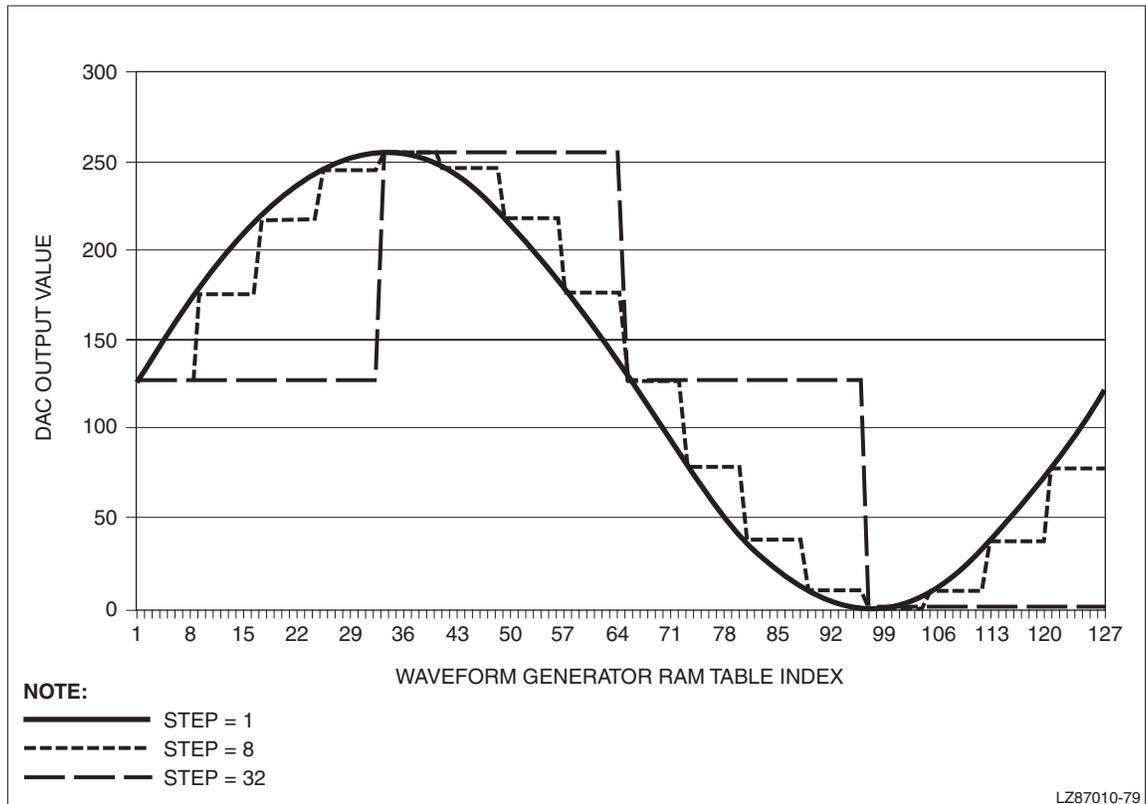


Figure 14-2. Effect of Step Values in Waveform Generation

14.2 Signals

Table 14-1 details the DAC and waveform generator signals.

Table 14-1. DAC Signals

SIGNAL NAME	SIGNAL TYPE	PIN NUMBER	PIN TYPE	FUNCTIONAL UNIT	SHARED WITH	DESCRIPTION
DA0	O	48	O	DACs		DAC 0 Analog Output
DA1	O	46	O	DACs		DAC 1 Analog Output
DAVREF	I	49	I	DACs		Voltage Reference for Digital-to-Analog Converters
WFGIN0	I	66	I/O	Waveform Generator	P3[5]	Waveform Generator Clock Input 0
WFGIN1	I	65	I/O	Waveform Generator	P3[4]	Waveform Generator Clock Input 1

14.3 Registers

14.3.1 DACC (DAC Control) Register

The DACC (DAC Control) register contains power enable bits for both DACs. Powering down the DACs when not in use reduces system power consumption.

Table 14-2. DACC Register

BIT	7	6	5	4	3	2	1	0
FIELD	PWEN1	///	///	///	PWEN0	///	///	///
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xC4							

Table 14-3. DACC Register Bits

BIT	NAME	DESCRIPTION
7	PWEN1	Power Enable for DAC 1 Allows the DAC to be shut down when not in use, conserving power. 0 = Off 1 = On
6:4	///	Reserved Reads '0'. Write as '0'.
3	PWEN0	Power Enable for DAC 0 Allows the DAC to be shut down when not in use, conserving power. 0 = Off 1 = On
2:0	///	Reserved Reads '0'. Write as '0'.

14.3.2 WGCTL0 and WGCTL1 (Control) Registers

The WGCTL0 and WGCTL1 (Waveform Generator Control) registers select the clock source for the waveform generator, determine whether processor writes go to the waveform generator or directly to the DAC, and start or stop the waveform generator.

Table 14-4. WGCTL0 and WGCTL1 Registers

BIT	7	6	5	4	3	2	1	0
FIELD	///	///	///	CLK[2]	CLK[1]	CLK[0]	START	WEN
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	WGCTL0: 0xCA WGCTL1: 0xCB							

Table 14-5. WGCTL0 and WGCTL1 Register Bits

BIT	NAME	DESCRIPTION
7:5	///	Reserved Reads '0'. Write as '0'.
4:2	CLK[2:0]	Clock Select Sets the source of the Waveform Generator Clock. See Table 14-6.
1	START	Start/Stop Enables or disables clocking of the Waveform Generator. The DAC is still active when the Waveform Generator is stopped. 0 = Stop Waveform Generator 1 = Start Waveform Generator When START is set, reads and writes to RAM are ignored. Waveform RAM can only be accessed by software when the waveform generator is stopped.
0	WEN	Write Enable 0 = Disable writes to RAM. Writes go directly to the DAC. 1 = Enables writes to RAM. Disables direct DAC writes.

Table 14-6. Waveform Generator Clock Input Select

CLK[2:0]	CLOCK INPUT
000	WFGIN0 pin
001	WFGIN1 pin
010	TM2CMP0 (output of Timer 2 Compare 0 unit)
011	TM3CMP1 (output of Timer 3 Compare 1 unit)
100	TM4CMP0 (output of Timer 4 Compare 0 unit)
101	TM5CMP1 (output of Timer 5 Compare 1 unit)
110	Reserved
111	Reserved

14.3.3 WGCFG0 and WGCFG1 (Configuration) Registers

The WGCFG0 and WGCFG1 (Waveform Generator Configuration) registers control the interrupt interval (the number of waveform generator input clocks between interrupts) and the memory step (the number of bytes added to the waveform generator index after an access).

Table 14-7. WGCFG0 and WGCFG1 Registers

BIT	7	6	5	4	3	2	1	0
FIELD	///	IVL[2]	IVL[1]	IVL[0]	///	STEP[2]	STEP[1]	STEP[0]
RESET	0	0	0	1	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	WGCFG0: 0xCC WGCFG1: 0xCD							

Table 14-8. WGCFG0 and WGCFG1 Register Bits

BIT	NAME	DESCRIPTION
7	///	Reserved Reads '0'. Write as '0'.
6:4	IVL[2:0]	Interrupt Interval Determines the number of input clock cycles before an interrupt is generated. If IVL[2:0] is '0', no interrupt is generated. The default is an interrupt generated on every input clock cycle. See Table 14-9.
3	///	Reserved Reads '0'. Write as '0'.
2:0	STEP[2:0]	Memory Step Determines the step value added to INDEX on each input clock cycle. See Table 14-10.

Table 14-9. Waveform Generator Interrupt Intervals

IVL[2:0]	INTERVAL
000	No Interrupt
001	1
010	2
011	4
100	8
101	16
110	32
111	64

Table 14-10. Waveform Generator Step Index

STEP[2:0]	STEP SIZE
000	0
001	1
010	2
011	4
100	8
101	16
110	32
111	Reserved

14.3.4 WGINX0 and WGINX1 (Index) Registers

The WGINX0 and WGINX1 (Waveform Generator Index) registers hold a pointer to the next byte in waveform memory that will be sent to the DAC.

Table 14-11. WGINX Registers

BIT	7	6	5	4	3	2	1	0
FIELD	///	INDEX[6]	INDEX[5]	INDEX[4]	INDEX[3]	INDEX[2]	INDEX[1]	INDEX[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	WGINX0: 0xCE WGINX1: 0xCF							

Table 14-12. WGINX0 and WGINX1 Register Bits

BIT	NAME	DESCRIPTION
7	///	Reserved Reads '0'. Write as '0'.
6:0	INDEX[6:0]	Memory Address Index Set by software to the initial address of the waveform pattern. This is incremented by STEP (modulo 128) on each input clock cycle.

14.3.5 WGMA0 and WGMA1 (Memory Address) Registers

The WGMA0 and WGMA1 (Waveform Generator Memory Address) registers hold the next value to be read or written by the processor when it accesses the WGMD0 or WGMD1 register. These registers are post-incremented by WGMD0.STEP or WGMD1.STEP after each access. To write a waveform pattern to waveform memory, the processor writes the starting address to WGMA0 or WGMD0 and sets the STEP field, then writes successive bytes to the WGMD0 or WGMD1 register.

Table 14-13. WGMA0 and WGMA1 Register

BIT	7	6	5	4	3	2	1	0
FIELD	///	WGMA[6]	WGMA[5]	WGMA[4]	WGMA[3]	WGMA[2]	WGMA[1]	WGMA[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	WGMA0: 0xFA WGMA1: 0xFC							

Table 14-14. WGMA0 and WGMA1 Register Bits

BIT	NAME	DESCRIPTION
7	///	Reserved Reads '0'. Write as '0'.
6:0	WGMA[6:0]	Waveform Memory Address Determines the address of the waveform memory when data is read or written by software. This value is post-incremented by the value of the STEP field on reads or writes to WGMD0 or WGMD1 register.

14.3.6 WGMD0 and WGMD1 (Memory Data) Registers

The WGMD0 and WGMD1 (Waveform Generator Memory Data) registers are used to access waveform memory or the DACs. If waveform memory accesses are enabled, (WGCTL(x).WEN = 1) reads and writes go to waveform memory. Otherwise (WGCTL(x).WEN = 0), they go directly to the DAC.

Table 14-15. WGMD0 and WGMD1 Registers

BIT	7	6	5	4	3	2	1	0
FIELD	WGMD[7]	WGMD[6]	WGMD[5]	WGMD[4]	WGMD[3]	WGMD[2]	WGMD[1]	WGMD[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	WGMD0: 0xFB WGMD1: 0xFD							

Table 14-16. WGMD0 and WGMD1 Register Bits

BIT	NAME	DESCRIPTION
7:0	WGMD[7:0]	Waveform Memory Data Register If the WEN field of the WGCTL(x) register is '0', data written to this register is sent directly to the DAC. If the WEN field is '1', reading this register returns value of the waveform memory at the address stored in WGMA(x)[6:0]. Writing to this register stores the value in the waveform memory at the address in WGMA(x)[6:0]. WGMA(x) is post-incremented by the value of STEP on both reads and writes.

Chapter 15

I²C Interface

15.1 Theory of Operation

The LZ87010 includes a two-wire I²C serial interface capable of operating in either Master or Slave mode. The two wires are SCL (serial clock) and SDA (serial data). Both are open-collector I/O pins.

The interface has a single byte of serial data buffering on receive and transmit. Registers provide control over operating mode, serial clock frequency, and slave-mode address. A debug register gives real-time status information about the interface, and a status register contains status bits that remain set until cleared by software.

Interrupts are generated on a variety of conditions, and are vectored to address 0x0043. They are enabled or disabled by the IE1.EI2C bit.

15.1.1 Setting I²C Clock Timing

When the I²C interface is in Master mode, the serial clock (SCL) is generated from PCLK, using two registers, ICHCNT and ICLCNT for timing parameters. When the I²C interface is in Slave mode, SCL is provided by the Master.

The equation for calculating the proper number of PCLKs required for setting the proper SCL clock HIGH and LOW period is as follows:

$$H_CNT = \text{ROUND_UP}(\text{MIN_SCL_HIGH}_{\text{time}} (\mu\text{s}) \times \text{PCLK}(\text{MHz})) - k$$

$$L_CNT = \text{ROUND_UP}(\text{MIN_SCL_LOW}_{\text{time}} (\mu\text{s}) \times \text{PCLK}(\text{MHz})) - k$$

See Table 15-1 for the parameters for this equation. 'ROUND_UP' means to round all fractions up to the next highest integer.

Table 15-1. I²C Clock Parameters

VALUE	400 Kbit/s	100 kbit/s
k	4	3
MIN_SCL_HIGH	0.6 μs	40 μs
MIN_SCL_LOW	1.3 μs	4.7 μs

See Table 15-2 for sample calculations of the HIGH count. The LOW count is calculated in the same way.

Table 15-2. Sample I²C HIGH Period Counts

I ² C DATA RATE (kbit/s)	PCLK (MHz)	SCL HIGH REQUIRED MIN. (μs)	H_CNT	SCL HIGH TIME (μs)
100	6.6	4	24	4.09
100	9.9	4	37	4.14
400	10	0.6	2	0.60
400	15.3	0.6	6	0.654
400	20	0.6	8	0.66

15.2 Interrupt Handling

In Slave mode, the I²C interface handles address comparison, shifts data into or out of the ICDATA register, and generates ACK pulses at the appropriate times. In short, the interface hardware handles the bit-level operation of the protocol. In Master mode, the interface also handles bus arbitration and synchronization.

The byte level and above are handled in software. Interrupts are generated on both receive and transmit data, in a way similar to typical serial data interrupts. On transmit, when the data in ICDATA has been sent and the interface is ready to accept another byte of transmit data, a transmit interrupt is generated. On receive, when new data is received over the interface and placed into the ICDATA register, a receive interrupt is generated.

For the purposes of interrupt generation, no distinction is made between address bytes and data bytes. However, in Slave mode, the interface ignores transfers not addressed to it. In 7-bit addressing mode, addresses that do not match that of the I²C interface do not generate interrupts. Nor do any following data transactions.

In 10-bit addressing mode, the address is transferred in two bytes. If the first transfer (containing the most-significant address bits) matches the most-significant bits of the Slave address, an interrupt will be generated on both halves of the address. If the second part of the address does not match, the ICSTAT.RX_ABRT bit is set, informing the interrupt handler that the address was not a complete match.

In transmit mode, the ICCON must be updated on a byte-by-byte basis, because the ICCON.S_TRNSFR bit must be set to '1' to initiate a byte transfer. This register also contains bits that set the operating mode.

In Master mode, bus arbitration and synchronization are handled in hardware. Addressing, which was handled in hardware in Slave mode, is handled in software in Master mode. For example, the R/W bit of a 7-bit address must be set in software; it is not overwritten by the state of the R/W bit in the ICCON register.

Status bits in the ICSTAT and ICDEBUG registers report the precise state of the interface. For example, there are status bits reporting whether the current transfer is a Slave address or if a transmit abort or receive data overrun has occurred.

15.2.1 Slave Mode

In slave-receiver mode, the interface interrupts the processor whenever an address or data byte has been received. The sequence is that the byte is received and acknowledged by the interface, then the processor is interrupted. The ICDATA register will contain a data byte, 7-bit Slave address, or one of the two 10-bit Slave address bytes. Status bits in the ICSTAT and ICDEBUG registers allow the processor to determine the type of transfer.

Whenever data is received, the ICSTAT.FULL_FLG bit is set. No further transfers can take place over the interface until this bit is cleared. Reading the ICDATA register clears the bit.

In slave-transmitter mode, the interface interrupts the processor when an address is received, when the interface is ready to receive another data byte, and on repeat START conditions. When the interface is ready to send another byte, it sets the ICSTAT.FULL_FLG bit. This will be cleared when the ICDATA register is written by the processor. In slave-transmitter mode, the ICCON register must be written for each byte, setting the ICCON.S_TRNSFR bit to initiate the transfer.

Interrupts set the ICSTAT.INT bit. Before the interrupt routine is exited, this bit must be cleared by reading the ICSTAT register.

In address and repeat START transactions, reading the ICDATA and ICSTAT registers is all that is required of the interrupt handler, since address comparisons are performed in hardware.

15.2.2 Master Mode

Master mode is similar to Slave mode from an interrupt-handling point of view, but the interface now transmits rather than receives addresses, and bus arbitration must be performed as well.

Master-mode transactions start by testing ICSTAT.IDLE bit to verify that the interface is idle, then initiating an address transaction. Address bytes and START bytes are generated in software and written to the ICDATA register as if they were data.

The handling of individual data interrupts is much the same as in Slave mode.

15.3 Signals

Table 15-3. I²C Registers

SIGNAL NAME	SIGNAL TYPE	PIN NUMBER	PIN TYPE	FUNCTIONAL UNIT	SHARED WITH	DESCRIPTION
SCL	I/O	68	I/O	I ² C	P3[6]	I ² C Bus Clock (Open Collector)
SDA	I/O	69	I/O	I ² C	P3[7]	I ² C Bus Data (Open Collector)

15.4 Registers

15.4.1 ICCON (I²C Configuration) Register

The ICCON register sets the operating mode of the interface and contains the flags used to start a transfer and to set the data direction.

Table 15-4. ICCON Register

BIT	7	6	5	4	3	2	1	0
FIELD	RS_P_N	R_W_N_CTRL	P_TRNSFR	S_TRNSFR	FS_STD_N	I2C_EN	MODE[1]	MODE[0]
RESET	0	0	0	0	1	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xB4							

Table 15-5. ICCON Register Bits

BIT	NAME	DESCRIPTION
7	RS_P_N	The RS_P_N bit is only used when the I ² C interface is in Master mode and the ACK signal is not set to '0' by the Slave with which it is communicating. In this case: 0 = An I ² C STOP condition is generated after each bus transaction. 1 = No STOP condition is generated.
6	R_W_N_CTRL	Read/Write Control The R_W_N_CTRL bit is only used when the I ² C interface is in Master mode. It sets the direction for data transfers: 0 = Write (Master transmitter) 1 = Read (Master receiver)
5	P_TRNSFR	The P_TRNSFR bit is only used when the I ² C interface is in Master mode. When '1', the I ² C interface will terminate the data transfer after the current I ² C transaction has completed. Hardware will reset the P_TRNSFR bit to '0' automatically.
4	S_TRNSFR	Start Transfer When the I ² C interface is in Master mode, a transfer, setting the S_TRNSFR bit to '1' will start a transaction on the I ² C bus. When the I ² C interface is in Slave mode, setting the S_TRNSFR bit will transmit a byte of data to the Master. Hardware will reset the S_TRNSFR bit to '0' after the transaction.
3	FS_STD_N	Fast/Standard Speed 1 = Fast interface speed (400 kbit/s) 0 = Standard interface speed (100 kbit/s)
2	I ² C_EN	I²C Enable 1 = I ² C interface is enabled 0 = I ² C interface is disabled (SCL and SDA will not be driven)
1	MODE[1]	I²C Mode 1 = Master mode 0 = Slave mode
0	MODE[0]	I²C Mode 1 = 10-bit addressing 0 = 7-bit addressing

15.4.2 ICSAR (I²C Slave Address) Register

The ICSAR register holds the unit address used by the interface when in Slave mode. In 7-bit addressing mode, the entire address is contained in this register, plus a read/write data-direction bit. In 10-bit addressing mode, this register holds the lower 8 address bits, and the upper two bits and the R/W bit are in the ICUSAR register. This register is not used in Master mode.

Table 15-6. ICSAR Register

BIT	7	6	5	4	3	2	1	0
FIELD	S_ADDR[7]	S_ADDR[6]	S_ADDR[5]	S_ADDR[3]	S_ADDR[3]	S_ADDR[2]	S_ADDR[1]	S_ADDR[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xB5							

Table 15-7. ICSAR Register Bits

BIT	NAME	DESCRIPTION
7:0	S_ADDR	<p>Slave Address In 7-bit addressing mode, S_ADDR[7:1] holds the I²C interface's slave address. In 10-bit addressing mode, S_ADDR[7:0] holds the lower 8 bits of the slave address. In 7-bit mode, S_ADDR[0] is used for read/write control of the data transfer:</p> <p>0 = Write 1 = Read</p>

15.4.3 ICUSAR (I²C Upper Slave Address) Register

The ICUSAR (I²C Upper Slave Address) Register holds the upper 2 address bits in 10-bit addressing mode, plus a data direction (R/W) bit. This register is not used in Master mode.

Table 15-8. ICUSAR Register

BIT	7	6	5	4	3	2	1	0
FIELD	U_AR[4]	U_AR[3]	U_AR[2]	U_AR[1]	U_AR[0]	S_ADDR[9]	S_ADDR[8]	R/W
RESET	1	1	1	1	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xB6							

Table 15-9. ICUSAR Register Bits

BIT	NAME	DESCRIPTION
7:3	U_AR[4:0]	Upper Address Bits Must be set to '0b11110'.
2:1	S_ADDR[9:8]	Slave Address[9:0] The upper 2 bits of the 10-bit slave address. Not used in 7-bit addressing mode.
0	RW	Slave Read/Write In 10-bit Slave mode, this provides read/write control for data transfers: 0 = Write 1 = Read

15.4.4 ICDATA (I²C Data) Register

The ICDATA register holds the received serial data or the serial data to be transmitted.

Table 15-10. ICDATA Register

BIT	7	6	5	4	3	2	1	0
FIELD	DAT[7]	DAT[6]	DAT[5]	DAT[4]	DAT[3]	DAT[2]	DAT[1]	DAT[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xB7							

Table 15-11. ICDATA Register Bits

BIT	NAME	DESCRIPTION
7:0	DAT[7:0]	I²C Data The DAT[7:0] contains the transmitted or received I ² C data.

15.4.5 ICHCNT (I²C Clock High Time) Register

The ICHCNT register sets the period for the serial clock HIGH time.

Table 15-12. ICHCNT Register

BIT	7	6	5	4	3	2	1	0
FIELD	H_CNT[7]	H_CNT[6]	H_CNT[5]	H_CNT[4]	H_CNT[3]	H_CNT[2]	H_CNT[1]	H_CNT[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xBC							

Table 15-13. ICHCNT Register Bits

BIT	NAME	DESCRIPTION
7:0	H_CNT[7:0]	High Count This register sets the SCL HIGH period. The HIGH period will be ICHCNT + 3 PCLK periods in 100 kbit/s mode, and ICHCNT + 4 PCLK cycles in 400 kbit/s mode. The ICHCNT Register must be set before any I ² C bus transaction can take place to insure proper I/O timing.

15.4.6 ICLCNT (I²C Clock Low Time) Register

The ICLCNT register sets the period for the serial clock LOW time.

Table 15-14. ICLCNT Register

BIT	7	6	5	4	3	2	1	0
FIELD	L_CNT[7]	L_CNT[6]	L_CNT[5]	L_CNT[4]	L_CNT[3]	L_CNT[2]	L_CNT[1]	L_CNT[0]
RESET	0	0	0	0	0	0	0	0
RW	RW	RW	RW	RW	RW	RW	RW	RW
ADDR	0xBD							

Table 15-15. ICLCNT Register Bits

BIT	NAME	DESCRIPTION
7:0	L_CNT[7:0]	Low Count This register sets the SCL LOW clock time. The LOW period will be ICLCNT + 3 PCLK periods in 100 kbit/s mode, and ICLCNT + 4 PCLK cycles in 400 kbit/s mode. The ICLCNT Register must be set before any I ² C bus transaction takes place to insure proper I/O timing. Note that the value in this register must be at least 3 for proper I ² C operation.

15.4.7 ICDEBUG (I²C Debug) Register

The ICDEBUG register holds real-time status about the current transfer.

Table 15-16. ICDEBUG Register

BIT	7	6	5	4	3	2	1	0
FIELD	///	///	I2C_W	I2C_R	ADDR	DATA	P_DET	S_DET
RESET	0	0	0	0	0	0	0	0
RW	RO	RO	RO	RO	RO	RO	RO	RO
ADDR	0xBE							

Table 15-17. ICDEBUG Register Bits

BIT	NAME	DESCRIPTION
7:6	///	Reserved Reads '0', write '0'.
5	I2C_W	Write in Progress Set to '1' during write transfers on the I ² C bus. This bit will be cleared when the STOP condition is detected.
4	I2C_R	Read in Progress Set to '1' during read transfers on the I ² C bus. This bit will be cleared when the STOP condition is detected.
3	ADDR	Address Phase Set to '1' when the addressing phase is active on the I ² C bus. This bit will set to '1' at the beginning of the transfer (START phase) and cleared to '0' after the address phase has completed.
2	DATA	Data Phase Set to '1' when a byte of data is being read or written on the I ² C bus. This bit will remain '1' until the transaction has completed.
1	P_DET	STOP Detected Set to '1' when a STOP Condition is detected. This bit will remain '1' until the ICDEBUG Register is read by the processor.
0	S_DET	START Detected Set to '1' when a START Condition is detected. This bit will remain '1' until the ICDEBUG Register is read by the processor.

15.4.8 ICSTAT (I²C Status) Register

The ICSTAT register gives status about the state of the interface.

Table 15-18. ICSTAT Register

BIT	7	6	5	4	3	2	1	0
FIELD	SLV_ADDR	RX_ABRT	TX_ABRT	IDLE	10_BIT_ADDR	OVRFLW	FULL_FLG	INTR
RESET	0	0	0	0	0	0	0	0
RW	RO	RO	RO	RO	RO	RO	RO	RO
ADDR	0xBF							

Table 15-19. ICSTAT Register Bits

BIT	NAME	DESCRIPTION
7	SLV_ADDR	Slave Address Set to '1' when the last byte received on the I ² C bus was a Slave address byte.
6	RX_ABRT	Receive Abort In Slave mode, this bit will be set to '1' if: <ul style="list-style-type: none"> The I²C interface is in 10-bit Slave mode and the upper address byte matched but the lower address byte did not. In Master mode, this bit will be set to '1' when the upper and lower address bytes match and a restart was issued by the Master in a Master-receive mode, but the repeated upper address does not match. When the OVRFLW bit is set to '1' during the data phase of Slave-receive mode. This bit will remain '1' until the ICSTAT register is read by the processor. When an address byte is received by the slave during the address phase of Slave-receive and FULL_FLG is set.
5	TX_ABRT	Transmit Abort Set to '1' when the I ² C interface is operating in the Master-transmitter mode and a Slave device does not respond with an ACK signal after receiving a byte of data from the Master. It will also be set to '1' when arbitration is lost while operating as a Master. This bit will remain '1' until the ICSTAT Register is read by the processor.
4	IDLE	Idle Set to '1' when the I ² C interface is not processing any messages.
3	10_BIT_ADDR	Ten-bit Address Set to '1' when a 10-bit address is detected. This bit will remain '1' until the ICSTAT Register is read by the processor.
2	OVRFLW	Overflow Set to '1' if the first byte of data received on the I ² C bus is not read out of the ICDATA register before the next byte received is written into the ICDATA register. The first byte written into the ICDATA register will be lost. This bit will remain '1' until the ICDATA Register is read.
1	FULL_FLG	Full Flag Set to '1', after a byte of address or data is received on the I ² C bus and written into the ICDATA register. This bit will remain '1' until the ICDATA Register is read by the processor or until the TX_ABRT bit is set.
0	INTR	Interrupt Set to '1' under the following conditions: <ul style="list-style-type: none"> After a data byte is received on the I²C bus and written to ICDATA After a Stop condition is detected. When either the FULL_FLG or OVRFLW flags are '1' In master mode, when the TX_ABRT flag is '1' In slave mode, when the RX_ABRT flag is '1'. This bit will remain '1' until reset by software.

Chapter 16

Debug Interface

16.1 Theory of Operation

The SHARP Debug Interface (SDI) consists of sophisticated on-chip debugging hardware including support for multiple hardware breakpoints and unlimited software breakpoints, plus a 128-element branch trace buffer. A sophisticated trigger mechanism allows breakpoints to be set on ranges of code or data addresses or on data values.

Communication to external debuggers is provided over a high-speed, two-wire serial interface, using SDI_CLK and SDI_DATA. SDI_CLK is an input to the LZ87010, and is driven by the external debugging hardware. SDI_DATA is a bidirectional serial data signal.

The LZ87010 features a Debug mode that is entered when requested by the serial debug interface or when a breakpoint is encountered. Debug mode halts the processor and allows the state of the system to be examined or altered over the Debug interface. While in Debug mode, single-step execution can also be used. When Debug mode is exited, execution continues from where it left off when Debug mode was entered, unless the user explicitly alters the execution address.

The timers and other system peripherals continue to run in Debug mode, but their interrupts will not be serviced until Debug mode is exited.

A typical system implementation consists of a debug connector carrying the SDI_DATA and SDI_CLK signals and a bi-directional RESET, allowing the debugger to both monitor and control the system reset state. Such a connection is shown in Figure 16-1. This connector is used on the SHARP KEV87010 Evaluation Board, using a standard 10-pin keyed male header with 2 rows of 5 pins on 0.100" centers. A ribbon cable can be plugged into this connector to connect it with a debugging unit such as the ISA-M8051EW from First Silicon Solutions, Inc.

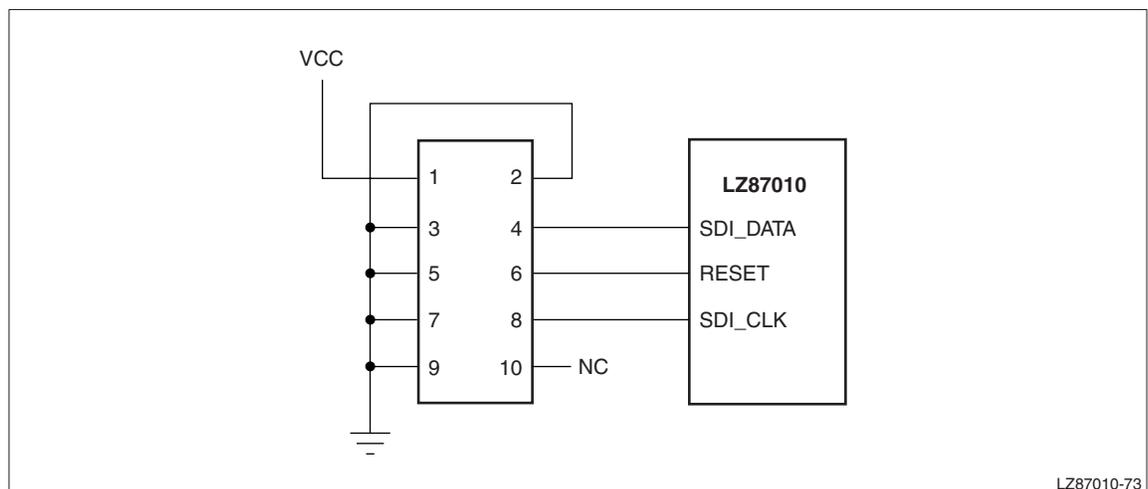


Figure 16-1. SHARP Debug Interface (SDI) Wiring

16.2 Signals

The SDI_CLK and SDI_DATA signals provide the serial data stream between the LZ87010 and the debugging unit. Both signals include internal weak pull-up resistors to VDD.

Table 16-1. Debug Signal Descriptions

SIGNAL NAME	SIGNAL TYPE	PIN NUMBER	PIN TYPE	FUNCTIONAL UNIT	DESCRIPTION
SDI_CLK	I	70	I	Debug	SHARP Debug Interface Clock. If no debugger is used, leave this pin unconnected.
SDI_DATA	I/O	71	I/O	Debug	SHARP Debug Interface Data. If no debugger is used, leave this pin unconnected.

Chapter 17

Reset

17.1 Theory of Operation

The LZ87010 has an active-HIGH RESET signal with an internal pull-down resistor (with a nominal value of 90 k Ω).

The recommended RESET pulse width is 38 HFCLK cycles, starting after VDD and the system oscillators are stable.

For debugging, a simple push-button switch between RESET and VDD gives good results without additional circuitry.

17.2 Signals

Table 17-1. Reset Signal

SIGNAL NAME	SIGNAL TYPE	PIN NO.	PIN TYPE	FUNCTIONAL UNIT	SHARED WITH	DESCRIPTION
RESET	I	27	I	Reset		System Reset

SHARP®

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